

OPERATING MANUAL

Electronic Load Mainframes HP Models 6050A and 6051A

HP Part No. 5950-2368


HP 6811A ac Power Source/Analyzer

NEW
375VA

Other Models Available:

- HP 6812A 750VA
- HP 6813A 1750VA
- HP 6814B 3000VA
- HP 6834B 4500VA

Graphical User Interface included

A photograph of the HP 6811A ac Power Source/Analyzer unit. It is a rack-mountable device with a light-colored front panel. On the left, there are two large circular ports. In the center, there is a digital display showing '115.0V' and '60.0Hz'. To the right of the display is a grid of numerous small, square buttons for various functions. The unit is shown from a slightly elevated front perspective.

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OPERATING MANUAL

Electronic Load Mainframes HP Models 6050A and 6051A

HP Part No 5959-3368

For Instruments with Serial Numbers:

HP 6050A – 2908A-00101 and Above

HP 6051A – 2927A-00101 and Above

CERTIFICATION

Hewlett-Packard Company certifies that this product met its published specifications at time of shipment from the factory. Hewlett-Packard further certifies that its calibration measurements are traceable to the United States National Bureau of Standards, to the extent allowed by the Bureau's calibration facility, and to the calibration facilities of other International Standards Organization members.

WARRANTY

This Hewlett-Packard hardware product is warranted against defects in material and workmanship for a period of three years from date of delivery. HP software and firmware products, which are designated by HP for use with a hardware product and when properly installed on that hardware product, are warranted not to fail to execute their programming instructions due to defects in material and workmanship for a period of 90 days from date of delivery. During the warranty period Hewlett-Packard Company will, at its option, either repair or replace products which prove to be defective. HP does not warrant that the operation for the software firmware, or hardware shall be uninterrupted or error free.

For warranty service, with the exception of warranty options, this product must be returned to a service facility designated by HP. Customer shall prepay shipping charges by (and shall pay all duty and taxes) for products returned to HP for warranty service. Except for products returned to Customer from another country, HP shall pay for return of products to Customer.

Warranty services outside the country of initial purchase are included in HP's product price, only if Customer pays HP international prices (defined as destination local currency price, or U.S. or Geneva Export price).

If HP is unable, within a reasonable time to repair or replace any product to condition as warranted, the Customer shall be entitled to a refund of the purchase price upon return of the product to HP.

LIMITATION OF WARRANTY

The foregoing warranty shall not apply to defects resulting from improper or inadequate maintenance by the Customer, Customer-supplied software or interfacing, unauthorized modification or misuse, operation outside of the environmental specifications for the product, or improper site preparation and maintenance. NO OTHER WARRANTY IS EXPRESSED OR IMPLIED. HP SPECIFICALLY DISCLAIMS THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.

EXCLUSIVE REMEDIES

THE REMEDIES PROVIDED HEREIN ARE THE CUSTOMER'S SOLE AND EXCLUSIVE REMEDIES. HP SHALL NOT BE LIABLE FOR ANY DIRECT, INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, WHETHER BASED ON CONTRACT, TORT, OR ANY OTHER LEGAL THEORY.

ASSISTANCE

The above statements apply only to the standard product warranty. Warranty options, extended support contracts, product maintenance agreements and customer assistance agreements are also available. Contact your nearest Hewlett-Packard Sales and Service office for further information on HP's full line of Support Programs.

SAFETY SUMMARY

The following general safety precautions must be observed during all phases of operation, service, and repair of this instrument. Failure to comply with these precautions or with specific warnings elsewhere in this manual violates safety standards of design, manufacture, and intended use of the instrument. Hewlett-Packard Company assumes no liability for the customer's failure to comply with these requirements.

BEFORE APPLYING POWER.

Verify that the product is set to match the available line voltage and the correct fuse is installed.

GROUND THE INSTRUMENT.

This product is a Safety Class 1 instrument (provided with a protective earth terminal). To minimize shock hazard, the instrument chassis and cabinet must be connected to an electrical ground. The instrument must be connected to the ac power supply mains through a three-conductor power cable, with the third wire firmly connected to an electrical ground (safety ground) at the power outlet. For instruments designed to be hard-wired to the ac power lines (supply mains), connect the protective earth terminal to a protective conductor before any other connection is made. Any interruption of the protective (grounding) conductor or disconnection of the protective earth terminal will cause a potential shock hazard that could result in personal injury. If the instrument is to be energized via an external autotransformer for voltage reduction, be certain that the autotransformer common terminal is connected to the neutral (earthed pole) of the ac power lines (supply mains).

FUSES

Only fuses with the required rated current, voltage, and specified type (normal blow, time delay, etc.) should be used. Do not use repaired fuses or short circuited fuseholders. To do so could cause a shock or fire hazard.

DO NOT OPERATE IN AN EXPLOSIVE ATMOSPHERE.

Do not operate the instrument in the presence of flammable gases or fumes.

KEEP AWAY FROM LIVE CIRCUITS.

Operating personnel must not remove instrument covers. Component replacement and internal adjustments must be made by qualified service personnel. Do not replace components with power cable connected. Under certain conditions, dangerous voltages may exist even with the power cable removed. To avoid injuries, always disconnect power, discharge circuits and remove external voltage sources before touching components.

DO NOT SERVICE OR ADJUST ALONE.

Do not attempt internal service or adjustment unless another person, capable of rendering first aid and resuscitation, is present.

DO NOT EXCEED INPUT RATINGS.

This instrument may be equipped with a line filter to reduce electromagnetic interference and must be connected to a properly grounded receptacle to minimize electric shock hazard. Operation at line voltages or frequencies in excess of those stated on the data plate may cause leakage currents in excess of 5.0 mA peak.

SAFETY SYMBOLS.



Instruction manual symbol: the product will be marked with this symbol when it is necessary for the user to refer to the instruction manual (refer to Table of Contents).



Indicates hazardous voltages.



or



Indicate earth (ground) terminal.

WARNING

or



The WARNING sign denotes a hazard. It calls attention to a procedure, practice, or the like, which, if not correctly performed or adhered to, could result in personal injury. Do not proceed beyond a WARNING sign until the indicated conditions are fully understood and met.

CAUTION

or



Caution

The CAUTION sign denotes a hazard. It calls attention to an operating procedure, or the like, which, if not correctly performed or adhered to, could result in damage to or destruction of part or all of the product. Do not proceed beyond a CAUTION sign until the indicated conditions are fully understood and met.

DO NOT SUBSTITUTE PARTS OR MODIFY INSTRUMENT.

Because of the danger of introducing additional hazards, do not install substitute parts or perform any unauthorized modification to the instrument. Return the instrument to a Hewlett-Packard Sales and Service Office for service and repair to ensure that safety features are maintained.

Instruments which appear damaged or defective should be made inoperative and secured against unintended operation until they can be repaired by qualified service personnel.

SAFETY SUMMARY (continued)



















GENERAL

Any LEDs used in this product are Class 1 LEDs as per IEC 825-1.

ENVIRONMENTAL CONDITIONS

This instrument is intended for indoor use in an installation category II, pollution degree 2 environment. It is designed to operate at a maximum relative humidity of 95% and at altitudes of up to 2000 meters. Refer to the specifications tables for the ac mains voltage requirements and ambient operating temperature range.

SAFETY SYMBOL DEFINITIONS

Symbol	Description	Symbol	Description
	Direct current		Terminal for Line conductor on permanently installed equipment
	Alternating current		Caution, risk of electric shock
	Both direct and alternating current		Caution, hot surface
	Three-phase alternating current		Caution (refer to accompanying documents)
	Earth (ground) terminal		In position of a bi-stable push control
	Protective earth (ground) terminal		Out position of a bi-stable push control
	Frame or chassis terminal		On (supply)
	Terminal for Neutral conductor on permanently installed equipment		Off (supply)
	Terminal is at earth potential (Used for measurement and control circuits designed to be operated with one terminal at earth potential.)		Standby (supply) Units with this symbol are not completely disconnected from ac mains when this switch is off. To completely disconnect the unit from ac mains, either disconnect the power cord or have a qualified electrician install an external switch.

Herstellerbescheinigung

Diese Information steht im Zusammenhang mit den Anforderungen der Maschinenlärminformationsverordnung vom 18 Januar 1991.

* Schalldruckpegel $L_p < 70 \text{ dB(A)}$ * Am Arbeitsplatz * Normaler Betrieb
* Nach EN 27779 (Typprüfung).

Manufacturer's Declaration

This statement is provided to comply with the requirements of the German Sound Emission Directive, from 18 January 1991.

* Sound Pressure $L_p < 70 \text{ dB(A)}$ * At Operator Position * Normal Operation
* According to EN 27779 (Type Test).

DECLARATION OF CONFORMITY

according to ISO/IEC Guide 22 and EN 45014

Manufacturer's Name: Hewlett-Packard Company

Manufacturer's Address: 150 Green Pond Road
Rockaway, New Jersey 07866
U.S.A.

declares that the Product

Product Name: Load mainframe and modules

Model Number: HP 6050A, 6051A mainframes with modules
HP 60501A/B, 60502A/B, 60503A/B, 60504A/B, 60507A/B

conforms to the following Product Specifications:

Safety: IEC 348:1978 / HD 401S1: 1981¹

EMC: CISPR 11:1990 / EN 55011:1991 - Group 1 Class B
IEC 801-2:1991 / EN 50082-1:1992 - 4 kV CD, 8 kV AD
IEC 801-3:1984 / EN 50082-1:1992 - 3 V / m
IEC 801-4:1988 / EN 50082-1:1992 - 0.5 kV Signal Lines
1 kV Power Lines

Supplementary Information:

The product herewith complies with the requirements of the Low Voltage Directive 73/23/EEC and the EMC Directive 89/336/EEC and carries the CE-marking accordingly.

Note 1: The product family was introduced prior to 12/93.

New Jersey
Location

January 1997
Date



Bruce Krueger / Quality Manager

European Contact: Your local Hewlett-Packard Sales and Service Office or Hewlett-Packard GmbH,
Department TRE, Herrenberger Strasse 130, D-71034 Boeblingen (FAX:+49-7031-14-3143)

PRINTING HISTORY

The edition and current revision of this manual are indicated below. Reprints of this manual containing minor corrections and updates may have the same printing date. Revised editions are identified by a new printing date. A revised edition incorporates all new or corrected material since the previous printing date.

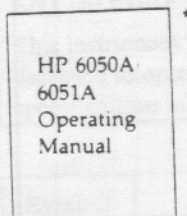
Changes to the manual occurring between revisions are covered by change sheets shipped with the manual. In some cases, the manual change applies only to specific instruments. Instructions provided on the change sheet will indicate if a particular change applies only to certain instruments.

Edition 3 - May, 1993

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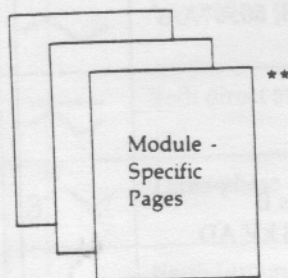
This document contains proprietary information protected by copyright. All rights are reserved. No part of this document may be photocopied, reproduced, or translated into another language without the prior consent of Hewlett-Packard Company. The information contained in this document is subject to change without notice.

If you are a first-time user, start with this manual, paying particular attention to Chapter 2. After installation (Chapter 3), read Chapter 4 to learn front-panel operation. Programming users should then read Chapter 5 before going to the *Programming Reference Guide*. Experienced programming users will probably refer only to the *Programming Reference Guide*.



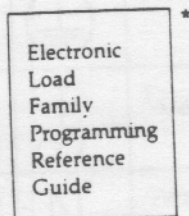
HP 6050A/6051A Operating Manual
HP Part No. 5959-3368
(this manual)

Specifications
System Overview
Installation Procedures
Front-Panel Operation
Remote Programming Introduction
Calibration Procedures



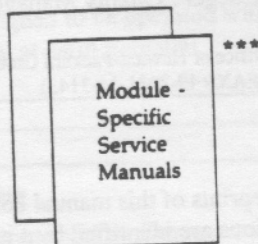
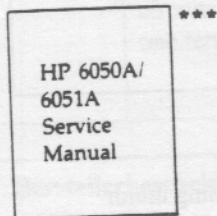
Module-Specific Pages
HP Models 60501A/B, 60502A/B, 60503A/B,
60504A/B, 60507B

Specifications
Programming Ranges
Factory Default Settings
Calibration Information



Hewlett-Packard Electronic Load Family
Programming Reference Guide
HP Part No. 06060-90005

Introduction to HP-SL
Introduction to Programming
Language Dictionary
Status Reporting



HP 6050A/6051A Service Manual

Module Service Manuals

* Supplied with HP 6050A/6051A Electronic Load Mainframe.

** Supplied with individual load modules.

*** Available for purchase. Supplied with instrument if ordered as Option 910.

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Appendix A

Considerations for Operating in Constant Resistance Mode
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Chapter 1

GENERAL INFORMATION

WHAT'S IN THIS MANUAL

This manual applies to both the HP 6050A and HP 6051A Electronic Load mainframes. The two mainframes are functionally identical, but the HP 6051A is a half-rack width unit, with only two slots for load modules. Most of the information given in this manual applies to both mainframes. Where differences occur, information specific just to the HP 6051A is given in parentheses following information that applies only to the HP 6050A, for example: ... a total of 1800 (600) watts...

This chapter contains specifications that apply to the HP 6050A and HP 6051A Electronic Load mainframes, as well as information concerning options and safety requirements. The remaining chapters in this manual contain instructions for installing, operating, programming, and calibrating the Electronic Load as follows:

Chapter 2 "Operation Overview":	describes all of the Electronic Load's functions and briefly describes how they can be controlled locally at the front panel and/or remotely via an HP-IB controller.
Chapter 3 "Installation":	provides instructions for installing load modules in the mainframe, controller and application connections, and turn-on checkout procedures.
Chapter 4 "Local Operation":	describes in detail how to operate the Electronic Load at the front panel.
Chapter 5 "Remote Operation":	provides an introduction to remote programming.
Chapter 6 "Calibration":	contains calibration procedures for the Electronic Load and gives sample calibration programs. Yearly calibration intervals are recommended.

Specifications and other information pertinent to a specific load module are given in the module-specific pages provided with each load module.

OPTIONS

Unless one of the following line voltage options is ordered, the unit is shipped from the factory set for 120 Vac, 48-63 Hz ac input power. If Option 100, 220, or 240 is ordered, the unit will be factory set for the appropriate line voltage. For information about changing the line voltage setting, see "Turn-On Checkout" in Chapter 3.

- 100: Input Power, 100 Vac, 48-63 Hz
- 220: Input Power, 220 Vac, 48-63 Hz
- 240: Input Power, 240 Vac, 48-63 Hz

Additional options are:

- 800: One rack mount kit for two half-rack units side by side (HP 6051A only)*
- 908: One rack mount kit*
- 909: One rack mount kit with handles (HP 6050A only)*
- 910: One service manual with extra Operating Manual and Programming Reference Guide

* Support rails are required for Options 800, 908, and 909.

SAFETY REQUIREMENTS

This product is a Safety Class 1 instrument, which means that it is provided with a protective earth ground terminal. This terminal must be connected to an ac source that has a 3-wire ground receptable. Review the instrument rear panel and this manual for safety markings and instructions before operating the instrument. Refer to the Safety Summary page at the beginning of this manual for a summary of general safety information. Specific safety information is located at appropriate places in this manual.

The Electronic Load is designed to comply with the following safety and environmental requirements:

- IEC 348—Safety requirements for electronic measuring apparatus
- CSA 22.2 No. 231—Electronic instruments and scientific apparatus for special use and applications
- UL 1244—Electrical and electronic measuring and testing equipment

SPECIFICATIONS

Table 1-1 lists the specifications and supplemental characteristics for the HP 6050A/6051A Electronic Load mainframe. All specifications apply over an operating

range of 0 to +55°C for the mainframe. Specifications are guaranteed through the warranty of the product. Supplemental characteristics are type-tested or typical values based on a product sample and, while representative, are not guaranteed for all instruments.

Table 1-1. HP 6050A/6051A Specifications and Supplemental Characteristics

Specifications:

AC Input:

Three internal switches permit operation from 100, 120, 220, or 240 Vac lines.

Amplitude: -13% to +6% nominal line voltage

Frequency: 48 to 63 Hz

Supplemental Characteristics:

AC Input:

Fuse: The ac input is protected by internal fuses.

Maximum VA: 635

HP-IB Programming Command Processing Time (Time required for an HP-IB command processed by the Electronic Load): 70 milliseconds (typical)

HP-IB Interface Capabilities:

SH1, AH1, T6, L4, SR1, RL1, DT1, DC1

Trigger Input:

Vlo = 0.9 V maximum at Ilo = -1 mA

Vhi = 3.15 V minimum (pull-up resistor on input)

Trigger Input:

Vlo = 0.72 V maximum at Ilo = 1 mA

Vhi = 4.4 V minimum at Ilo = -20 μ A

Weight:

Net (mainframe only): HP 6050A, 9.5 kg (21 lb.)
HP 6051A, 5.5 kg (12 lb.)

Shipping: HP 6050A, 14 kg (31 lb.)
HP 6051A, 7.5 kg (17 lb.)

Dimensions:

Width: HP 6050A, 425.5 mm (16.75 in.)
HP 6051A, 213 mm (8.4 in.)

Height: 178 mm (7 in.), add 10 mm (0.4 in.) for removable feet

Depth: 625 mm (24.6 in.), including input connectors on modules

Chapter 2

OPERATION OVERVIEW

INTRODUCTION

The HP 6050A and HP 6051A Multiple Input Electronic Load Mainframes are used for design, manufacturing, and evaluation of dc power supplies, batteries, and power components. Other applications include use as a power circuit breaker or crowbar, high-current function or pulse generator, fuel-cell and photovoltaic cell test, and de-energizing superconducting magnets.

The mainframe contains six (two) slots for load modules. Load modules occupy either 1 or 2 slots, depending on the power rating of the module. The mainframe can dissipate up to 300 watts per slot, to a total of 1800 (600) watts for a fully loaded mainframe. An individual module may have either 1 or 2 channels, each of which has its own channel number. Each module contains its own input connectors. The mainframe contains a processor, HP-IB connector and interface circuits, trigger circuits, front-panel keypad and display, and other circuits common to all the load modules.

Each module can operate independently in constant current (CC) mode, constant voltage (CV) mode, or constant resistance (CR) mode. In addition, each input can be turned on or off (open circuit) or short circuited.

Features include built-in HP-IB interface and built-in pulse generator, both standard. Pulse mode allows dynamic testing of power supplies and components, without giving the device under test time to heat up. The flexible pulse mode provides six triggering methods, allowing synchronization with a wide variety of events. A Save/Recall feature allows you to save up to 7 complete instrument setups, one of which can be saved in non-volatile memory so that it is recalled automatically at power-on. Also standard is HP-IB readback of actual input voltage and current, and extensive protection and status reporting capability.

The mainframe contains two (one) cooling fans whose speed automatically increases or decreases as the module temperatures rise and fall. This feature reduces overall noise level because the fans do not run at maximum speed at all times.

The input power rating curve for each module is shown in the module-specific pages. See the extended power paragraphs in this section for a description of the power rating curves. Note that regardless of a module's power rating, input current is derated linearly from 2 volts down to 0 volts.

Each load module can be individually controlled either via HP-IB or locally via the front panel. Once a channel is selected

or addressed, all subsequent commands go to that channel until another channel is selected or addressed. Operation of all models is similar, regardless of power ratings. Therefore, the operating instructions given in this manual are generic, and apply to all modules. The module-specific pages provided with each module include specifications and other information pertinent just to a particular model. Some examples described here may use values that are not appropriate for your module, but the example is valid. Some descriptions refer to ranges, limits, full-scale values, and similar terms (for example, low range and high range). Refer to the module-specific pages provided with each module for the actual values.

Programs written for the HP 6060 series of single electronic loads can be used with the multiple loads, easing program development for applications using various members of the HP electronic load family. (Triggering via the ac line frequency or the load's internal timer is available only in the multiple load mainframe.)

If your application requires a greater power or current capacity than one module can provide, load modules can be connected in parallel in CC or CR mode.

FRONT PANEL DESCRIPTION

The front panel includes a 12-character alphanumeric display, 11 status indicators, and four groups of keypads. Ordinarily the alphanumeric display shows the number of the channel presently under front-panel control, and the input voltage and current of that channel. By using the **Meter** key you can sequentially display input power, programming error codes, and protection-circuit status. If any protection circuits are active, that status will be displayed first when you use the **Meter** key. If you change channels via the front panel, any fault information will be displayed first for the new channel. Then you can key through the display in the normal sequence. The alphanumeric display also shows what function is being performed when you use the keypads.

The display also includes 11 annunciators that point to the 11 status labels printed on the front panel. The Constant Current, Constant Resistance, Constant Voltage, Transient, and Unregulated status annunciators are specific to the channel displayed. The Protection, Error, Shift, Remote, Address, and Service ReQuest status annunciators are channel independent.

Four of the keys perform two functions, with the alternative function labeled in blue above the key. The alternative function is selected by first pressing the blue (shift) key, which turns on the Shift annunciator and enables the alternative function.

Note that the front-panel display operates independently from the HP-IB CHANNEL command. In other words, you can select a channel locally (front panel) for which the display will show the input voltage and current, and the controller can subsequently send commands to other channels without changing the channel being displayed.

REMOTE PROGRAMMING

Commands sent to the Electronic Load via HP-IB are decoded by the mainframe microprocessor, which detects syntax and range errors. The mainframe processor also prescales data sent to the modules, and maintains status registers for each module. Three commands have aliases for compatibility with other HP SL instruments. MODE can also be called FUNCTION, INPUT can also be called OUTPUT, and CHANNEL can also be called INSTRUMENT. OUTPUT and INSTRUMENT would typically be used if you want your program to refer to the load modules in terms of the device or instrument under test. Be careful if using INSTRUMENT for CHANNEL in systems that have more than one Electronic Load mainframe; someone looking at the listing in the future may be misled.

LOCAL/REMOTE CONTROL

Local (front panel) control is in effect immediately after power is applied. The front panel keypad and display allow manual control of each individual module when the Electronic Load is used in bench test applications. Remote (computer) control goes into effect (front panel Rmt annunciator is on) as soon as the mainframe receives a command via the HP-IB. A built-in HP-IB interface and HP SL compatible commands allow control and readback of all functions when the Electronic Load is used in computer controlled applications.

With remote control in effect, only the computer can control the Electronic Load; the front panel keypad has no effect. You can, however, still use the front panel display to view the input voltage and current readings. You can return the Electronic Load to local control from remote control by pressing **Local**. This will return the Electronic Load to local control, unless the local-lockout command has been received from the HP-IB computer.

Most of the functions that can be performed remotely over the HP-IB can also be performed locally at the front panel. The names on the keys reflect the HP SL commands that are used to program the various functions. Consequently, learning to operate the Electronic Load from the front panel will aid you when you start to write computer programs.

Details of local operation are covered in *Chapter 4- Local Operation* and fundamentals of remote programming are given in *Chapter 5- Remote Operation*. Complete HP SL programming details are given in the *HP Electronic Loads Programming Reference Guide*. The remaining paragraphs in this chapter describe the operating modes, transient operation, protection features, and other operating features of the Electronic Load.

EXTENDED POWER OPERATION

NOTE

Extended power operation is not available on "B" load modules (HP Models 60501B-60507B). In addition, this feature may not be present in "A" modules produced after 1989.

The extended power feature allows a module to dissipate considerably more than its nominal power rating in many cases. The primary factor limiting the amount of power that can be dissipated is the temperature of the current-control pass transistors, as sensed at the heatsink. A module's nominal power rating is specified for continuous power at high ambient temperature, but in many applications average power is less than 100%, and ambient temperature is considerably lower than the highest specified full-power temperature. In these less-than-extreme applications, each load module can safely dissipate as much as one third more power than its nominal power rating for a limited time.

In effect, each module has two power-limit curves, as shown in Figure 2-1. Whether the module is operating with the nominal power-limit curve or the extended power-limit curve is determined by heatsink temperature. The module turns on with extended power available and extended power continues to be available unless and until the internal temperature rises beyond a safe operating point for extended power. At the point, the module automatically reduces the power-limit curve to the module's nominal power rating, and sets the Extended Power Unavailable (EPU) bit in the status registers. Extended power is available any time the EPU bit (bit 9) is not set. A graph provided in the module-specific specifications under **DC Input Rating** shows the typical time that a module can operate at full extended power after having stabilized at a given average power before extended power becomes unavailable.

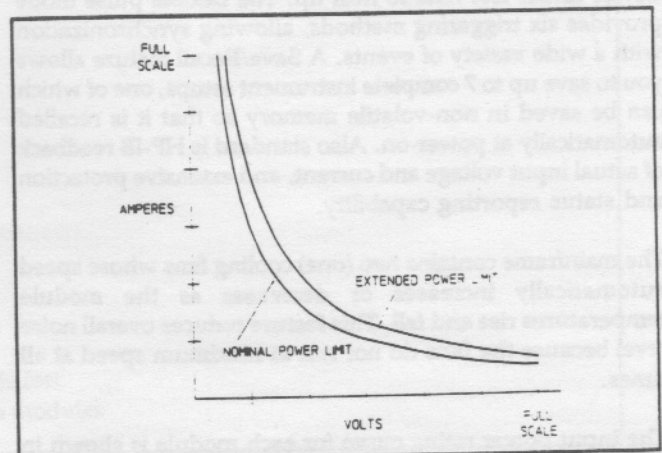


Figure 2-1. Power Limit Curves

PROGRAMMABLE FEATURES

Modes of Operation

The three modes of operation are:

- constant current (CC)
- constant voltage (CV)
- constant resistance (CR)

When programmed to a mode, a module remains in that mode until the mode is changed or until a fault condition, such as an overpower or overtemperature, occurs. When changing modes, the module's input is momentarily disabled (non-conducting state) before the new mode is enabled. This insures that there will be minimum overshoots when changing modes.

The current, resistance, and voltage mode parameters described in subsequent paragraphs can be programmed whether or not the mode is presently selected. When a mode is selected via the front panel or via the HP-IB, most of the associated parameters will take effect at the input (exceptions are noted in the mode descriptions).

Constant Current CC (Mode)

In this mode, the module will sink a current in accordance with the programmed value regardless of the input voltage (see Figure 2-2). The CC mode can be set with front panel keys (**MODE** , **CURR** , and **Enter**) or via the HP-IB (**MODE:CURR** command). The CC mode parameters are discussed in the following paragraphs.

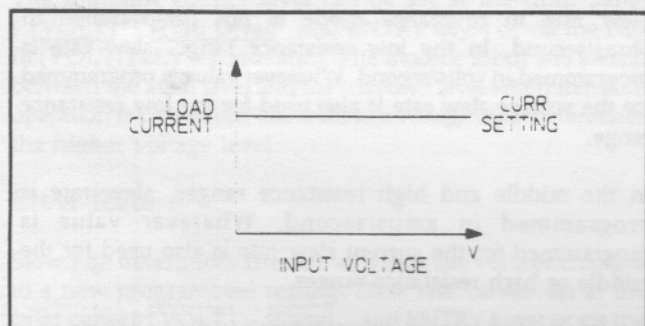


Figure 2-2. Constant Current Mode

Ranges

Current may be programmed in either of two overlapping ranges, a low range and a high range. The low range provides better resolution at low current settings. The range can be set at the front panel (**Range** and **ENTRY** keys) or via the HP-IB (**CURR:RANG** command). Any value in the low range selects the low range. Any value above the maximum of the low range selects the high range. Changing the range affects the module in the same manner as changing modes; i.e., it causes the input to go through a non-conducting state. Note that the values of the present current settings may be automatically adjusted to fit the new range. For example, if 10 A is the present setting and the 0 to 6 A range is then programmed, the current setting will automatically be changed to 6 A; see Chapter 4 - Local Operation.

Immediate Current Level

The current level can be set at the front panel (**CURR** and **ENTRY** keys) or via the HP-IB (**CURR** command). If the CC mode is the active mode, the new setting immediately changes the input at a rate determined by the slew setting

(described below). If the module is not in the CC mode, the new setting is saved for use when the mode is changed to CC.

Triggered Current Level

The current level can be preset (stored in the Electronic Load) allowing the input to be updated when a trigger is received instead of immediately as described above. The current level can only be preset via the HP-IB (**CURR:TRIG** command). The preset capability is not available at the front panel.

If the CC mode is the active mode, the preset current level will become the actual value and the input will be updated when a trigger occurs. If the CC mode is not the active mode, the preset current level will become the actual value when a trigger occurs but there will be no effect on the input until the CC mode becomes active. Once a level is triggered, subsequent triggers will have no effect on the input unless another **CURR:TRIG** command is sent. The trigger sources available to the Electronic Load are described later in this chapter. The Electronic Load has a status reporting capability to keep track of pending triggers and other operating conditions. The status reporting capability is described in detail in the *HP Electronic Loads Programming Reference Guide*.

Transient Current Level

The transient current level can be set at the front panel (**CURR** , **Tran Level** and **ENTRY** keys) or via the HP-IB (**CURR:TLEV** command). The transient current level determines the higher current level when transient operation (described later in this chapter) is turned on. The module input will switch between the main level and the transient level when transient operation is turned on.

Software Current Limit

The Electronic Load allows the user to set a current limit (0 to 102% of full scale) for each module via the HP-IB (**CURR:PROT** command) which will shut down the input if the current limit is exceeded beyond a programmable time delay. Note that the software current limit is in effect for any mode of operation (not just the CC mode). The software current limit feature is described later in this chapter under *Protection Features*.

Slew Rate

Slew rate determines the rate at which the current input to a module changes to a new programmed value. Slew rate can be set at the front panel (**CURR** , **Slew** and **ENTRY** keys) or via the HP-IB (**CURR:SLEW** command). This slew rate remains in effect for the immediate, triggered, and transient level changes previously described.

There are 12 discrete current slew rates within each slew-rate range. Any slew rate value can be sent to a module (there are no upper and lower limits that would cause an error), and a module will automatically select one of the 12 rates

that is closest to the programmed value. The slew rate is rescaled to the closest fit in the 1-of-12 discrete steps if the current range is changed.

Constant Resistance (CR) Mode

In this mode, the module will sink a current linearly proportional to the input voltage in accordance with the programmed resistance (see Figure 2-3). The CR mode can be set at the front panel (**MODE** , **RES** and **Enter** keys) or via the HP-IB (**MODE:RES** command). The CR mode parameters are described in the following paragraphs (see also Appendix A).

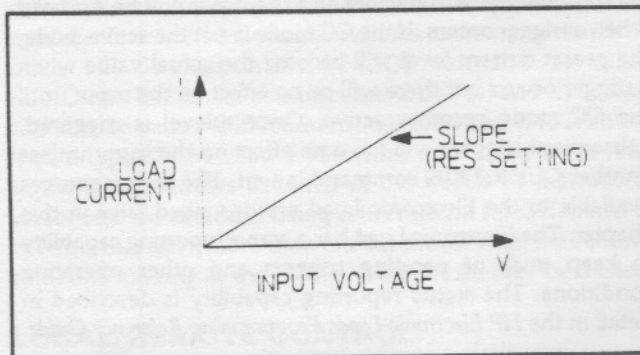


Figure 2-3. Constant Resistance Mode

Ranges

Resistance may be programmed in any of three overlapping ranges (low, middle, high). The range can be set at the front panel (**RES** , **Range** , and **ENTRY** keys) or via the HP-IB (**RES:RANG** command). Any value in the low range selects the low range. Any value that is within the middle range and above the maximum low-range value selects the middle range. Any value that is within the high range and above the maximum middle-range value selects the high range. Note that the values of the present resistance settings may be automatically adjusted to fit within the new range.

Immediate Resistance Level

The resistance level can be set at the front panel (**RES** and **ENTRY** keys) or via the HP-IB (**RES** command). If the CR mode is the active mode, the new setting immediately changes the input at a rate determined by the voltage or current slew setting (see description below). If the module is not in the CR mode, the new setting is saved for use when the mode is changed to CR.

Triggered Resistance Level

The resistance level can be preset (stored in the Electronic Load) allowing the input to be updated when a trigger is received instead of immediately as described above. The resistance level can only be preset via the HP-IB (**RES:TRIG** command). The preset capability is not available at the front panel.

If the CR mode is the active mode, the preset resistance level will become the actual value and the input will be updated when a trigger occurs. If the CR mode is not the active mode, the preset resistance level will become the actual value when a trigger occurs but there will be no effect on the input until the CR mode becomes active. Once a level is triggered, subsequent triggers will have no effect on the input unless another **CURR:TRIG** command is sent.

Transient Resistance Level

The transient resistance level can be set at the front panel (**RES** , **Tran Level** and **ENTRY** keys) or via the HP-IB (**RES:TLEV** command). The transient level and the main level are used in transient operation, which is described later in this chapter. In the low resistance range, the transient level must be set to a **higher** resistance value than the main level. However, in the middle and high resistance ranges, the transient level must be set to a **lower** resistance value than the main level.

Slew Rate

Slew rate in resistance mode is not programmed in ohms/second. In the low resistance range, slew rate is programmed in volts/second. Whatever value is programmed for the voltage slew rate is also used for the low resistance range.

In the middle and high resistance ranges, slew rate is programmed in amps/second. Whatever value is programmed for the current slew rate is also used for the middle or high resistance ranges.

Constant Voltage (CV) Mode

In this mode, the module will attempt to sink enough current to control the source voltage to the programmed value (see Figure 2-4). The module acts as a shunt voltage regulator when operating in the CV mode. The CV mode can be set at the front panel (**MODE** , **VOLT** and **Enter** keys) or via the HP-IB (**MODE:VOLT** command). The CV mode parameters are described in the following paragraphs.

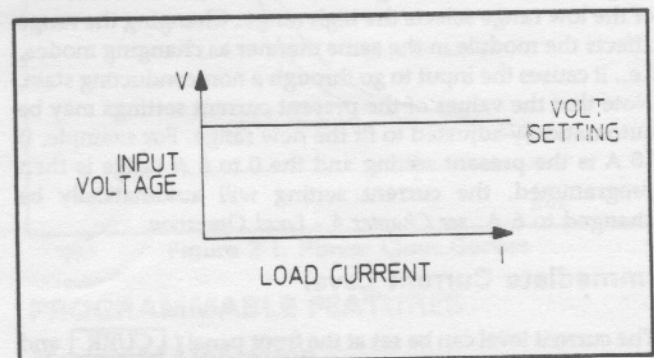


Figure 2-4. Constant Voltage Mode

Range

Voltage mode has only one range.

Immediate Voltage Level

The voltage level can be set at the front panel (**VOLT** and **ENTRY** keys) or via the HP-IB (**VOLT** command). If the CV mode is the active mode, the new setting immediately changes the input at a rate determined by the voltage slew setting. If the module is not in the CV mode, the new setting is saved for use when the mode is changed to CV.

Triggered Voltage Level

The voltage level can be preset (stored in in the Electronic Load) allowing the input to be updated when a trigger is received instead of immediately as described above. The voltage level can only be preset via the HP-IB (**VOLT:TRIG** command).

Transient Voltage Level

The transient voltage level can be set at the front panel (**VOLT** , **Tran Level** and **ENTRY** keys) or via the HP-IB (**VOLT:TLEV** + command). The module input will switch between the main level and the transient level when transient operation is turned on. The transient voltage level determines the higher voltage level.

Slew Rate

Slew rate determines the rate at which the voltage changes to a new programmed setting. Slew rate can be set at the front panel (**VOLT** , **Slew** , and **ENTRY** keys) or via the HP-IB (**VOLT:SLEW** command). This slew rate remains in effect for the immediate, triggered, and transient voltage level changes described above.

There are 12 discrete slew rates that can be programmed for CV Mode slew rate. Any slew-rate value can be sent to a module (there are no upper and lower limits that would cause an error). The module will automatically select one of the 12 rates that is closest to the programmed value. It is important to note that the fastest slew rates cannot be achieved because of bandwidth limitations. The module-specific pages list the usable slew rates.

Transient Operation

Transient operation enables the module to periodically switch between two load levels, as might be required for testing power supplies. A power supply's regulation and transient characteristics can be evaluated by monitoring the supply's output voltage under varying combinations of load levels, frequency, duty cycle, and slew rate. Transient operation can be turned on and off at the front panel (**Tran on/off** key) or via the HP-IB (**TRAN ON** and **TRAN OFF** commands). Before you turn on transient operation, you should set the

desired mode of operation as well as all of the parameters associated with transient operation. Transient operation may be used in the CC, CR, or CV modes and can be continuous, pulsed, or toggled. Note that the pulsed or toggled operation cannot be programmed from the front panel.

Continuous Transient Operation

In continuous operation, a repetitive pulse train switches between two load levels. Continuous transient operation is selected via the HP-IB using the **TRAN:MODE CONT** command. For front panel operation, continuous transient operation is automatically selected when transient operation is turned on (**Tran On/Off** key).

The two load levels in the transient operation are the previously described main level (immediate or triggered) and transient level for current, resistance, or voltage. The rate at which the level changes is determined by the slew rate (see slew rate descriptions for CV, CR, or CV mode as applicable). In addition, the frequency and duty cycle of the continuous pulse train are programmable. The frequency can be set from 0.25 to 10000 Hz at the front panel (**FREQ** and **ENTRY** keys) or via the HP-IB (**TRAN:FREQ** command). The duty cycle can be set from 3% to 97% (0.25 Hz to 1 kHz) or from 6% to 94% (above 1 kHz) at the front panel (**Dcycle** and **ENTRY** keys) or via the HP-IB (**TRAN:DCYC** command).

For example, assume that the CC mode is active, the slew rate is at the default setting (maximum rate), and the applicable transient operation parameters have been set as follows:

HP-SL Command	Description
TRAN:MODE CONT	Sets continuous operation.
CURR 5	Sets main current level to 5 amps.
CURR:TLEV 10	Sets transient current level to 10 amps.
TRAN:FREQ 1000	Sets transient generator frequency to 1 kHz.
TRAN:DCYC 40	Sets transient generator duty cycle to 40%.
TRAN ON	Turns on transient operation.

Figure 2-5 shows the waveform that would result in this example. The module input current will slew to and remain at 10 amps for 40% of the period (400 μ s), then slew to and remain at 5 amps for the remaining 60% (600 μ s) of that cycle.

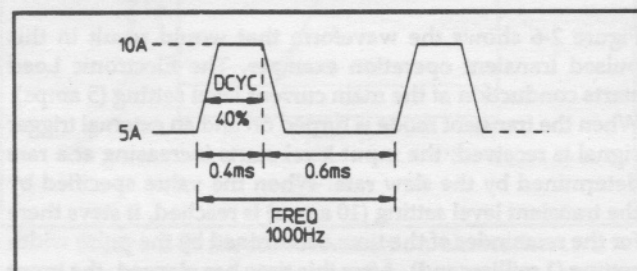


Figure 2-5. Continuous Transient Operation

The load module starts conduction at the main level (in this case 5 amps). When transient operation is turned on and at a time specified by the frequency setting, the input level starts increasing at a rate determined by the slew rate. When the value specified by the transient level setting is reached, it stays there for the remainder of the time determined by the frequency and duty cycle settings. After this time has elapsed, the input level decreases to the main level again at the rate specified by the slew setting and stays there for the remainder of the period prescribed by the frequency setting.

Pulsed Transient Operation

Pulsed transient operation is similar to continuous operation with the following exceptions:

- In order to get a pulse, an explicit trigger is required. The trigger can be an external trigger signal received via the TRIGGER input on the rear panel, the HP-IB GET function, the *TRG common HPSL command, the TRIG subsystem HPSL command, or the ac line or internal timer signal.
- One pulse results from each trigger. Therefore, frequency cannot be programmed. The main level, transient level, and slew rate are programmed as described for continuous operation. The pulse width is programmable from 0.00005 to 4 seconds via the HP-IB (TRAN:TWID command). Pulsed transient operation cannot be programmed at the front panel.
- The appearance of the pulse at each module's input may be delayed from the trigger signal. For pulse widths of 17 ms or greater, delay is less than 1.6% of the pulse width. For pulse widths of less than 17 ms, delay is less than 4% of the pulse width.

In this example, assume that the CC mode is active, the slew rate is at the factory default setting (maximum rate), an external trigger input is connected to the Electronic Load's rear panel, and the applicable transient operation parameters have been set as follows:

HPSL Command	Description
TRIG:SOUR EXT	Selects the external trigger input.
TRAN:MODE PULS	Selects pulsed transient operation.
CURR 5	Sets main current level to 5 amps.
CURR:TLEV 10	Sets transient current level to 10 amps.
TRAN:TWID .001	Sets pulse width to 1 millisecond.
TRAN ON	Turns on transient operation.

Figure 2-6 shows the waveform that would result in this pulsed transient operation example. The Electronic Load starts conduction at the main current level setting (5 amps). When the transient mode is turned on and an external trigger signal is received, the input level starts increasing at a rate determined by the slew rate. When the value specified by the transient level setting (10 amps) is reached, it stays there for the remainder of the time determined by the pulse width setting (1 millisecond). After this time has elapsed, the input level decreases to the main level again at the rate specified

by the slew setting and remains there until another trigger is received. Any triggers that occur during the time the transient level is in effect will be ignored.

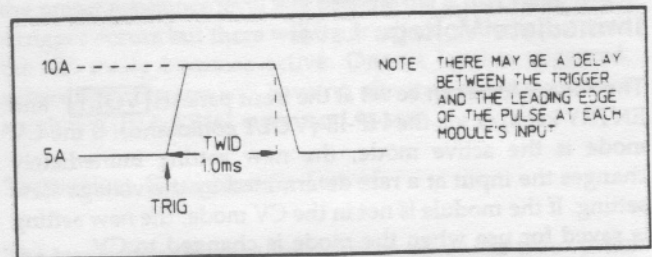


Figure 2-6. Pulsed Transient Operation

Toggled Transient Operation

Toggled transient operation causes the module input to alternate between two predefined levels as in continuous operation except that the transient points are controlled by explicit triggers instead of the internal transient generator. As in pulsed transient operation, the trigger signal can be an external trigger signal, the HP-IB GET function, the *TRG command, the TRIG command, or the ac line or internal timer signals. Note that toggled transient operation can only be programmed via the HP-IB (TRAN:TOGG command); it cannot be programmed at the front panel.

In this example, assume that the CC mode is active, the slew rate is at the factory default setting (maximum rate), an external trigger input signal is connected to the Electronic Load's rear panel, and the applicable transient operation parameters have been set as follows:

HPSL Command	Description
TRIG:SOUR EXT	Selects the external trigger input source.
TRAN:MODE TOGG	Selects toggled operation.
CURR 5	Sets main current level to 5 amps.
CURR:TLEV 10	Sets transient current level to 10 amps.
TRAN ON	Turns on transient operation.

Figure 2-7 shows the waveform that would result for this toggled transient operation example. Operation is similar to that described for continuous and pulse operation, except that each time a trigger is received the input alternates between the main and transient current levels.

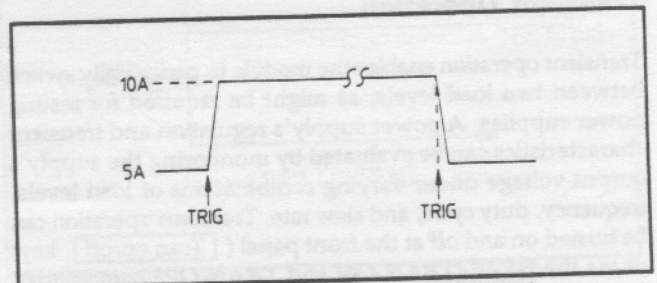


Figure 2-7. Toggled Transient Operation

Triggered Operation

The Electronic Load has various triggering modes to allow synchronization with other test equipment or events. The triggering circuits are located in the mainframe, and all modules receive the trigger simultaneously (although each module is programmed individually as to what operation, if any, will be triggered. As described previously, triggering can be used for the following applications:

Triggering a preset level	Transfers all pending preset levels to the actual level. For the presently active mode, the new level appears at the input. For the modes which are not presently active, the preset levels will not take effect at the input until the applicable mode becomes active.
Triggering a transient pulse	Generates a transient pulse of programmable width when pulsed transient operation is in effect.
Toggling	Changes the input between the main level and the transient level when toggled transient operation is in effect.

Three triggering methods are available over the HP-IB: the GET function, the *TRG common HPSL command, and the TRIG subsystem HPSL command (refer to *HP Electronic Loads Programming Reference Guide*). The HPSL TRIG subsystem allows you to select either the ac line frequency, internal timer, or TRIG command as the trigger source. There is also a TRIGGER connector on the rear panel for external trigger inputs. Triggering cannot be done via the front panel.

*TRG and the TRIG command are both synchronous with other commands; that is, the modules are not triggered until pending operations are completed. GET, external triggers, ac-line triggers, and internal-timer triggers are all asynchronous; that is, the modules are triggered as soon as the trigger signal is received.

If the ac line is selected via the HP-IB as the trigger source, triggers will be generated once for each cycle of ac input power. An ac line frequency of 60 Hz produces a trigger period of 16.67 ms; 50 Hz line frequency produces a trigger period of 20 ms.

The rear-panel TRIGGER connector also provides a trigger output signal. This signal is generated synchronously with the trigger signal sent by the mainframe to the modules. The trigger output signal can be used to trigger an external device such as an oscilloscope, DVM, or another Electronic Load mainframe.

The Electronic Load has a status reporting capability to keep track of trigger operations. Refer to 'Status Reporting' in the *HP Electronic Loads Programming Reference Guide*.

Slew Rate And Minimum Transition Time

Slew rate is defined as the change in current or voltage over time. A programmable slew rate allows a controlled transition from one load setting to another to minimize induced voltage drops on inductive power wiring, or to control induced transients on a test device (such as would occur during power supply transient response testing).

In cases where the transition from one setting to another is large, the actual transition time can be calculated by dividing the voltage or current transition by the slew rate. The actual transition time is defined as the time required for the input to change from 10% to 90% or from 90% to 10% of the programmed excursion. In cases where the transition from one setting to another is small, the small signal bandwidth of the load limits the minimum transition time for all programmable slew rates. Because of this limitation, the actual transition time is longer than the expected time based on the slew rate, as shown in Figure 2-8.

Therefore, both minimum transition time and slew rate must be considered when determining the actual transition time. This is shown in Figure 2-9 for the twelve programmable slew rates in current mode operation. The actual transition time will be either the total slew time (transition divided by slew rate), or the minimum transition time, whichever is longer.

In voltage mode, all minimum transition times are based on a low-capacitance current source. These transition times are affected by capacitive loading of the inputs. For example, a capacitance of 2.2 microfarads increases the 85 microsecond minimum transition time (shown in the specifications table) to 110 microseconds. Therefore, no graph is provided for minimum transition time and slew rate in voltage mode operation.

In resistance mode, the low resistance range uses the slew rate that has been programmed for voltage mode. The middle resistance range uses the slew rate that has been programmed for the high current range. The high resistance range uses the slew rate that has been programmed for the low current range.

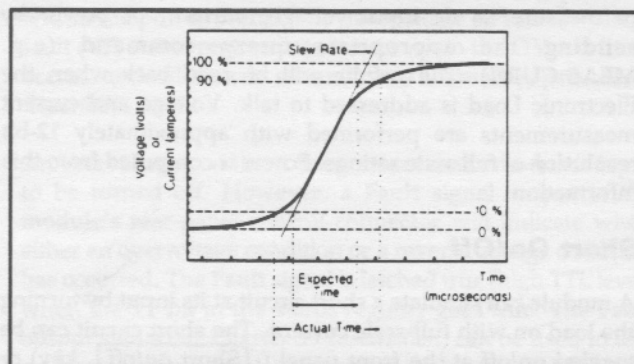


Figure 2-8. Risetime Transition Limitation

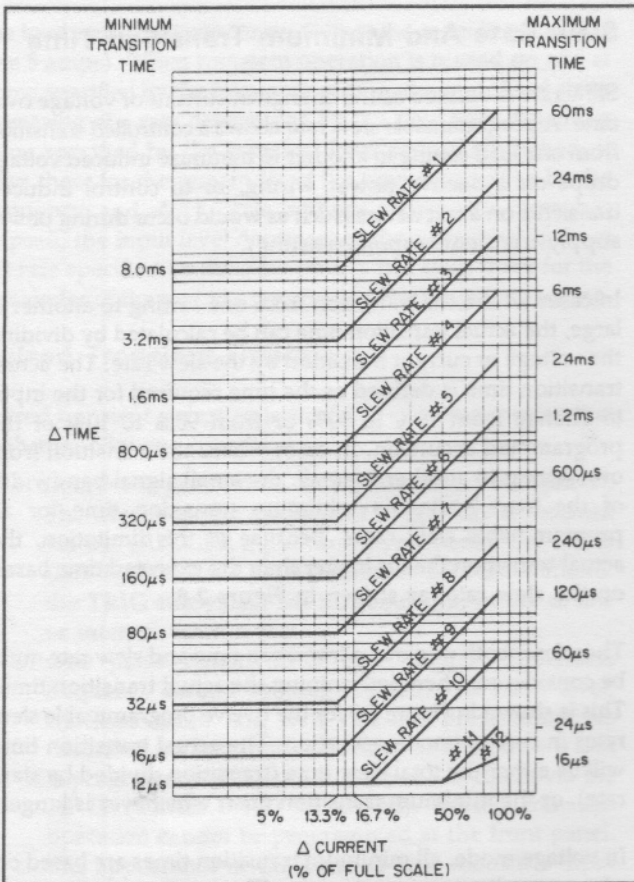


Figure 2-9. Transition Times and Slew Rates

Input Current, Voltage, and Power Measurement

Each module's input current, voltage, and power can be measured at the front panel (**Meter** key) or via the HP-IB (MEAS command). With local (front panel) control in effect, pressing **Meter** will continually step the display through voltage and current input values, the computed power value, and various status conditions for the selected channel.

With remote control in effect, a module may be instructed to measure its dc input voltage, current, or power by sending the appropriate query command (e.g. MEAS:CURR). The results will be read back when the Electronic Load is addressed to talk. Voltage and current measurements are performed with approximately 12-bit resolution of full scale ratings. Power is computed from this information.

Short On/Off

A module can simulate a short circuit at its input by turning the load on with full-scale current. The short circuit can be toggled on/off at the front panel (**Short on/off** key) or via the HP-IB (INPUT:SHORT ON|OFF command). The short on/off change uses the slew rate setting of the active mode and range.

The actual value of the electronic short is dependent on the mode and range that are active when the short is turned on. In CV mode it is equivalent to programming zero volts. In CC mode it is equivalent to programming full-scale current for the present current range. In CR mode it is equivalent to programming the minimum resistance for the present resistance range.

Note that turning the short on in CV mode may cause the load to draw so much current that the software current limit operates, which may turn the input off.

Turning the short circuit on does not affect the programmed settings, and the load input will return to the previously programmed values when the short is turned off.

CAUTION

Pressing the Short On/Off key with certain user applications may cause damage to the equipment being tested, which may result in personal injury. Contact your HP Sales and Service office if you need to have the Short On/Off key disabled.

Input On/Off

A module's input can be toggled on/off at the front panel (**Input on/off** key) or via the HP-IB (INPUT ON|OFF command). The input on/off change does not use the slew rate setting so the input will change at the maximum slew rate.

Turning the input off (zero current) does not affect the programmed settings. The input will return to the previously programmed values when the input is turned on again. Note that the Input On/Off command supersedes the mode commands and Short On/Off command.

Saving and Recalling Settings

The Electronic Load has internal registers in which settings (mode, current, voltage, resistance, slew, transient level, etc.) for each module can be saved. By saving settings and recalling them later you can save programming time.

The present settings for all channels are saved in the specified register (0 to 6) at the front panel (**Save** key) or via the HP-IB (*SAV command). All of the settings are saved in the specified location in the mainframe's memory. Settings saved in locations 1 through 6 will be lost when ac line power is cycled. However, the *SAV 0 command will cause the settings to be stored in non-volatile memory; and, the next time the Electronic Load is turned on, these settings will become the power-on settings.

You can recall the saved settings from the specified register (0 to 6) at the front panel (**Recall** key) or via the HP-IB (*RCL command). All of the parameters for each module which were saved by the *SAV command are set to the saved

values. At power-on, the Electronic Load automatically executes a *RCL 0, which recalls the values saved in non-volatile memory.

You can recall the factory default settings at the front panel (**Recall** **7**) or via the HP-IB (*RST command).

Remember that Save and Recall operate on all channels, not just the presently addressed or selected channel.

Reading Remote Programming Errors

Remote programming errors can be read via the HP-IB (SYST:ERR? query) or at the front panel (**Error** key). The Err annunciator indicates when remote programming errors have occurred. The errors are negative numbers grouped into blocks of 100 as follows:

- 1xx Command errors
- 2xx Execution errors
- 3xx Device-specific errors
- 4xx Query errors

The SYST:ERR? query (or **Error** key) reads back the errors in the order in which they occurred (the error queue can hold up to 30 entries). Once the error is read back it is removed from the list. A value 0 indicates there is no error; and 0 will be returned when all errors in the list have been read. Pressing the **Error** key displays just the error number. The SYST:ERR? query returns the error number and a short description of the error to the computer. Refer to Chapter 6 in the *HP Electronic Loads Programming Reference Guide*.

Local programming errors generated by front panel operations are not put into the error list, but are immediately put on the Electronic Load's front panel display; e.g., 'OUT OF RANGE'.

Status Reporting

The Electronic Load incorporates a status reporting capability. Various status conditions within the Electronic Load can be reported using this capability. The user determines which condition(s) will be reported. Chapter 5 of the *HP Electronic Loads Programming Reference Guide* describes each of the status registers in the electronic load. (These registers, including the channel status registers, are all maintained in the mainframe.) Notice that the same information is available in both the channel status and questionable status registers, but the channel registers are organized by channel, and the questionable registers are organized by fault. Therefore, depending on which channels and/or faults are most critical in your application, you can use one branch to localize selected faults quickly, and use the other branch for broader fault reporting. By knowing that only a particular fault (questionable branch) or a particular channel (channel branch) is enabled to initiate a service request, you can eliminate the need to read one or more registers to locate a fault.

PROTECTION FEATURES

Each load module includes the following protection features:

- Overvoltage
- Overcurrent (hardware and software)
- Overpower (hardware and software)
- Overtemperature
- Reverse Voltage

The appropriate bit(s) in the mainframe's status registers are set when any of the above protection features are active. Also, the Prot annunciator comes on and the front-panel alphanumeric display indicates which condition(s) have been detected. For example, if an overtemperature (OT) condition has been detected causing a module's input to be turned off (protection shutdown, PS), the display will indicate "PS OT".

Resetting Latched Protection

All of the protection features latch (remain set) when they are tripped, except for the hardware overcurrent and reverse voltage. The latched protection features can be reset via the HP-IB (*RST or INP:PROT:CLE commands) or at the front panel (**Prot Clear** key). Of course, the condition that caused the protection feature to trip must be removed or it will trip again as soon as it is reset.

CAUTION

To protect the Electronic Load from possible damage, the input voltage must not exceed the maximum input voltage rating specified in the module-specific pages supplied with each module. Never apply the ac line voltage to a module's input binding posts.

Overvoltage

The overvoltage protection circuit is set at a predetermined voltage, which cannot be changed. If the overvoltage circuit has tripped, the module will attempt to limit the voltage by drawing current from the DC source. The module limits the value of current drawn such that the resulting power is within the power rating. The overvoltage (OV) and voltage fault (VF) status register bits are set when the OV condition occurs, and will remain set until they are reset as previously described.

An overvoltage condition does not cause the module's input to be turned off. However, a Fault signal output at the module's rear-panel control connector will indicate when either an overvoltage condition or a reverse voltage condition has occurred. The Fault signal is latched true (high TTL level) when the VF bit in the status register goes true. The Fault output signal (see Chapter 3 - Installation) can be used to trip an external circuit breaker or control a relay (e.g., HP 59510A Relay Accessory) in order to disconnect the Electronic Load input from the source it is testing when an overvoltage or a reverse voltage condition occurs.

Overcurrent

The Electronic Load includes both hardware and software overcurrent protection features.

Hardware. When operating in the CR or CV mode, it is possible for a module to attempt to sink more current than it is rated for.

Under this condition, the load current will be limited by a current limit circuit, which is set at a value slightly above the current rating of the module. It protects both the Electronic Load and the device under test from operating too far beyond specified limits. The hardware current limit circuit does not turn the module's input off. The overcurrent (OC) bit in the status register is set when an OC condition occurs, and is reset when the OC condition is removed.

Software. In addition to the hardware overcurrent protection circuit, the Electronic Load allows the user to define a current protection limit in software which will shut down a module's input if the limit is exceeded. This feature can only be programmed via the HP-IB. It is turned on/off using the **CURR:PROT:STATE ON|OFF** command. The software current limit level (in amps) is set using the **CURR:PROT** command. A programmable delay (in seconds) before trip is also provided with the **CURR:PROT:DEL** command. If the software overcurrent limit is exceeded and persists beyond the specified delay time, the module is turned off. Also, for these conditions, the OC and PS (protection shutdown) status register bits are set and will remain set until the OC condition is removed and the bits are reset as previously described.

Overpower

A load module's response to an overpower condition depends on whether the module was operating with the nominal power limit or the extended power limit when the overpower condition occurred.

Nominal Power Limit. The nominal power-limit boundary is set by software that monitors the input current and voltage. If the input power exceeds the nominal power limit, the load module sets the overpower status bit, which will reset if the overpower condition ceases. If the overpower condition persists for 3 seconds, the load module's input circuit turns off, and the OP and PS status bits are both latched on. The input circuit remains off, and the OP and PS status bits remain set, until protection clear occurs. Of course, if the overpower condition is not corrected, the load will turn off again.

Extended Power Limit. The extended power-limit boundary is set by hardware circuits. This hardware power-limit circuit can be activated by any of three conditions:

1. if an overpower condition occurs while the module is operating in the extended power area

2. during certain large programmed changes
3. if the nominal power limit is exceeded (the software limit sets the OP bit and starts the 3-second timer, but does limit the input power)

If the hardware power-limit circuit becomes active, it attempts to limit power by limiting the current drawn by the load.

Once the power has been returned to the safe operating area, the protective circuit allows the current to rise again. This protective sequence can turn on and off (approximately 5% of full scale peak-to-peak) at rates from 2 kHz to 12 kHz. It will continue until the overpower condition ceases, or the module's heatsink temperature rises enough to cause the module to impose the nominal power limit. With the nominal power limit in effect, the module's input circuit will open after the 3-second delay. Note that this oscillation is a design feature that protects your instrument while preventing nuisance shutdowns caused by transient conditions.

Overtemperature

Each module has an overtemperature (OT) protection circuit which will turn off the input if the internal temperature exceeds safe limits. If the OT circuit activates, the OT and PS status register bits are set and will remain set until they are reset. If the OT condition still exists when the reset is executed, the module's input will remain off. You must wait until the module cools down before you can reset the OT circuit. The fan(s) will continue to operate to cool the unit as quickly as possible.

Reverse Voltage

CAUTION

This feature protects the load module in case the input dc voltage lines are connected with the wrong polarity. If a reverse voltage (RV) condition is detected, turn off power to the dc source and the Electronic Load and make the correct connections.

The Electronic Load conducts reverse current when the polarity of the DC source connection is incorrect. The maximum safe reverse current is specified in the module-specific pages. The reverse voltage (RV) and voltage fault (VF) bits in the status register are set when reverse voltage is applied. When the reverse voltage is removed the RV bit is cleared. However, the VF bit remains set until it is reset. As previously described, the **Fault** output signal at the control connector tracks the state of the VF bit. The **Fault** signal can be used to control an external relay in order to disconnect the module from the dc source if an RV condition occurs.

CONTROL CONNECTOR

Each module has a 10-pin connector mounted on its rear panel. These signals are described in the following paragraphs. See Chapter 3 for connection details.

Remote Sensing

The remote sensing inputs, +S and -S, can be used in CV or CR modes. By eliminating the effect of the inevitable voltage drop in the load leads, remote sensing provides greater accuracy by allowing the load to regulate directly at the source's output terminals, as well as measure the voltage there.

Monitor Outputs

The IMON and VMON output signals indicate the input current and voltage. A 0-to-10V signal at the appropriate output indicates the zero-to-full scale input current or voltage. An external DVM or oscilloscope can be connected to monitor the input voltage and current.

External Programming Input

CC and CV modes can be programmed with a signal (ac or dc) connected to the Ext Prog input. A 0-to-10V external signal corresponds to the 0-to-full scale input range in CV mode or in CC mode. The external programming signal is combined with the value programmed via the HP-IB or the front panel, so that, for example, a programmed value of one-half full scale and a 5-volt external programming input would produce a full-scale value at the input.

Figure 2-10 shows the input waveform that would result from the following setup:

- CC Mode
- 60 A Range
- 20 A Input (programmed via HP-IB or front panel)
- ± 1 V (2 V pk-pk) 1 kHz external programming signal

The external programming signal (+ and - 1 volt) corresponds to + and - 6 amps at the input (1 volt external programming input = 1/10 full scale). Therefore, the input varies ± 6 A at the 20 A level.

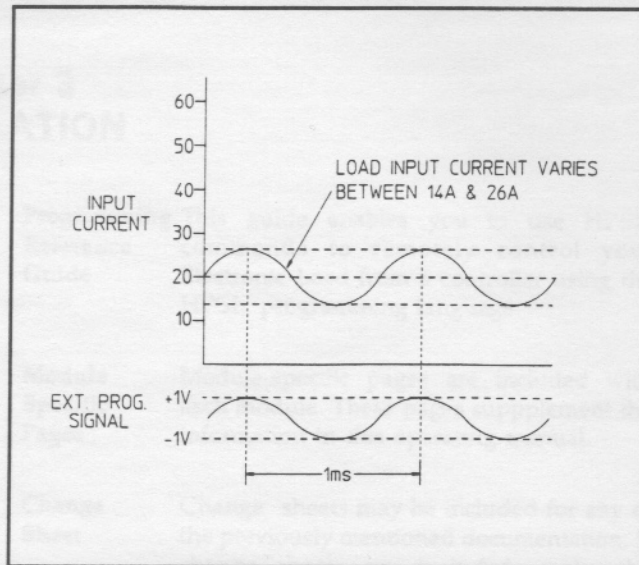


Figure 2-10. External Programming Example

Fault

The Fault signal becomes active if an overvoltage or reverse voltage occurs at the input, as described in the Protection Features paragraphs.

Port On/Off

Port is a general purpose output port that can be used to control an external device such as a relay for power supply test purposes. The output is toggled on and off via the HP-IB (PORT0 ON/OFF command). It cannot be controlled from the front panel.

The Port output signal is a TTL compatible signal that becomes active (high level) when the PORT command is programmed ON and becomes inactive (low level) when the PORT command is programmed OFF.

Chapter 3 INSTALLATION

INTRODUCTION

This chapter discusses how to install the modules and make connections to the rear panel of your HP 6050A or HP 6051A Electronic Loads. A turn-on checkout procedure as well as application considerations for specific operating modes are also discussed.

INSPECTION

When you receive your Electronic Load, inspect it for any obvious damage that may have occurred during shipment. If there is damage, immediately notify the carrier and the nearest HP Sales Office. Warranty information is printed on the inside front cover of this manual.

Save the shipping cartons and packing materials in case a module or the mainframe must be returned to Hewlett-Packard in the future. If you return a unit for service, attach a tag identifying the owner and model number. Also include a brief description of the problem.

In addition to this manual, check that the following items have been received with your mainframe and module:

Power Cord	Your Electronic Load was shipped with a power cord for the type of outlet used at your location. If the appropriate cord was not included, contact your nearest HP Sales and Service Office to obtain the correct cord (see Figure 3-1 for the part number and order option).
Trigger Connector	A 4-pin trigger connector is shipped with your mainframe. This connector is discussed later in this chapter.
Control Connector	A 10-pin control connector is shipped with each module. This connector is discussed later in this chapter.

Programming Reference Guide This guide enables you to use HP-SL commands to remotely control your Electronic Load from a controller using the HP-SL programming language.

Module Specific Pages Module-specific pages are included with each module. These pages supplement the information in this operating manual.

Change Sheet Change sheets may be included for any of the previously mentioned documentation. If change sheets are included, make the corrections to the appropriate manual.

INSTALLING THE MODULES

CAUTION

Modules can be damaged by electrostatic discharge (static electricity). Use standard anti-static work practices such as using wrist straps when handling and installing modules. Avoid touching the circuit boards.

Other than observing standard anti-static work practices, no special tools are required to install modules inside a mainframe. The HP 6050A mainframe has enough room for six single-width modules (e.g. HP 60501A), or three double-width modules (e.g. HP 60504A). Modules can be combined in the mainframe in any order. The HP 6051A mainframe has only enough room for two single-width modules or one double-width module. The module installation procedure is the same for both mainframes.

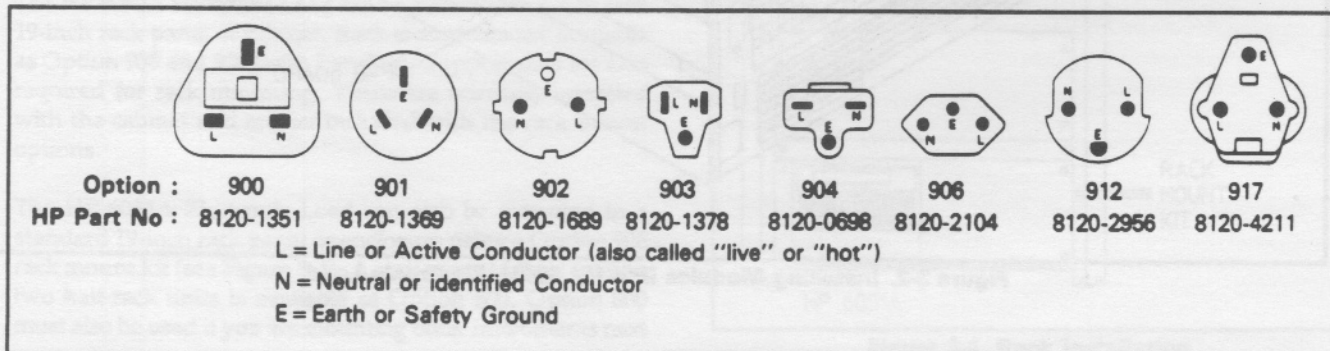


Figure 3-1. Power cord Configurations

Procedure

1. With the mainframe off, disconnect the power cord and remove the top cover by loosening the thumbscrews.
2. Remove any packing material from inside the mainframe.
3. Grasp the module using the quarter-turn locking fastener and the input binding posts. This reduces the possibility of damage to static sensitive components on the PC board.
4. Start installing the modules in the slot next to the HP-IB board (see Figure 3-2.)
5. Lock the module in place using the quarter-turn locking fastener and the rear panel thumbscrew. Hand-tighten only.
6. Connect the three ribbon cables to the adjacent connector pins in the HP-IB board (or adjacent module). Make sure the connectors are properly seated.
7. If applicable, install each additional module in the slot next to the previous module in the same manner (go back to step 3).
8. Replace the top cover after all modules are installed.

NOTE

Fully hand-tighten the cover thumbscrews. This engages an internal safety switch. The Electronic Load will not turn on if the thumbscrews are left loose.

Channel Number

The channel number of a specific module is determined by the location of that module in relation to the HP-IB board. For example, the module next to the HP-IB board is always channel number one. Numbering continues sequentially so that the module furthest from the HP-IB board is the highest numbered channel in your system.

Figure 3-3 shows the channel assignments for a HP 6050A Electronic Load mainframe containing two HP 60502A single-width modules and two HP 60504A double-width modules. One channel number is automatically assigned to each module according to the order in which it was installed in the mainframe. At this time, the maximum number of available channels is six for HP 6050A mainframes, and two for HP 6051A mainframes.

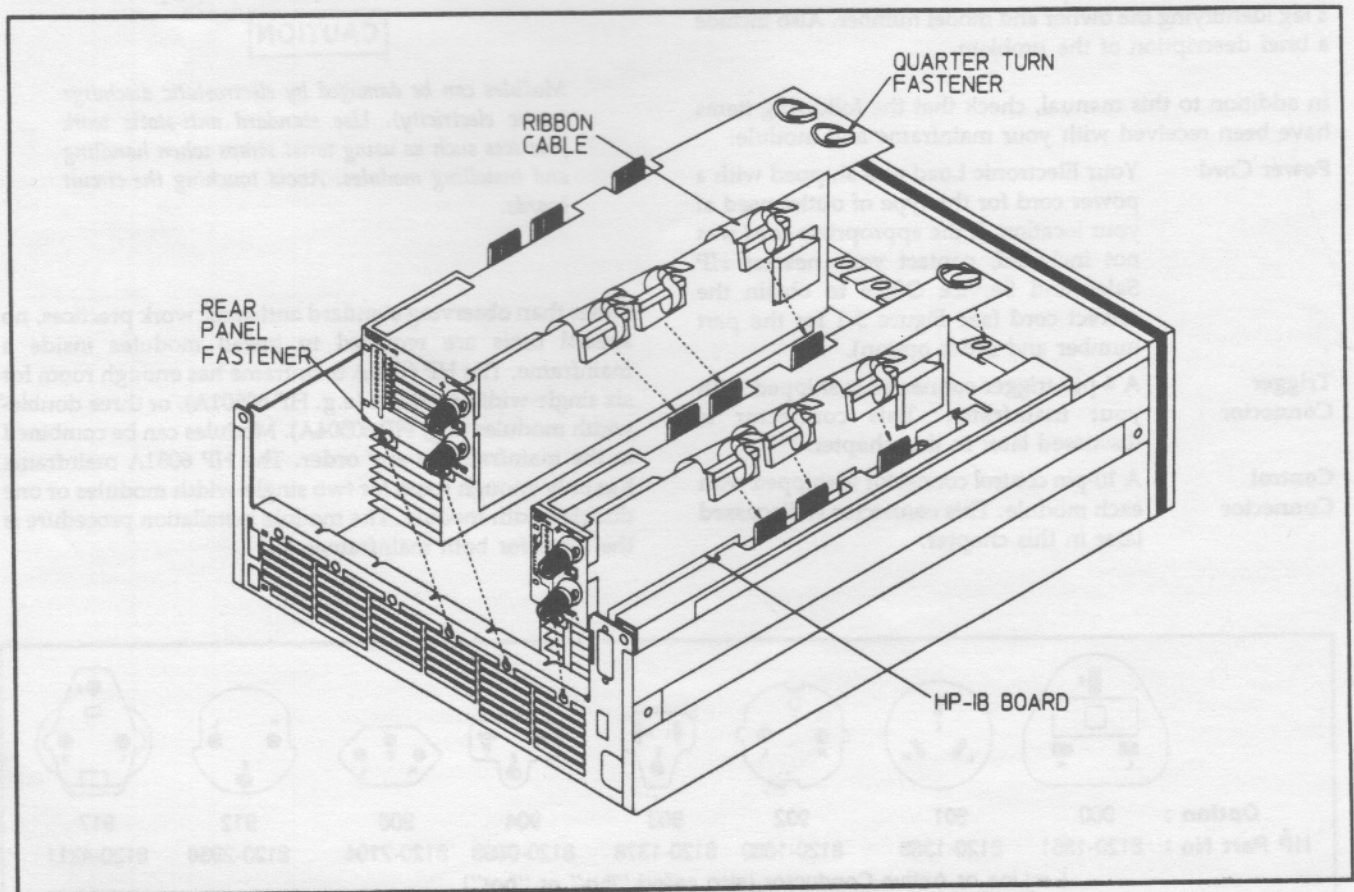


Figure 3-2. Installing Modules in a HP 6050A Electronic Load

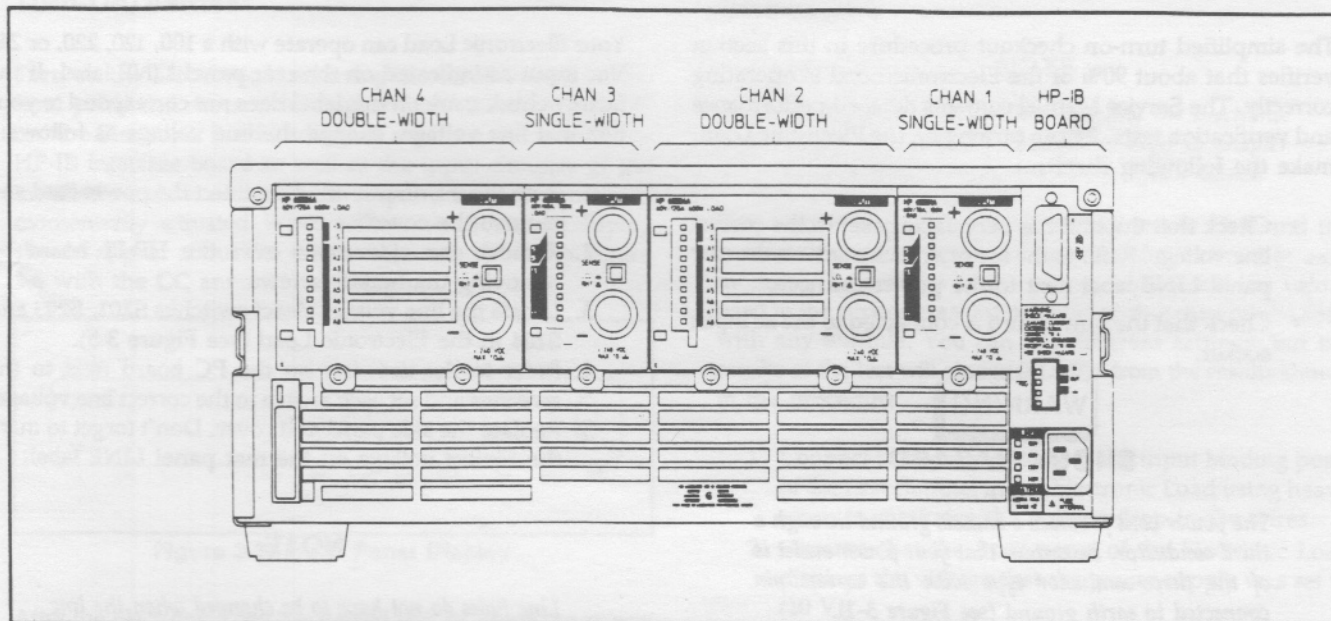


Figure 3-3. Channel Number Example (HP 6050A)

INSTALLING THE MAINFRAMES

The dimensions of the HP 6050A and HP 6051A Electronic Loads are specified in Chapter 1. The mainframes have plastic feet that are shaped to ensure self-alignment when stacked with other HP System II instruments. The feet can be removed for rack mounting.

Cooling

The Electronic Loads can operate without loss of performance within the temperature range of 0° to 40°C, and with derated performance from 40° to 55° C. However, you must install your Electronic Load in a location that allows sufficient space at the top, sides, and rear of the unit for adequate air circulation. Variable-speed fans cool the unit by drawing in air through the top and sides and exhausting it out the back. You must leave at least 1.5 cm (0.5 in.) space above the unit for adequate air circulation. Note that the unit's feet allow enough vertical space for air circulation when units are stacked.

Rack Mounting

The HP 6050A Electronic Load can be mounted in a standard 19-inch rack panel or cabinet. Rack mount kits are available as Option 908 and 909 (with handles). Support rails are also required for rack mounting. These are normally supplied with the cabinet and are *not* included with the rack mount options.

The HP 6051A Electronic Load can also be mounted in a standard 19-inch rack panel or enclosure using a Option 908 rack mount kit (see Figure 3-4). A rack mount kit for joining two half-rack units is available as Option 800. Option 800 must also be used if you are mounting other instruments next

to an HP 6051A Electronic Load. Support rails are also required for rack mounting. These are normally supplied with the cabinet and are not included with the rack mount options.

If you are installing equipment on top of your Electronic Load in the cabinet, use a filler panel above the unit to ensure adequate space for air circulation. A 1U panel (EIA Standard RS-310-C) as shown in Figure 3-4 is sufficient. If your cabinet has a circulation fan, avoid installing the Electronic Load too close to the cabinet fan. The cabinet fan may restrict the airflow required through the Electronic Load.

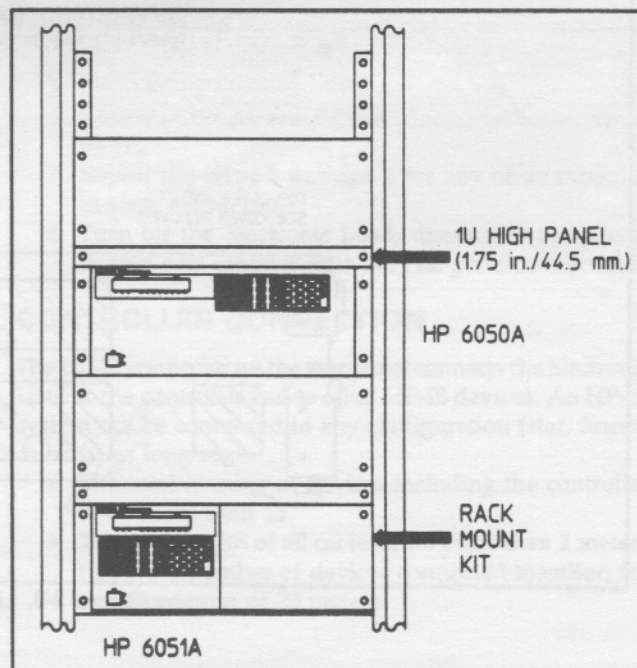


Figure 3-4. Rack Installation

TURN-ON CHECKOUT

The simplified turn-on checkout procedure in this section verifies that about 90% of the Electronic Load is operating correctly. The Service Manual contains detailed performance and verification tests. Before turning on the Electronic Load, make the following checks:

- Check that the unit has been factory set to the correct line voltage. Refer to the factory check mark on the rear panel **LINE** label next to the power connector.
- Check that the power cord is connected to the ac input socket.

WARNING

SHOCK HAZARD

The power cord provides a chassis ground through a third conductor. Be certain that your power outlet is of the three-conductor type with the correct pin connected to earth ground (see Figure 3-1).

- Check that all sense switches on the modules are set to **LCL** (depressed).
- Check that the cover is installed with the thumbscrews fully tightened.

Changing Line Voltage

Your Electronic Load can operate with a 100, 120, 220, or 240 Vac input as indicated on the rear panel **LINE** label. If the factory check mark on this label does not correspond to your nominal line voltage, change the line voltage as follows:

1. With the mainframe off, disconnect the power cord and remove the cover.
2. Remove the side cover over the HP-IB board by removing the handle screws.
3. Locate the line voltage select switches **S202**, **S203** and **S204** in the Electronic Load (see Figure 3-5).
4. Refer to the drawing on the PC board next to the switches and set each switch to the correct line voltage.
5. Replace the side panel and cover. Don't forget to mark the correct voltage on the rear panel **LINE** label.

NOTE

Line fuses do not have to be changed when the line voltage selection is changed. The line fuses will protect the electronic Load on any of the indicated voltage settings. Line fuses are discussed in the Service Manual.

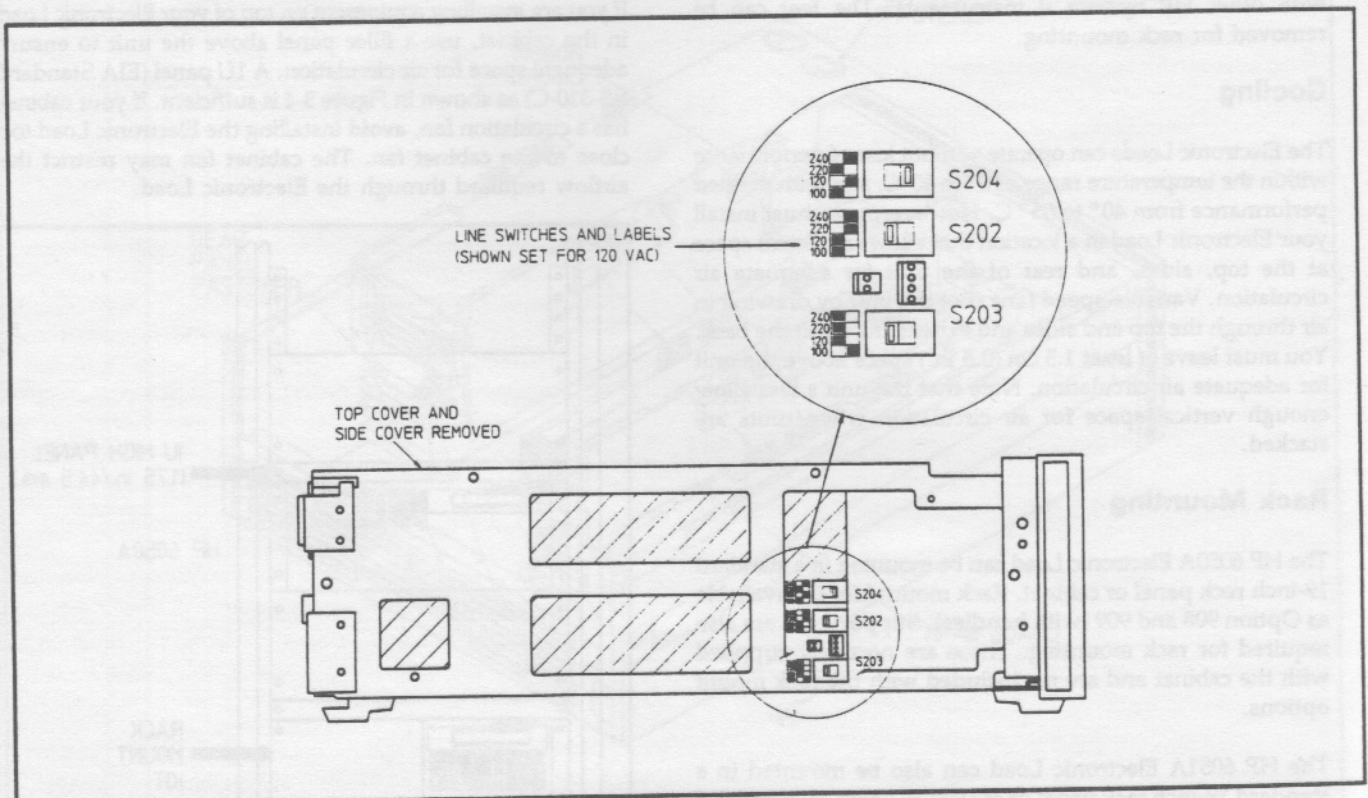


Figure 3-5. Line Voltage Switches

Turn-On/Selftest

Turn on the Electronic Load using the **LINE** switch on the front panel and observe the display. Immediately after turn-on, the Electronic Load undergoes a selftest that checks the HP-IB interface board as well as the input circuitry of the installed modules. All of the front panel LCD segments are momentarily activated. When selftest completes, the display should appear about the same as the one shown in Figure 3-6 with the **CC** annunciator being on.

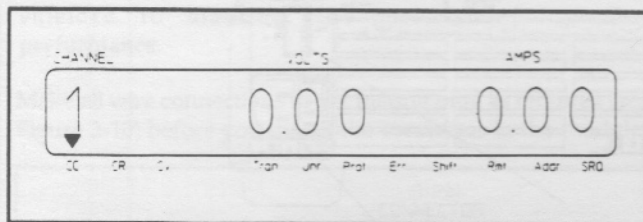


Figure 3-6. Front Panel Display

After the Electronic Load has passed selftest, connect a power supply to the Electronic Load to test the input circuits as described under "Power Test".

If the Electronic Load fails any portion of the selftest, one of the following error numbers may briefly appear on the display:

HP-IB Errors		Channel Errors	
Display	Description	Display*	Description
ERROR 1	RAM failure	1 ERROR 100	Self test error
ERROR 2	ROM failure	1 ERROR 101	Secondary RAM failure
ERROR 3	HP-IB failure	1 ERROR 102	Secondary ROM failure
ERROR 4	Internal trigger failed	1 ERROR 103	Secondary timer trigger failed
ERROR 5	Line trigger failed	1 ERROR 104**	Calibration EEprom failed
ERROR 6	Timer trigger failed	1 ERROR 105	Main DAC high
ERROR 7	EEprom failed	1 ERROR 106	Main DAC low
		1 ERROR 107	Transient DAC high
		1 ERROR 108	Transient DAC low

* The applicable channel number is displayed for Multiple Electronic Loads starting with the lowest numbered channel. Error numbers are not related to the negative numbers returned by the **SYST:ERR?** query.

** Requires recalibration

Another indication that a selftest failure has occurred is if the **ERR** annunciator on the display remains on after selftest completes.

If the Electronic Load has failed selftest, return the mainframe or module to the nearest HP Sales and Service Office for repair.

Power Test

NOTE

The following checkout assumes that the Electronic Load is set to the factory defaults. Refer to Chapter 4 if you need to recall the factory default values.

Use a power supply with the voltage set to 10 V and the current limit set to 10 A to check the input circuit of each module. The settings of the power supply and the values used in the procedure were selected so that they can be used with any module. You can use different settings, but the results of the test will obviously differ from the results shown in the procedure.

1. Connect the power supply to the input binding posts of the first channel in the Electronic Load using heavy wires to minimize the voltage drop in the wires.
2. Observe that the front panel of the Electronic Load displays the voltage that the power supply was set to (10 V).
3. Depress the following front panel keys in the indicated order:

Curr **5** **Enter**

4. Observe that the Electronic Load is drawing 5 A and is operating in **CC** mode. The power supply should be operating in **CV** mode. The Electronic Load front panel display should appear about the same as the one shown in Figure 3-7.

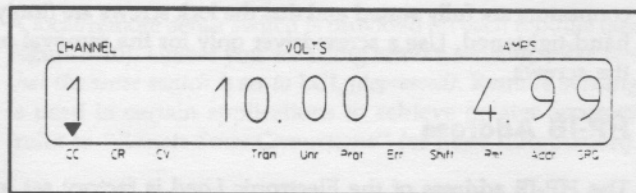


Figure 3-7. Power Test Display

5. Depress the **Meter** key.
6. Observe that the front panel display indicates about 50 W.
7. Repeat the steps 1 through 6 for any other modules in your mainframe.
8. Turn off the Electronic Load, disconnect the power supply, and continue with the rear panel connections.

CONTROLLER CONNECTION

The HP-IB connector on the rear panel connects the Electronic Load to the controller and to other HP-IB devices. An HP-IB system can be connected in any configuration (star, linear, or both) as long as:

- The total number of devices including the controller is no more than 15.
- The total length of all cables is no more than 2 meters times the number of devices connected together, up to a maximum of 20 meters.

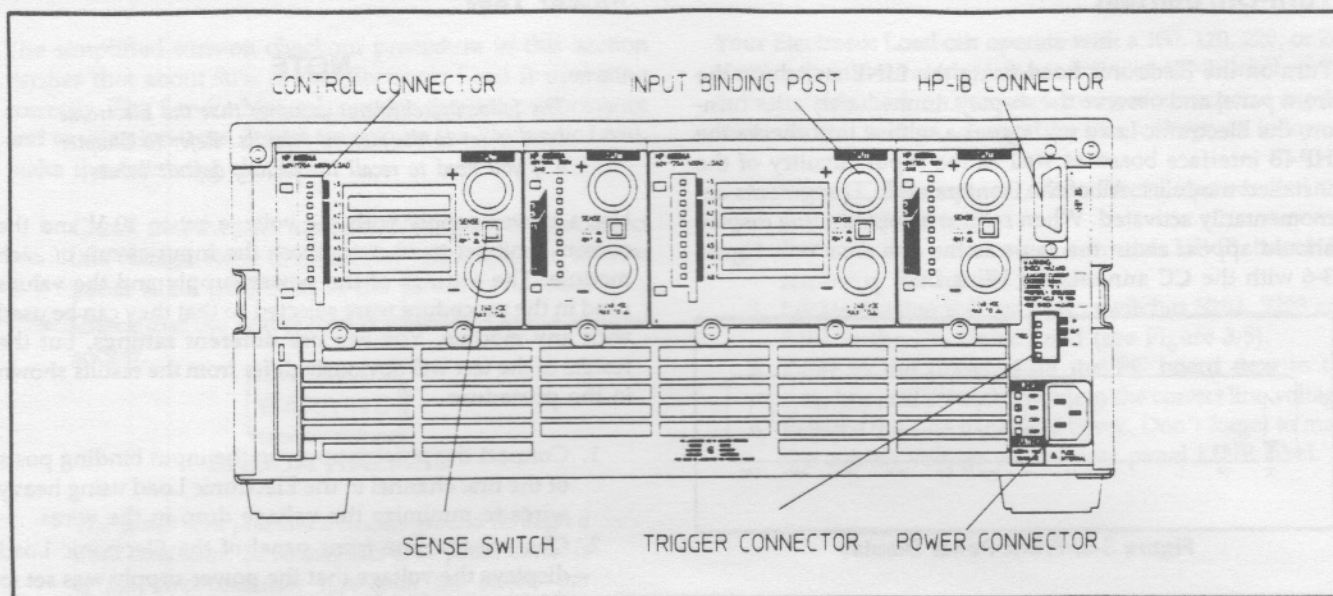


Figure 3-8. Rear Panel

NOTE

IEEE Std. 488-1978 states that you should exercise caution if an individual cable length exceeds 4 meters.

Do not stack more than three connector blocks together on any HP-IB connector. The resultant leverage can exert excessive force on the mounting panels. Make sure that all connectors are fully seated and that the lock screws are firmly hand-tightened. Use a screwdriver only for the removal of the screws.

HP-IB Address

The HP-IB address of the Electronic Load is factory set to address 5. The HP-IB address can only be set using the front panel **Address** and **ENTRY** keys. Chapter 4 explains how to change the HP-IB address.

REAR PANEL CONNECTORS AND SWITCHES

Figure 3-8 shows the rear panel of the HP 6050A Electronic Load. The input binding posts, control connectors, and trigger connector are used for application connections.

Input Binding Posts

Two screw-down binding posts (+ and -) are provided on each module for connecting the input wires to the Electronic Load (see Figure 3-9). Connections are made as follows:

1. Strip back the wire insulation as indicated:

Wire Size	Strip back:
AWG 4	6 mm (0.65 in.)
AWG 6 or 8	13 mm (0.5 in.)
AWG 10 or smaller	10 mm (0.4 in.)

AWG 4 is the maximum wire size. Stranded copper wire, size AWG 6 or 8, is the recommended wire. If

you are connecting more than one wire on each post, twist the wires to ensure a good contact when the adjustment knob is tightened.

2. Insert the wire into the binding post.

WARNING

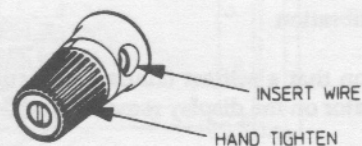
SHOCK HAZARD

To prevent accidental contact with hazardous voltages, do not extend the wire beyond the contact area inside the binding post.

3. Hand tighten the adjustment knob to secure the wire in the binding post. If you are using a slotted screwdriver, tighten the knob to 8 in.-lbf for a secure connection.

CAUTION

Do not use lubricants or contact cleaners on the binding posts. Certain chemical agents can damage the LEXAN material of the binding post, causing the part to fail.



NOTES:

1. WIRE SIZE AWG 4 MAXIMUM.
2. STRIP BACK INSULATION (13mm FOR AWG 6 OR 8)
3. INSERT WIRES IN HOLE IN BINDING POSTS
4. TIGHTEN TO 8 in-lbf
5. OBSERVE PROPER POLARITY WHEN CONNECTING LEADS TO SOURCE

Figure 3-9. Input Binding Post

Control Connector

A ten-pin connector and a quick-disconnect mating plug (HP part number 0360-2345) are provided on each module for connecting remote sense leads, external V/I monitors, an external programming input, and external control lines (see Figure 3-10). The mating plug is packaged in an envelope that is included with the module.

Consistent with good engineering practice, all leads connected to the control connector should be twisted and shielded to maintain the instrument's specified performance.

Make all wire connections to the mating plug as required (see Figure 3-10) before you install the connector in the module.

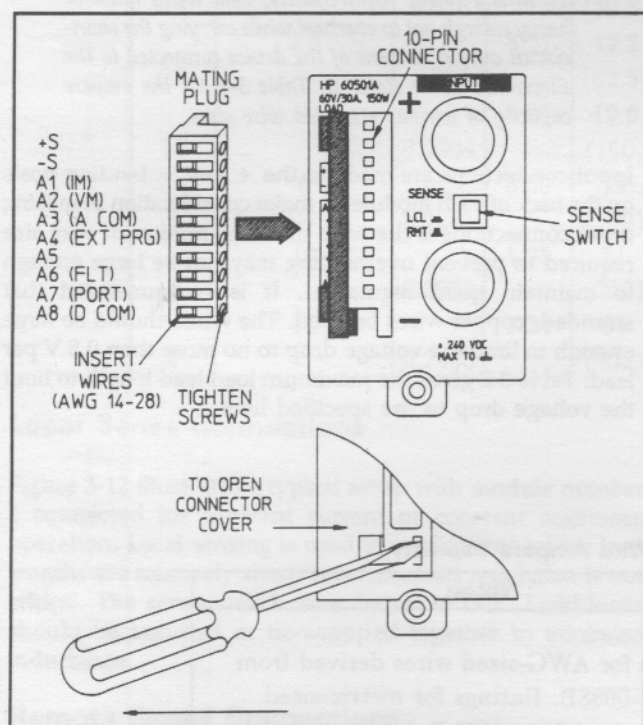


Figure 3-10 Control Connector and Cover

+ S and - S Used to connect the remote sense leads to the power source. Pin + S connects the + S signal and pin - S connects the - S signal. Remote sensing can only be used in CV and CR modes.

IM and VM (pins A1 and A2) Used to monitor the module's input current and voltage. A 0 V-to-10 V signal at the appropriate pin indicates the zero-to-full scale current or voltage. Pin A1 monitors current (IM); pin A2 monitors voltage (VM).

A Com (pin A3) Provides the common connection for the IM, VM, and external programming (Ext Prg) signals.

Ext Prg (pin A4) Connects an external programming input. The CC and CV mode can be programmed

with a 0 V-to-10 V signal (ac or dc). This signal can act alone or can be combined with values programmed over the HP-IB. Thus, it is possible to superimpose an ac signal upon a dc level.

Pin A5 Not used

Flt (pin A6) A TTL-compatible output signal that becomes active (high level) when an overvoltage or a reverse voltage condition or fault occurs. This signal powers up in the inactive (low-level) state.

Port (pin A7) A TTL-compatible output signal that becomes active (high level) when the PORT0 command is programmed ON. This signal can be used to control an external device such as a relay for shorting or disconnecting the module's input terminals or as a general purpose digital output port. This signal powers up in the inactive (low-level) state.

D Com (pin A8) Provides the common connection for the Flt and Port signals.

After you have finished making all wire connections, open the connector cover on the back of the module as shown in Figure 3-10 and insert the mating plug into the connector.

Sense Switch

A local/remote sense switch is provided on each module (see Figure 3-10). Unless you are using remote sensing, *make sure that the sense switch is set to LCL (depressed)*. Remote sensing is used in certain applications to achieve greater accuracy (refer to "Remote Sense Connections" for more information).

NOTE

If the sense switch is set to remote operation without having sense leads connected to the sense inputs, the module will continue to work in CC mode, but the input will turn off in CV and CR mode. Voltage readback will not work in any mode.

Trigger Connector

A four-pin connector and a quick-disconnect mating plug (HP part number 1252-1488) are provided on each mainframe for input and output trigger signals (see Figure 3-11). The mating plug is packaged in an envelope that is included with the mainframe.

Consistent with good engineering practice, all leads connected to the trigger connector should be twisted and shielded to maintain the instrument's specified performance.

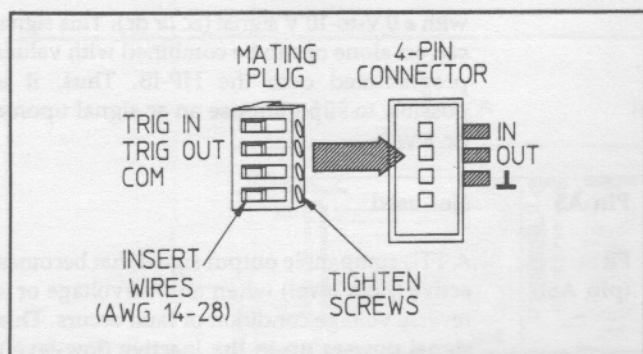


Figure 3-11. Trigger Connector

TRIG IN (pin 1) A TTL-compatible input that responds to low-level external trigger signals. A trigger applied to this input can be used to change settings (voltage, current, resistance, etc.), toggle between settings in transient-toggle mode, or generate a pulse in transient-pulse mode. An external trigger affects any module that has its external trigger input enabled by the **TRIG:SOUR:EXT** command.

TRIG OUT (pin 2) A TTL-compatible output signal that becomes active (low level) whenever the Electronic Load is triggered with an HP-IB command or **TRIG IN** signal. This signal can be used to trigger external equipment such as oscilloscopes, digitizers, or another Electronic Load.

Com (pin 3) Provides the common connection for the trigger signals. This common is directly connected to the chassis.

Pin 4 Not used

APPLICATION CONNECTIONS

Wiring Considerations

WARNING

FIRE HAZARD

To satisfy safety requirements, load wires must be heavy enough not to overheat while carrying the short-circuit output current of the device connected to the Electronic Load. Refer to Table 3-1 for the ampere capacity of various stranded wire sizes.

Input connections are made to the + and - binding posts on the back of each module. A major consideration in making input connections is the wire size. The minimum wire size required to prevent overheating may not be large enough to maintain good regulation. It is recommended that stranded, copper wires be used. The wires should be large enough to limit the voltage drop to no more than 0.5 V per lead. Table 3-2 gives the maximum load lead length to limit the voltage drop to the specified limit.

Table 3-1. Stranded Copper Wire Ampere Capacity

Wire Size		Ampacity	Notes:
AWG	Cross Section Area in mm ²		
22	0.75	5.0	1. Ratings for AWG-sized wires derived from MIL-W-5088B. Ratings for metric-sized wires derived from IEC Publication 335-1.
20		8.33	
18		10	
16	1	15.4	2. Ampacity of aluminum wire is approximately 84% of that listed for copper wire.
14	1.5	13.5	
12	2.5	19.4	
10	4	16	3. When two or more wires are bundled together, ampacity for each wire must be reduced to the following percentages: 2 conductors 94% 3 conductors 89% 4 conductors 83% 5 conductors 76%
8	6	31.2	
6	10	25	
4		40	4. Maximum temperatures: Ambient = 50° C Conductor = 105° C
		32	
		55	
		40	
		75	
		63	
		100	
		135	

Table 3-2. Maximum Wire Lengths to Limit Voltage Drops

Wire Size		Resistivity		Maximum Length in Meters (Feet) to Limit Voltage Drop to 0.5 V or Less						
AWG	Cross Section Area in mm ²	Ω/kft	Ω/km	5 A	10 A	20 A	30 A	40 A	50 A	60 A
22	0.5	16.15	40.1	(6)	(3)	(1.5)	(1)	(0.77)	(0.62)	(0.52)
20		10.16		2.5	1.2	0.6	0.4	0.31	0.25	0.21
18	0.75	6.388	26.7	(9.5)	(4.5)	(2)	(1.5)	(1.23)	(0.98)	(0.82)
16				3.7	1.9	0.9	0.6	0.47	0.37	0.31
14	1	4.018	20.0	(15.5)	(7.5)	(3.5)	(2.5)	(2.0)	(1.57)	(1.30)
12				5.0	2.5	1.3	0.8	0.63	0.50	0.42
10	1.5	2.526	13.7	(24.5)	(12)	(6)	(4)	(3.1)	(2.49)	(2.07)
8				7.3	3.6	1.8	1.2	0.91	0.73	0.61
6	2.5	1.589	8.21	(39.5)	(19.5)	(9.5)	(6.5)	(4.9)	(3.46)	(3.30)
4				12.2	6.1	3.0	2.0	1.52	1.22	1.01
2	4	0.9994	5.09	(62.5)	(31)	(15.5)	(10.5)	(7.9)	(6.29)	(5.24)
1				19.6	9.8	4.9	3.3	2.46	1.96	1.64
1	6	0.6285	3.39	(100)	(50)	(25)	(17)	(12.5)	(10.00)	(8.34)
1				29	14.7	7.4	4.9	3.69	2.95	2.96
1	10	0.3953	1.95	(159)	(79)	(39.5)	(27)	(19.9)	(15.91)	(13.25)
1				51	25	12.8	8.5	6.41	5.13	4.27
1	16	0.2486	1.24	(252)	(126)	(63)	(40)	(31.6)	(25.30)	(21.07)
1				80	40	20	13.4	10.08	8.06	6.72
1	4			(402)	(201)	(100)	(68)	(50.37)	(40.23)	(33.51)

Local Sense Connections

Figure 3-12 illustrates a typical setup with module number 1 connected for constant current or constant resistance operation. Local sensing is used in applications where lead lengths are relatively short, or where load regulation is not critical. The sense switch must be set to LCL. Load leads should be bundled or tie-wrapped together to minimize inductance.

Remote Sense Connections

Figure 3-13 illustrates a typical setup with module number 1 connected for remote sense operation. The remote sense terminals of module 1 are connected to the output of the power supply. Remote sensing compensates for the voltage drop in applications that require long lead lengths. It is only useful when module 1 is operating in CV or CR mode, or when using voltage readback. The sense switch must be set to RMT. Load leads should be bundled or tie wrapped together to minimize inductance.

Parallel Connections

Figure 3-14 illustrates how modules can be paralleled for increased power dissipation. Up to six modules can be directly paralleled in CC or CR mode. Modules *cannot* be paralleled in CV mode. Each module will dissipate the power it has been programmed for. For example, if two modules

are connected in parallel, with module number 1 programmed for 10 A and module number 2 programmed for 20 A, the total current drawn from the source is 30 A.

In Figure 3-14, all lead connections are terminated at the source. Each module is connected to the source using separate wires. Using the source as the current distribution point allows larger wires to be used for each module connection and also reduces the common impedance inherent in daisy-chained configurations.

If because of lead length or other considerations, lead connections cannot be made at the source, a remote distribution terminal may be required. Lead connections can also be daisy-chained across the module binding posts as long as the total current draw is less than the ampere-rating of AWG 8 wire (see Table 3-1). This is because two wires larger than AWG 8 cannot both fit inside an Electronic Load, binding post.

Zero-Volt Loading Connections

As shown in Figure 3-15, the Electronic Load can be connected in series with a voltage source or auxiliary power supply greater than 3 V so that the Electronic Load can test devices at its full current capacity down to a zero-volt level. Remote sensing is recommended for improved load regulation and when turning the short on.

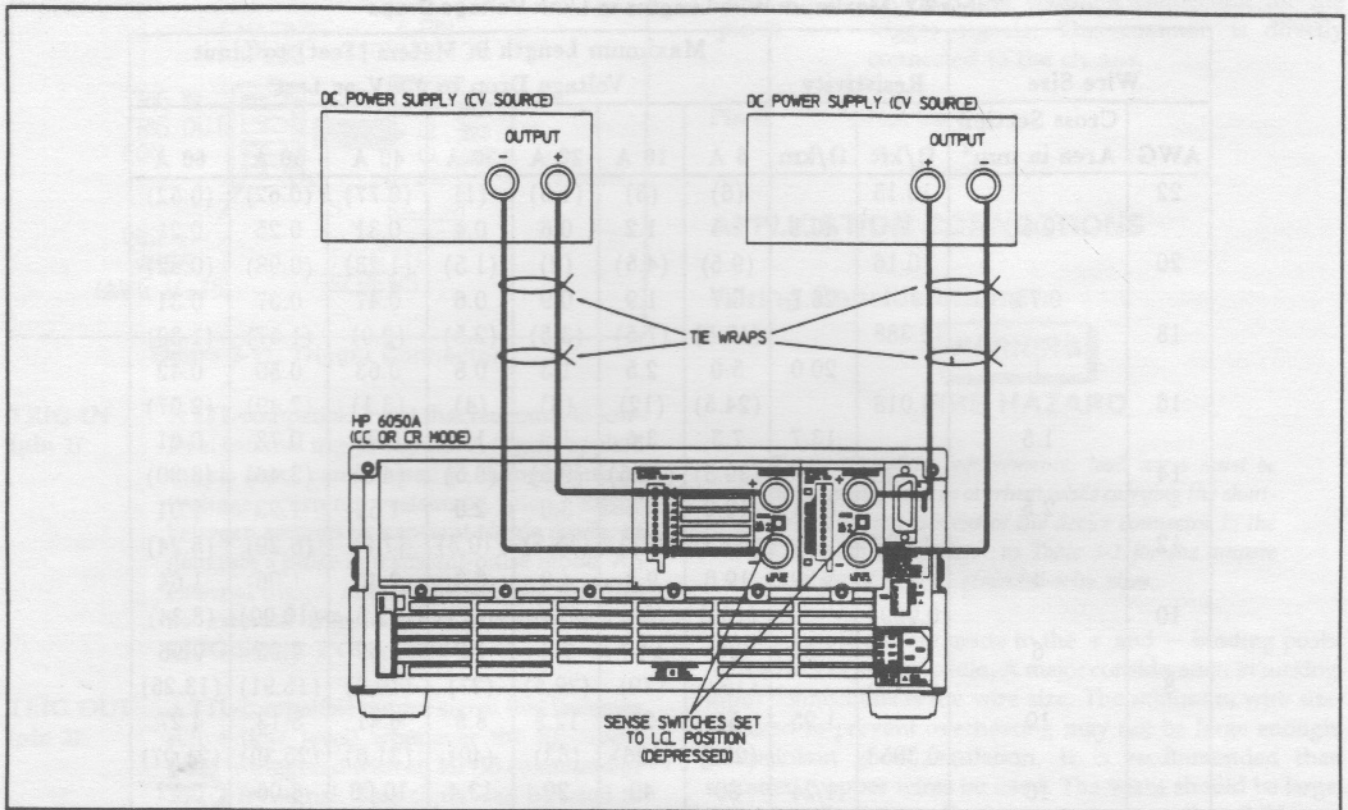


Figure 3-12. Local Sensing

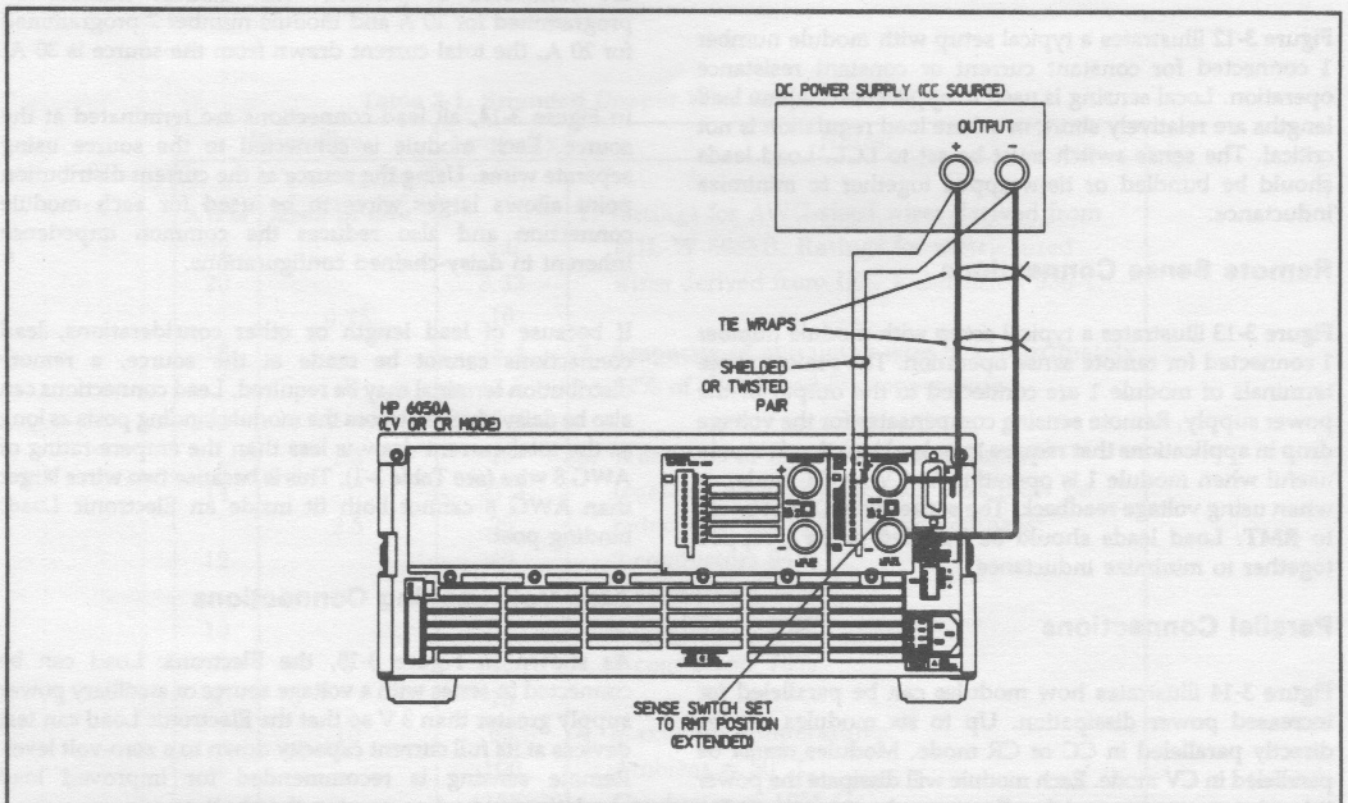


Figure 3-13. Remote Sensing

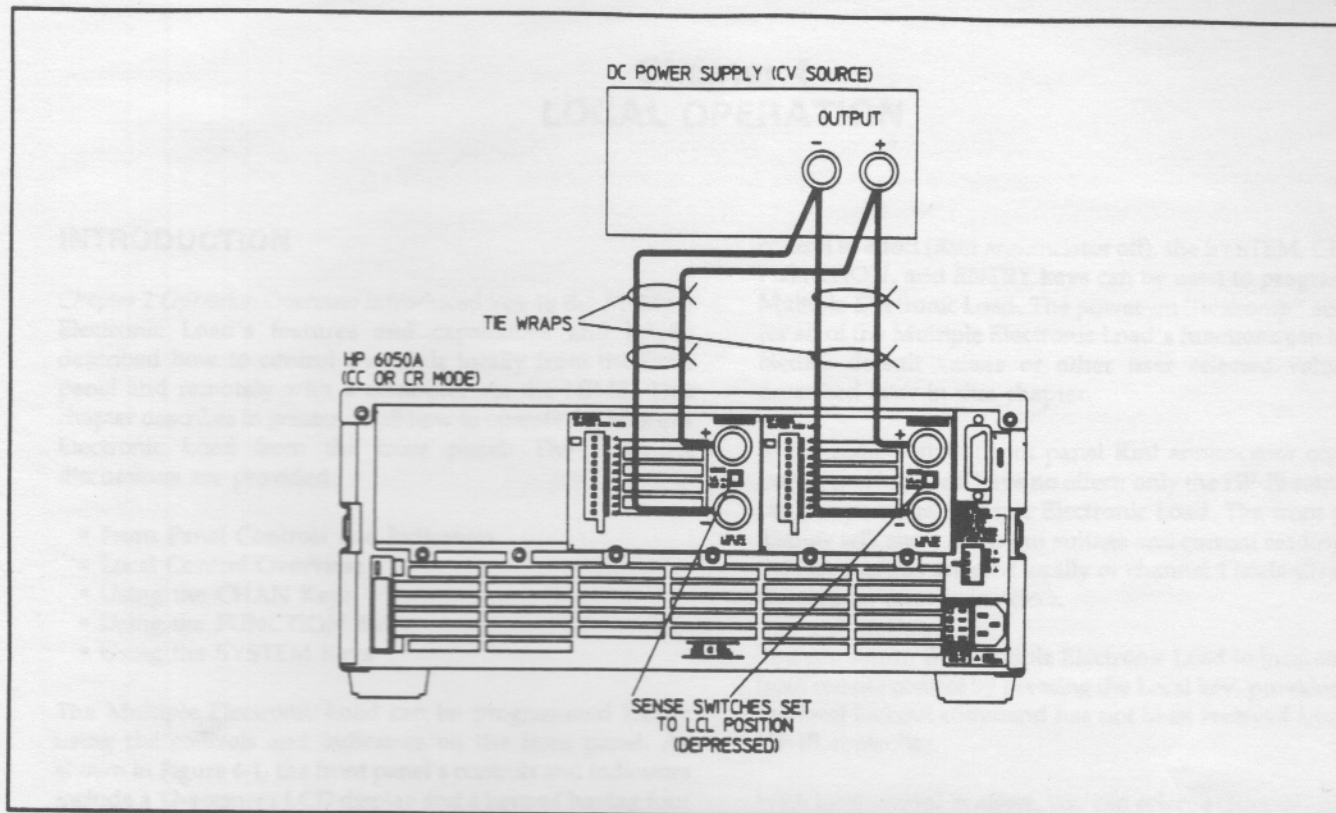


Figure 3-14. Parallel Operation

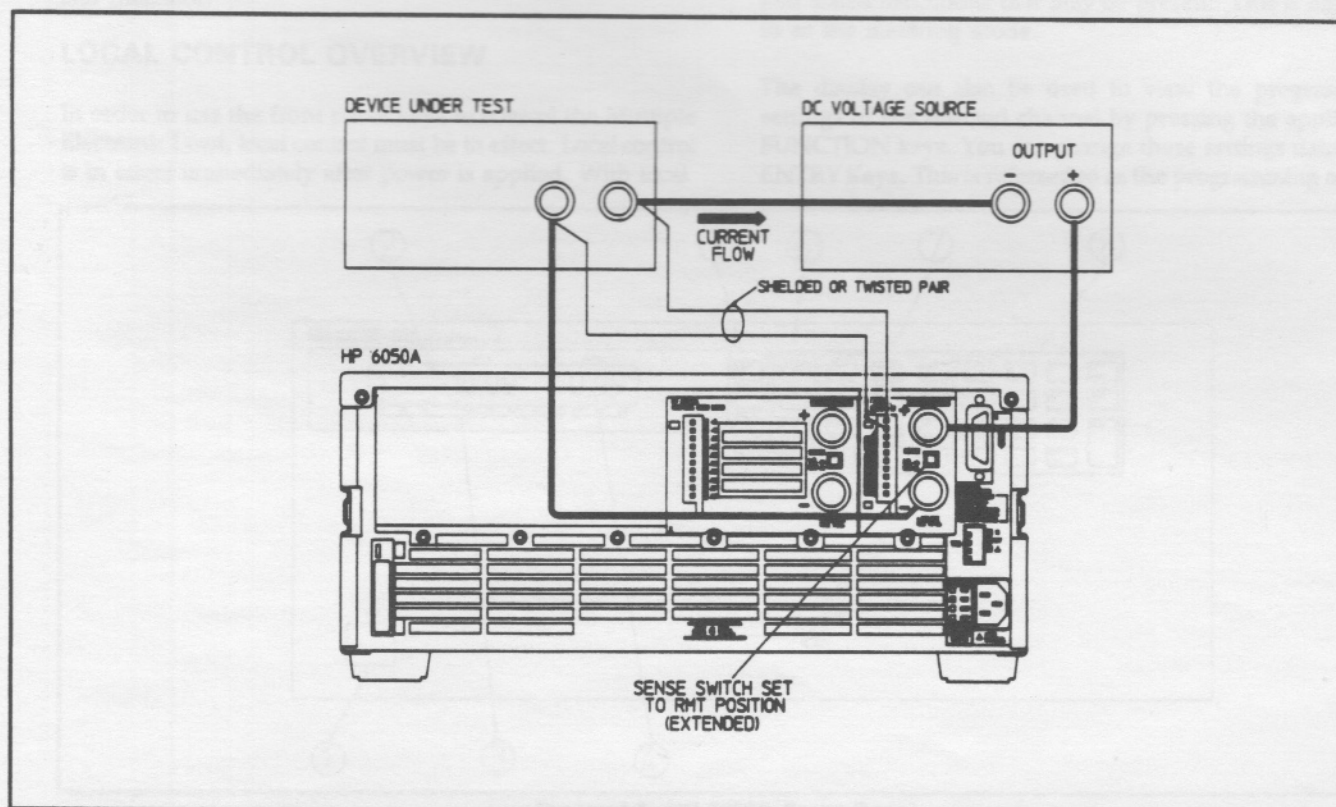


Figure 3-15. Zero-Volt Loading

Chapter 4 LOCAL OPERATION

INTRODUCTION

Chapter 2 *Operation Overview* introduced you to the Multiple Electronic Load's features and capabilities and briefly described how to control a module locally from the front panel and remotely with a computer via the HP-IB. This chapter describes in greater detail how to operate the Multiple Electronic Load from the front panel. The following discussions are provided:

- Front Panel Controls and Indicators
- Local Control Overview
- Using the CHAN Keys
- Using the FUNCTION Keys
- Using the SYSTEM Keys

The Multiple Electronic Load can be programmed locally using the controls and indicators on the front panel. As shown in Figure 4-1, the front panel's controls and indicators include a 12-segment LCD display and a keypad having four groups of keys (SYSTEM, CHAN, FUNCTION, and ENTRY). Table 4-1 gives a brief description of each control and indicator.

LOCAL CONTROL OVERVIEW

In order to use the front panel keys to control the Multiple Electronic Load, local control must be in effect. Local control is in effect immediately after power is applied. With local

control in effect (**Rmt** annunciator off), the SYSTEM, CHAN, FUNCTION, and ENTRY keys can be used to program the Multiple Electronic Load. The power-on "wake-up" settings for all of the Multiple Electronic Load's functions can be the factory default values or other user selected values as described later in this chapter.

In the remote state (front panel **Rmt** annunciator on), the front panel keys will have no effect; only the HP-IB controller can program the Multiple Electronic Load. The front panel display will show the input voltage and current readings for the last channel selected locally or channel 1 (default) while the remote state is in effect.

You can return the Multiple Electronic Load to local control from remote control by pressing the Local key, provided that the local lockout command has not been received from the HP-IB controller.

With local control in effect, you can select a channel and use the front panel display to view the input voltage/current values and the computed power value as well as certain fault and status conditions that may be present. This is referred to as the metering mode.

The display can also be used to view the programmed settings of the selected channel by pressing the applicable FUNCTION keys. You can change these settings using the ENTRY Keys. This is referred to as the programming mode.

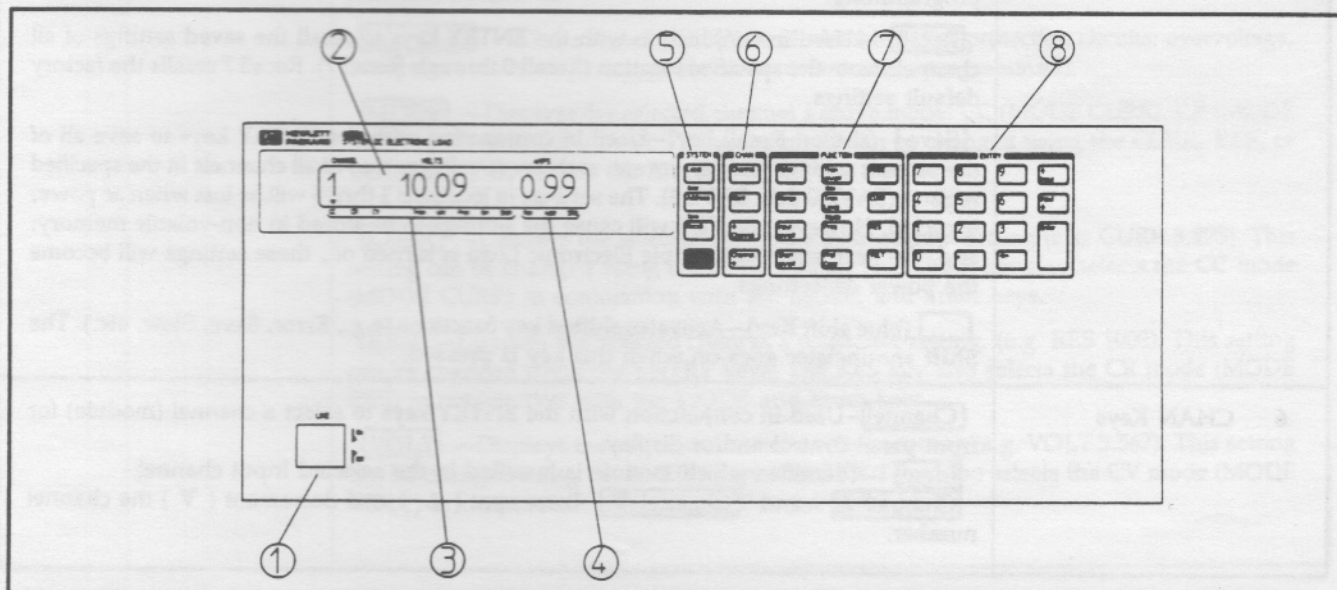


Figure 4-1. HP 6050A Front Panel

Table 4-1. Controls and Indicators (continued)

Item	Description
1 Line Switch	Turns the ac power on and off.
2 LCD Display	Normally displays the selected input channel number and the actual voltage and current at that input, for example, "1 10.09 0.99" as shown in Figure 4-1. When programmed from the front panel, the channel number and the function being programmed are displayed. For example, "1 CURR 1.000" indicates that the channel 1 CURR function is set to 1.00 amperes.
3 Electronic Load Status Annunciators	<p>CC—Indicates the selected channel is in the constant current (CC) mode. Note that Figure 4-1 illustrates that channel 1 is in the CC mode (CC annunciator is on).</p> <p>CR—Indicates the selected input channel is in the constant resistance (CR) mode.</p> <p>CV—Indicates the selected input channel is in the constant voltage (CV) mode.</p> <p>Tran—Indicates that transient operation is enabled for the selected input channel.</p> <p>Unr—Indicates that the selected input channel is unregulated (applies only in the CC mode and in the middle and high ranges of the CR mode).</p> <p>Prot—Indicates when channel protection features (OC, OV, OP, OT, etc.) are active on any channel.</p> <p>Err—Indicates that remote programming error(s) have occurred.</p> <p>Shift—Indicates that the shift key, bottom key (blue) in SYSTEM group, was pressed.</p>
4 HP-IB Status Annunciators	<p>Rmt—Indicates that the Multiple Electronic Load is in the HP-IB remote state. In the remote state, the only front panel key that will function is the Local key.</p> <p>Addr—Indicates that the Multiple Electronic Load is addressed to talk or to listen over the HP-IB.</p> <p>SRQ—Indicates that the Multiple Electronic Load is requesting service over the HP-IB; i.e., the service request line (SRQ) is active.</p>
5 SYSTEM Keys	<p>Local —Returns the Multiple Electronic Load from remote (computer) control to local (front panel) control.</p> <p>Address —Displays the Multiple Electronic Load's HP-IB address. You can change the address using the numeric entry keys. You cannot query or change the address remotely (over the HP-IB).</p> <p>Error (shifted address key)—Displays error codes that resulted from remote programming.</p> <p>Recall —Used in conjunction with the ENTRY keys to recall the saved settings of all channels from the specified location (Recall 0 through Recall 7). Recall 7 recalls the factory default settings.</p> <p>Save (shifted Recall key)—Used in conjunction with the ENTRY keys to save all of the present settings (mode, current, resistance, voltage, etc.) of all channels in the specified register (SAVE 0 thru SAVE 6). The settings in locations 1 thru 6 will be lost when ac power is cycled. However, SAVE 0 will cause the settings to be stored in non-volatile memory; and, the next time the Multiple Electronic Load is turned on, these settings will become the power on settings.</p> <p>Shift (blue shift Key)—Activates shifted key functions (e.g., Error, Save, Slew, etc.). The Shift annunciator goes on when this key is pressed.</p>
6 CHAN Keys	<p>Channel —Used in conjunction with the ENTRY keys to select a channel (module) for front panel control and/or display.</p> <p>Ident —Identifies which module is installed in the selected input channel.</p> <p>Channel ▲ and Channel ▼ Increment (▲) and decrement (▼) the channel number.</p>

Table 4-1. Controls and Indicators (continued)

Item	Description
7 FUNCTION Keys	<p>Meter —Returns the display to the metering function. With the metering function selected, the display will show the measured input voltage and current, the computed input power, or certain status conditions (e.g. INPUT SHORT ON, OC, etc.) for the selected channel. Press the Meter key to continually step through the displays.</p> <p>Range —Displays the selected channel's range setting for current (C:RNG) or resistance (R:RNG), depending upon which function is selected. The settings can be changed using the ENTRY keys.</p> <p>Input On/Off —Toggles the selected channel's input on and off. Input Off disables the input. Input On enables the input and returns the module to the original settings.</p> <p>Short On/Off —Toggles the selected channel's short circuit mode on and off. Short On applies a short circuit across the input. Short Off removes the short circuit and returns the channel to the original settings. Short On is overridden by Input Off.</p> <p>Tran On/Off —Toggles transient operation on and off for the selected channel. The Tran annunciator is on while transient operation is on. Transient operation causes the module's input to periodically switch between two levels.</p> <p>Tran Level —Displays the selected channel's transient level for current (C:TLV), resistance (R:TLV), or voltage (V:TLV) depending upon which function is selected. This level can be changed using the ENTRY keys. The input alternates between the transient level (TLV) and the main level of the active mode (CURR, RES, or VOLT) when transient operation is turned on.</p> <p>Slew (shifted Tran Level key)—Displays the selected channel's slew setting for current (C:SLW) or voltage (V:SLW) depending upon which function is selected. The settings can be changed using the ENTRY keys. The slew settings determine the rates at which new programmed values will change. Note that resistance changes use the voltage or current slew rate settings depending upon the resistance range.</p> <p>Freq —Displays the frequency setting of the transient generator (e.g. FREQ 1000) for the selected channel. The setting can be changed using the ENTRY keys. The Freq setting determines the frequency in continuous transient operation.</p> <p>Dcycle (shifted Freq key)—Displays the duty cycle of the transient generator(e.g. DCYCLE 50.0) for the selected channel. The setting can be changed using the ENTRY keys. The Dcycle setting determines the TLEV portion (percentage) of the duty cycle in continuous transient operation.</p> <p>Prot Clear —Clears the selected channel's latching-type protection circuits: overvoltage, overpower, overtemperature, and overcurrent (user programmed).</p> <p>MODE —Displays the selected channel's active mode: CC (MODE CURR), CR (MODE RES), or CV (MODE VOLT). The active mode can be changed using the CURR, RES, or VOLT key followed by the Enter key.</p> <p>CURR —Displays the selected channel's main current setting (e.g. CURR 3.275). This setting can be changed using the ENTRY keys. The CURR key also selects the CC mode (MODE CURR) in conjunction with the MODE and Enter keys.</p> <p>RES —Displays the selected channel's resistance setting. (e.g. RES 1000). This setting can be changed using the ENTRY keys. The RES key also selects the CR mode (MODE RES) in conjunction with the MODE and Enter keys.</p> <p>VOLT —Displays the selected channel's voltage setting (e.g. VOLT 5.567). This setting can be changed using the ENTRY keys. The VOLT key also selects the CV mode (MODE VOLT) in conjunction with the MODE and Enter keys.</p>

Table 4-1. Controls and Indicators (continued)

Item	Description
8 ENTRY Keys	<p>[0] to [9] and [.] — Set the channel number and the value of the specified function (e.g. CURR 2.525, RES 1000, VOLT 7.000, etc.).</p> <p>[←] (backspace)—Erases the previous keystroke in order to make corrections before entering a new setting.</p> <p>[Enter] —Enters the parameters (value, mode, channel) on the display for the specified function (or selects the mode of operation), and returns the front panel to the metering mode.</p> <p>[Input ▲] and [Input ▼] —These keys simulate front panel control knobs. They can be used to change the main level or the transient level of the function shown on the display. The new values are entered automatically (Enter key is not used) and they take effect as soon as they are displayed. You can also use these keys to change the actual input level when the display is monitoring the input voltage/current or the computed power. Note that these keys have no effect on range, slew, frequency, etc.</p>

You can return the display to the metering mode from the programming mode by pressing **[Meter]**. Continually pressing the Meter key will cause the display to step through the following for the selected channel:

- "INPUT OFF" (if active)
- "SHORT ON" (if active)
- Volts/Amps input metering, for example, "9.99 0.99"
- Computed power value, for example "9.9 WATTS"
- Protection Features (if any are active):
 - "VF"—voltage fault
 - "OV"—overvoltage
 - "RV"—reverse voltage
 - "PS"—protection shutdown
 - "OC"—overcurrent
 - "OP"—overpower
 - "OT"—overtemperature

If the display is metering the input voltage/current or the computed power, you can use the Input Entry keys to increase or decrease the actual input. These keys simulate front panel control knobs. Pressing **[Input ▲]** will cause the main level (current, resistance, or voltage) of the active mode to increase, while pressing **[Input ▼]** will cause the main level to decrease. You can continually press an Input key to speed up the changes. In the CC and CR modes, the total amount of change is determined by the selected range.

The protection features (OV, OC, OP, etc.) listed above are described briefly in *Chapter 2 Operation Overview* in this guide. When programming the Multiple Electronic Load remotely, you can use the Multiple Electronic Load's status reporting capability to check the state of the protection features. Refer to *Chapter 5 Status Reporting* in the *HP Electronic Load Family Programming Reference Guide*.

NOTE

If the input voltage exceeds the maximum measurement capability of the selected module, the front panel display will indicate an overload (OVL) condition. For example, if the channel 2 module has

a measurement overload condition, the front panel display will change from indicating the measured volts/amps values (or the computed power value) to indicating "2 OVLD".

USING THE CHAN KEYS

These keys are used to select one of the channels for local control and/or display and to identify which module is installed in the selected channel number. See *Channel Number* in *Chapter 3*.

In local control, the FUNCTION keys will control the module whose channel number is selected (appears on the display). When power is turned on, channel number 1 is automatically selected. If no modules are installed in the mainframe, the display will indicate "1 INPUT DWN". Also, at power on, the message "UNKNOWN" can appear on the display along with the affected channel number if the firmware will not support the specified module, or if the specified module is defective. If either of these messages appear, the Err annunciator will also be on. Pressing the Error key (shifted Address key) will produce "ERROR - 240" on the display which identifies a hardware error (See Table 4-2 in the *Electronic Load Family Programming Reference Manual*). If module(s) are installed in the mainframe and the Err annunciator remains on after power is applied, the Multiple Electronic Load has failed selftest (see *Chapter 3 - Turn-On/Selftest*).

Selecting the Channel

You can select a channel in either of two ways:

1. You can use the Channel key in conjunction with the ENTRY keys to select a channel. For example, to select channel 1 press:

[Channel] **[1]** **[Enter]**

2. You can use the **[Channel▲]** and **[Channel▼]** keys to increment (▲) and decrement (▼) the channel number. The new channel number is selected immediately.

Identifying the Selected Channel

The Ident key is used to identify which module is installed in the selected channel. For example, with channel 1 selected, press **Ident** and observe the display. Assuming that the HP 60502A 300 Watt Module is installed in channel 1, the display will indicate:

"1 60V 60A"

Assume that the HP 60501A 150 Watt Module is installed in channel 2. Select channel 2 by pressing **Channel** **2** **Enter**. Now, press **Ident** and observe that the display indicates:

"2 60V 30A"

USING THE FUNCTION KEYS

Most of an Electronic Load Module's functions can be programmed using these keys. Figure 4-2 is a flow chart that shows a recommended programming sequence. Note that the sequence includes selecting a channel and turning the module's input off before you program any values. This is a good practice because it insures that there is no input current while you are setting up your test program.

Programming is then accomplished by selecting a mode of operation (CC, CR, or CV) and setting the desired values for range (if applicable), the main operating level, and the slew rate. If transient operation is desired, set the transient level, make the desired frequency and duty cycle settings, and turn transient operation on. The settings you make will take effect at the selected channel's input as soon as you turn the input on.

The programming ranges and the factory default values for a particular module are given in the applicable module-specific pages. If you program a value outside of the valid range, it will be ignored and the display will read "OUT OF RANGE". A few programming examples are given in subsequent paragraphs.

NOTE

In the programming examples that follow, it is assumed that channel 1 is selected and that a dc source is connected to the associated module's INPUT binding posts.

Turning the Input On/Off

The input can be toggled on and off by pressing **Input on/off**. When the input is turned off, the message "INPUT OFF" will be displayed. The input on/off change does not use any slew setting, so the input will change at the maximum rate. Turning the input off does not change the programmed settings.

Turning the input on again restores the input to the programmed values and returns the display to the metering mode.

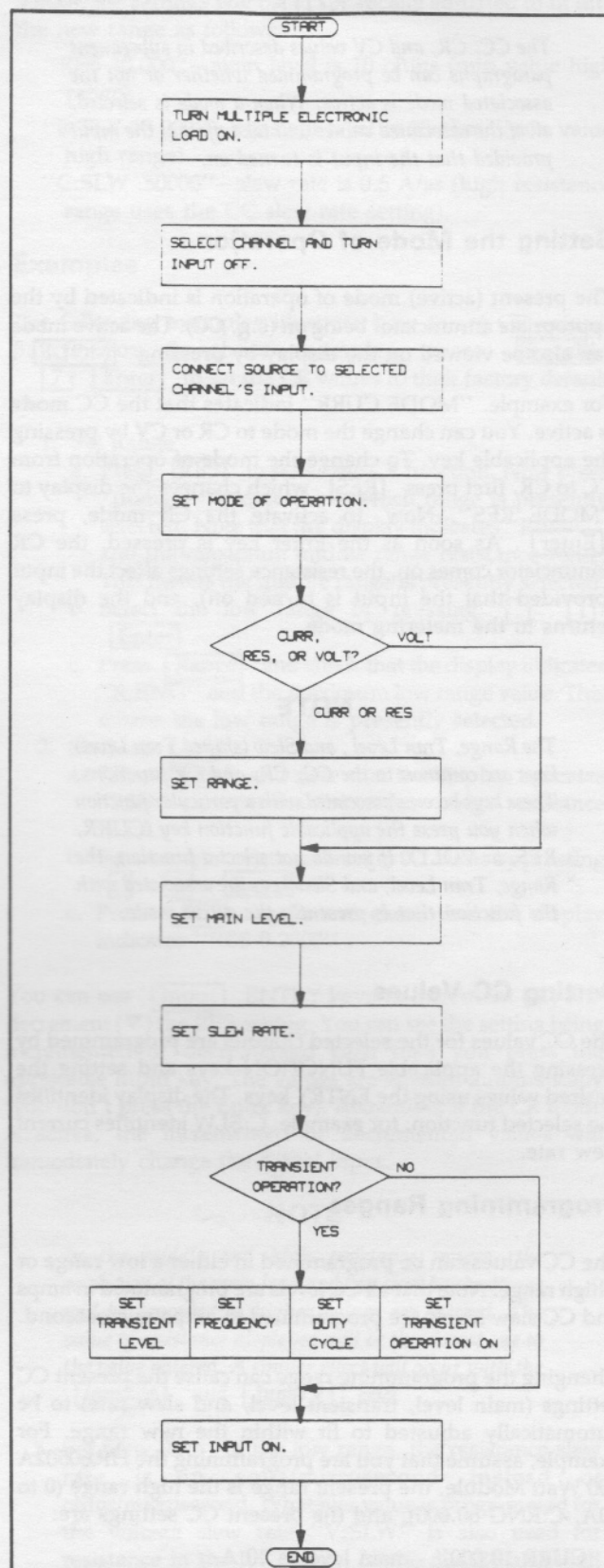


Figure 4-2. Recommended Programming Sequence

NOTE

The CC, CR, and CV values described in subsequent paragraphs can be programmed whether or not the associated mode is active. When a mode is selected, all of the associated values will take effect at the input provided that the input is turned on.

Setting the Mode of Operation

The present (active) mode of operation is indicated by the appropriate annunciator being on (e.g. CC). The active mode can also be viewed on the display by pressing **MODE**.

For example, "MODE CURR" indicates that the CC mode is active. You can change the mode to CR or CV by pressing the applicable key. To change the mode of operation from CC to CR, first press **RES** which changes the display to "MODE RES". Now, to activate the CR mode, press **Enter**. As soon as the Enter key is pressed, the CR annunciator comes on, the resistance settings affect the input (provided that the input is turned on), and the display returns to the metering mode.

NOTE

The Range, Tran Level, and Slew (shifted Tran Level) keys are common to the CC, CR, and CV functions. These keys become associated with a particular function when you press the applicable function key (CURR, RES, or VOLT). If you do not select a function, the Range, Tran Level, and Slew keys are associated with the function that is presently the active mode.

Setting CC Values

The CC values for the selected channel are programmed by pressing the applicable FUNCTION keys and setting the desired values using the ENTRY keys. The display identifies the selected function; for example, C:SLW identifies current slew rate.

Programming Ranges

The CC values can be programmed in either a low range or a high range. Note that all CC levels are programmed in amps and CC slew levels are programmed in amps/microsecond.

Changing the programming range can cause the present CC settings (main level, transient level, and slew rate) to be automatically adjusted to fit within the new range. For example, assume that you are programming the HP 60502A 300 Watt Module, the present range is the high range (0 to 60A, C:RNG 60.000), and the present CC settings are:

"CURR 10.000" - main level is 10 A
"C:TLV 12.000" - transient level is 12 A
"C:SLW 5.0000" - slew rate is 5 A/ μ s

If you now select the low range (0 to 6 A, C:RNG:6.0000), the settings will automatically change to the following:

"CURR 6.0000" - main level is 6 A (max low range value)
"C:TLV 6.0000" - transient level is 6 A (max low range value)
"C:SLW .50000" - slew rate is 0.5 A/ μ s (max low range value)

Examples

The following examples illustrate how to set CC values. Before you do these examples, press **Recall** **7** **Enter** to set the CC values to their factory default states.

1. Select Range

- Press **CURR** to select the CC function. Now press **Range** to determine the range setting. Note that the display indicates "C:RNG" and the maximum high range CC value. This means that the high range is selected.
- Select the low range by pressing **1** **Enter**.
- Press **Range** and check that the display indicates "C:RNG" and the maximum low range value. This means that the low range is selected.

2. Set Main Level

- Press **CURR** and note that the display indicates "CURR" and the minimum low range CC value.
- Set the main current level to 1 amp by pressing **1** **Enter**.
- Press **CURR** again and check that the display indicates "CURR 1.0000".

Note that you can use the **Input** ENTRY keys to increment (\blacktriangle) or decrement (\blacktriangledown) the main level CURR setting. You can see the CURR setting being incremented or decremented one step at a time each time you press the applicable Input key. The values are entered automatically (you don't press the Enter key). Remember that if the CC mode is active, the incremented or decremented value will immediately change the actual input.

3. Set Slew Rate—There are 12 discrete slew rate steps in each range (low and high). Any slew rate can be programmed (there are no upper and lower limits that would cause an error). The Multiple Electronic Load automatically selects one of 12 slew rates that is closest to the programmed value.

- First press the **Shift** (blue shift key) and note that the **Shift** annunciator comes on. Now press **Slew** (shifted Tran Level key) to determine the slew setting. Note that the display indicates "C:SLW" and the maximum slew rate setting for the low current range.
- Set the slew rate to 0.05 A/ μ s by pressing **0** **5** **Enter**.
- Press **Shift** and **Slew** again and check that the display indicates "C:SLW 0.05000" (or the closest slew rate step to this value depending upon the module being programmed).

4. Set Transient Level—The transient current level is meaningful only if transient operation (described later) is turned on. Note Remember that you set the main current level to 1 amp in step 2. In CC mode, the transient level must be set to a higher level than the main level.
 - a. Press **Tran Level** and note that the display indicates "C:TLV" and the minimum low range CC value.
 - b. Set the transient CC level to 2 amps by pressing **2** **Enter**.
 - c. Press **Tran Level** again and note that the display indicates "C:TLV 2.0000". Note that you can use the Input ENTRY keys to increment and decrement the transient current level. Operation is similar to that described above for the main current level.

Setting CR Values

The CR values for the selected channel are programmed by pressing the applicable FUNCTION keys and then setting the desired value using the ENTRY keys. The display identifies the selected function; for example, R:RNG identifies resistance range. See Appendix A for considerations regarding high-resistance applications.

Programming Ranges

The resistance values can be programmed in a low, middle, or high range. Note that all resistance levels are programmed in ohms and the slew rate is in amps/microsecond or volts/microsecond depending upon which resistance range is selected.

NOTE

On the HP 60501 module, the front panel will display 20000 for the high resistance range even though 10K is the maximum value that can be programmed.

Changing the programming range can cause the present CR settings to be automatically adjusted to fit within the new range. For example, assume that you are programming the HP 60502A 300 Watt module, the present range is the middle range (1 to 1 k ohms, R:RNG 1000.0), and the present settings are:

"RES 50.000"—main level is 50 ohms
 "R:TLV 40.000"—transient level is 40 ohms
 "C:SLW .50000"—slew rate is 0.5 A/ μ s (middle resistance range uses the CC slew rate setting).

If you now select the low range (0 to 1 ohm, R:RNG 1.0000), the settings will automatically be changed to fit into the new range as follows:

"RES 1.0000"—main level is 1 ohm (max value low range)
 "R:TLV 1.0000"—transient level is 1 ohm (max value low range)
 "V:SLW 5.0000"—slew rate is 5 V/ μ s (low resistance range uses the CV slew rate setting).

If you now select the high range (10 to 10 k ohms, R:RNG 10000), the settings will be automatically adjusted to fit into the new range as follows:

"RES 10.000"—main level is 10 ohms (min value high range)

"R:TLV 10.000"—transient level is 10 ohms (min value high range)

"C:SLW .50000"—slew rate is 0.5 A/ μ s (high resistance range uses the CC slew rate setting).

Examples

The following examples illustrate how to set CR values. Before you do these examples, press **Recall** **7** **Enter** to set the CR values to their factory default states.

1. Set Range

- a. Press **RES** to select the CR function. Now press **Range** to determine which range is presently selected. Note that the display indicates "R:RNG" and the maximum middle range resistance value. This means the middle range is presently selected.
- b. Select the low range by pressing **.** **1** **Enter**.
- c. Press **Range** and check that the display indicates "R:RNG" and the maximum low range value. This means the low range is presently selected.

2. Set Main Level

- a. Press **RES** and note that the display indicates "RES" and the maximum low range resistance value.
- b. Set the main resistance level to 0.2 ohms by pressing **.** **2** **Enter**.
- c. Press **RES** again and check that the display indicates "RES 0.2000".

You can use **Input** ENTRY keys to increment (\blacktriangle) and decrement (\blacktriangledown) the RES setting. You can see the setting being incremented or decremented each time you press the applicable Input key. The values are entered automatically (you don't press the Enter key). Remember if the CR mode is active, the incremented or decremented values will immediately change the actual input.

NOTE

*In the middle and high resistance ranges, the resolution of the main level and transient level settings will be degraded as higher values are entered. The value of resistance displayed will be the closest one to the value entered. A similar effect will occur with the **Input** \blacktriangle and **Input** \blacktriangledown keys.*

3. Set Slew Rate—In the low range, the resistance slew rate is in volts/microsecond instead of ohms/microsecond. Whatever value is programmed for the voltage slew rate "V:SLW" is also used for resistance in the low range. In the middle and high ranges, the resistance slew rate is programmed in

amps/microsecond. Whatever value is programmed for the current slew rate "C:SLW" is also used for resistance in the middle and high ranges.

- a. First press the ☐ (blue shift key) and note that the Shift annunciator comes on. Now press (shifted Tran Level key) to determine the present slew setting. Note that the display indicates "V:SLW" and the maximum voltage slew rate. The Multiple Electronic Load automatically selects the voltage slew rate when the low resistance range is selected.
 - b. Set the slew rate to 0.25 V/ μ s by pressing .
 - c. Press ☐ and again and check that the display indicates "V:SLW 0.2500" (or the closest slew rate step to this value for the particular module being programmed).
4. Set Transient Level—The transient resistance level is meaningful only if transient operation (described later) is turned on. In the low range, the transient resistance level must be set to a higher level than the main resistance value. In the middle and high ranges, the transient resistance level must be set to a lower value than main resistance value. If levels are not set properly, transient operation will not take place.
- a. Press and note that the display indicates "R:TLV" and the maximum low range resistance value.
 - b. Set the transient resistance level to 0.4 ohm by pressing .
 - c. Press again and note that the display indicates "R:TLV 0.4000".

Note that you can use the Input ENTRY keys to increment and decrement the transient resistance level. Operation is similar to that described above for the main resistance level.

Setting CV Values

The CV values for the selected channel are programmed by pressing the applicable FUNCTION keys and setting the desired values using the ENTRY keys. The display identifies the selected function; for example "V:TLV" identifies the transient voltage level.

Programming Range

The voltage values can only be programmed in one range. All voltage levels are programmed in volts and the voltage slew rate is programmed in volts/microsecond.

Examples

The following examples illustrate how to program CV values. Before you do these examples, press to set the CV values to their factory default values.

1. Set Main level
 - a. Press and note that the display indicates "VOLT" and the maximum voltage value.

- b. Set the main voltage level to 20 volts by pressing .
- c. Press again and check that the display indicates "VOLT 20.000".

Note that you can use the ENTRY keys to increment (\blacktriangle) or decrement (\blacktriangledown) the main VOLT level setting.

You can see the VOLT setting being incremented or decremented each time you press the applicable Input key. The values are entered automatically (you don't press the Enter key). Remember if the CV mode is active, the incremented or decremented values will immediately change the actual input.

2. Set Slew Rate—There are 12 discrete steps within the voltage slew range. The Multiple Electronic Load automatically selects one of the 12 slew rates that is closest to the programmed value.

NOTE

Because of bandwidth limitations only 9 slew rate steps can be achieved. Although CV slew rates #10 through #12 may be programmed, they are not implemented.

- a. First press ☐ (blue shift key) and note that the Shift annunciator goes on. Now press (shifted Tran Level key) to determine the present slew setting. Note that the display indicates "V:SLW" and the maximum slew rate.
 - b. Set the slew rate to 0.5 V/ μ s by pressing .
 - c. Press ☐ and again and note that the display indicates "V:SLW 0.5000".
3. Set Transient Level—The transient voltage level is meaningful only if transient operation (describe later) is turned on. The transient voltage level must be set to a higher value than the main voltage level in order for transient operation to take place.
- a. Press and note that the display indicates "V:TLV" and the maximum voltage value.
 - b. Set the transient voltage level to 30 volts by pressing .
 - c. Press again and note that the display indicates "V:TLV 30.000".

You can use the Input Entry keys to increment and decrement the transient voltage level. Operation is similar to that described above for the main voltage level.

Transient Operation

Transient operation can be used in the CC, CR, or CV mode. It causes the selected channel (module) to switch between two load levels. Continuous transient operation can be programmed from the front panel or remotely via the HP-IB. Pulsed and toggled transient operation can only be programmed remotely via the HP-IB.

In continuous transient operation, a repetitive pulse train switches between two load levels. Transient operation is turned on and off at the front panel using the Tran on/off key. Before you turn on transient operation, you should set the desired mode of operation as well as all of the values associated with transient operation.

The two load levels in transient operation are the main and transient levels previously described for CC, CR, and CV. The rate at which the level changes is determined by the associated slew rate setting.

In addition to the mode dependent parameters mentioned above, the frequency and the duty cycle of the continuous pulse train are programmable.

The following example illustrates how to program transient operation in the CC mode.

1. Setup CC Values
 - a. Set the main CC level to 1 amp, the transient CC level to 2 amps, and the slew rate to 0.15 A/ μ s. See examples under *Setting CC Values*.
 - b. Turn on CC mode by pressing:
MODE **CURR** **Enter**
2. Set frequency to 5 kHz by pressing:
FREQ **5** **0** **0** **0** **Enter**
3. Set duty cycle to 25% by pressing:
□ (blue shift key) **Dcycle** (shifted)
2 **5** **Enter**
4. Turn on transient operation by pressing:
Tran on/off
5. Note that the **Tran** annunciator is on.

Shorting The Input

The Multiple Electronic Load can simulate a short circuit across any input channel. The short circuit can be toggled on/off across the selected input by pressing **Short on/off**.

When the input is shorted the message "SHORT ON" will be displayed. The short on/off change uses the slew rate setting of the active mode and range. Turning the short off returns the input to the previously programmed values and returns the display to the metering mode. Note that "INPUT OFF" takes precedence over "SHORT ON".

CAUTION

Pressing the Short On/Off key with certain user applications may cause damage to the equipment being tested, which may result in personal injury. Contact your HP Sales and Service office if you need to have the Short On/Off key disabled.

Resetting Latched Protection

Each module in the Multiple Electronic Load includes overvoltage "OV", overpower "OP", and overtemperature

"OT" protection features as well as a software overcurrent limit protection feature (remotely programmable only) that latch when they are tripped. The protection shutdown "PS" and voltage fault "VF" conditions also latch when tripped. The **Prot** annunciator on the front panel goes on when any of the above features are tripped in any channel. To reset these protection features, press **Prot Clear**.

NOTE

*The condition that caused the protection feature to trip must be removed or it will trip again as soon as it is reset. Also, if OT occurs, the module must have sufficiently cooled down in order for the **Prot Clear** to take effect.*

USING THE SYSTEM KEYS

These keys consist of Local, Address, Error (shifted Address key), Recall, Save (shifted Recall key), and the blue shift key (bottom key in the SYSTEM column). The Local key and the Shift key have already been discussed. The remaining SYSTEM keys are described in the following paragraphs.

Setting The HP-IB Address

Before you can program the Multiple Electronic Load remotely via an HP-IB computer, you must know its HP-IB address. You can find this out by pressing **Address**. The Multiple Electronic Load's HP-IB address will be displayed; for example "ADDRESS 5". The Multiple Electronic Load is shipped from the factory with its address set to 5.

If you want to leave the address set at 5, you can return to the metering mode by pressing the Meter key.

If you want to change the address, you can enter a new value. Any integer from 0 to 30 can be selected. For example, to change the address to 12 press:

Address **1** **2** **Enter**

This new address will remain set and will not be lost when power is cycled. Note that the Address setting is not affected by the Save and Recall functions described below.

Displaying Error Codes

Remote programming errors are indicated when the Err annunciator is on. To display the error code (s), first return to local control by pressing **Local**.

To display an error code, press
□ (blue shift key) **Error** (shifted).

Errors are recorded in a list and are displayed in the order in which they occurred. Each time the shifted Error key is pressed, an error code is displayed. Once an error is displayed, it is removed from the error list. "ERROR 0" indicates there are no errors present and will be displayed when all errors in the list have been displayed. The error codes are negative numbers in the range from -100 to -499. Refer to the *HP Electronic Loads Programming Reference Guide* for a description of the error codes.

Saving and Recalling Settings

The Multiple Electronic Load's settings (mode, input state, current levels, resistance levels, etc.) for all channels can be saved and then recalled for use in various test setups. This simplifies the repetitive programming of different settings. The complete list of parameters that can be saved and recalled for a particular module are the same parameters as listed for the factory default values. Refer to the applicable module-specific pages.

The present settings of all parameters can be saved in a specified storage register (0 to 6) using the Save (shifted Recall) key. At a later time, you can recall the settings from the specified register using the Recall key. The Save and Recall keys affect all channels simultaneously.

For example, you can store the present settings in register 2 by pressing (blue shift key) (shifted) .

You can change the Multiple Electronic Load's settings as required and then return to the settings stored in register 2 by pressing .

Settings stored in registers 1 through 6 will be lost when the Electronic Load's power is cycled. When power is turned off and then on again, each of these registers (1 through 6) will be set to the "wake-up" values. The "wake-up" values are stored in register 0 and can be set to any values you desire (see *Changing Wake-up Settings* below).

Changing "Wake-up" Settings

The "wake-up" settings for all channels are stored in register 0. At power-on, the Multiple Electronic Load will "wake-up" with these values set. When a module is shipped from the factory, its "wake-up" values are the same as its factory default values.

You can change the "wake-up" values to whatever values you wish. You do this by setting them into each channel and then saving them in register 0 by pressing

(blue shift key) (shifted Recall key) .

When power is turned off and on, the Multiple Electronic Load's modules will be set to the values you saved in register 0.

CAUTION

The Save 0 operation takes a few seconds to complete. Do not turn power off until the "SAVE 0" message goes away indicating that the operation is complete. If you turn off power before completion, the non-volatile memory will be corrupted and the Multiple Electronic Load will need to be recalibrated.

Recalling the Factory Default Values

You can recall the factory default values for all modules by pressing: .

As soon as the Enter key is pressed, each channel in the Multiple Electronic Load will be set to its factory default values. Note that the Multiple Electronic Load is also set to the factory default values when the *RST common command is sent via the HP-IB (see the Programming Reference Guide).

If you also want the factory default settings to be the "wake-up" settings, you can recall them as described above and then press:

(blue shift key) (shifted) .

Now, when power is turned off and on, the channels will be set to the factory default settings.

Chapter 5 REMOTE OPERATION

INTRODUCTION

Chapter 4 - Local Operation described how to program the Multiple Electronic Load manually using the front panel keys. This chapter describes the fundamentals of programming the Multiple Electronic Load remotely from an HP-IB controller. The similarities between local and remote programming will become apparent as you read this chapter. The intent of this chapter is to help first time users quickly become familiar with operating their Electronic Load remotely from an HP-IB controller. Only the most commonly used HP-IB commands will be discussed. Programming examples given in this chapter use the HP-IB commands in their simplest form (abbreviated commands, no optional key words, etc.).

Refer to the *Electronic Load Family Programming Reference Guide* for a detailed description of all commands. The Programming Guide includes a complete Language Dictionary as well as a quick reference summary of all of the HP-IB commands that can be used to program the Electronic Load. It also covers the Electronic Load's HP-IB functions, status reporting capabilities, and error messages.

NOTE

The programming examples that follow are written in BASIC Programming Language for use with HP Series 300 computers. You may convert examples for use with any other language or computer.

ENTER/OUTPUT STATEMENTS

You need to know the statements your computer uses to output and enter information. For example, the HP BASIC language statement that addresses the Multiple Electronic Load to listen and sends information to the Multiple Electronic Load is:

OUTPUT

The HP BASIC language statement that addresses the Multiple Electronic Load to talk and reads information back from the Multiple Electronic Load is:

ENTER

The Multiple Electronic Load's front panel **Rmt** annunciator is on when it is being controlled remotely via an HP-IB controller and its **Addr** annunciator is also on when it is addressed to talk or to listen.

HP-IB ADDRESS

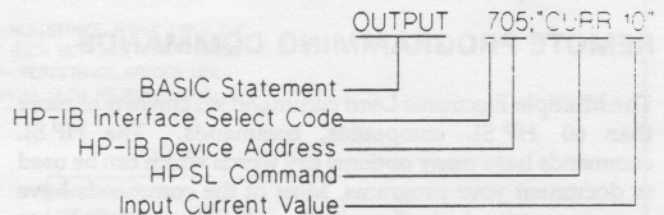
Before you can program your Multiple Electronic Load remotely via an HP-IB computer, you need to know its HP-IB address. Each instrument you connect to the HP-IB interface has a unique address assigned to it. The address allows the system controller to communicate with individual instruments.

The Multiple Electronic Load's HP-IB address is set locally at the front panel using the Address key as described in Chapter 4. The examples in this chapter assume that the Electronic Load's address is 05.

Series 300 computers have an HP-IB interface select code which is 7. Only one instrument connected to the interface can have address 05. Thus, the complete HP-IB address assumed in the upcoming programming examples is 705. You may modify the examples to have any HP-IB address.

SENDING A REMOTE COMMAND

To send the Multiple Electronic Load a remote command, combine your computer's output statement with the HP-IB interface select code, the HP-IB device (Multiple Electronic Load) address, and finally the Multiple Electronic Load's HP-IB SL command. For example, to set the input current of a previously specified channel to 10 amps, send:



SELECTING A CHANNEL

Most of the remote commands are channel specific, that is, they are directed to the channel which was most recently specified by the **CHAN** command. If no **CHAN** command was specified since the Multiple Electronic Load was turned-on, subsequent commands will be directed to channel 1, the default channel. The following example selects channel 2 and then sets the CV level of the module installed in channel 2 to 20 volts.

```
10 OUTPUT 705; "CHAN 2"  
20 OUTPUT 705; "VOLT 20"  
30 END
```

Line 10: Selects channel 2 to receive subsequent channel specific commands.

Line 20: Sets the CV level of the channel 2 module to 20 volts.

GETTING DATA BACK

The Multiple Electronic Load is capable of reading back the values of parameter settings as well as the actual input voltage and current or computed input power of any channel. It can also return information relating to the internal operation and module identification associated with any channel. In order to read back the desired information, you must send the appropriate query to the desired channel. For example, the query "MEAS:CURR?" asks the Multiple Electronic Load to measure the actual input current at the INPUT binding posts of the most recently specified channel. Refer to the *Electronic Load Family Programming Reference Guide* for complete details on using queries.

The Multiple Electronic Load stores the response to the query in an output buffer which will hold the information until it is read by the computer or is replaced with new information.

Use your computer's ENTER statement to read the measurement from the output buffer in the Multiple Electronic Load. The following example asks the Multiple Electronic Load to measure the actual input current to the previously specified channel and then reads the response back to the computer.

```
10 OUTPUT 705; "MEAS:CURR"  
20 ENTER 705; A  
30 DISP A  
40 END
```

Line 10: Measures the actual input current.

Line 20: Reads the actual input current level back into variable A in the computer.

Line 30: Displays the input current value on the computer's display

REMOTE PROGRAMMING COMMANDS

The Multiple Electronic Load command set consists of more than 60 HP SL compatible, commands. The HP SL commands have many optional key words which can be used to document your programs. Most of the commands have a query syntax which allows the present parameter settings to be read back to the controller. All of these details are given in the *Electronic Load Family Programming Reference Guide*.

The Multiple Electronic Load's major functions can be programmed using a relatively few number of these commands. Figure 5-1 illustrates how to program these functions using the applicable HP SL commands. The programming ranges and factory default values for a particular module are given in the applicable module-specific pages.

The remaining paragraphs in this chapter give a few simple programming examples to help you get started. In each example, it is assumed that a dc power source is connected to the selected channel's input binding posts. Also, the following points are important to remember when you are remotely programming CC, CR, and CV values.

1. Modes

The CC, CR, and CV values can be programmed whether or not the associated mode is active. If the input is turned on, all of the applicable values will take effect at the input when the associated mode is selected.

2. Ranges

Changing the CC or CR programming range can cause the present settings to be automatically adjusted to fit within the new range. See *Setting CC Values and Setting CR values* in Chapter 4. During a range change, the input will go through a non-conducting state to minimize overshoots.

3. Transient levels

The transient CC or CV level must be set to a higher level than the respective main level. In the low range, the transient CR level must be set to a higher level than the main CR level. In the middle and high ranges, the transient CR level must be set to a lower level than the main CR level.

4. Slew Rates

The CC slew rate is programmed in amps/second. There are 12-steps for each of the two current ranges (low and high). The Multiple Electronic Load automatically selects one of the 12 steps that is closest to the programmed value. The CV slew rate is programmed in volts/second. There are 12-steps within the voltage range. The Multiple Electronic Load automatically selects one of the 12 steps that is closest to the programmed value. In the low range, the CR slew rate is programmed in volts/second instead of ohms/second. Whatever value is programmed for the CV slew rate is also used for CR. In the middle and high ranges, the CR slew rate is programmed in amps/second. Whatever value is programmed for the CC slew rate is also used for CR.

5. Programmable Current Protection (CURR:PROT)

The programmable current limit is in effect for any mode of operation (not just the CC mode). When programmable current protection is enabled, and the programmed current limit and time delay are exceeded, the module's input will be turned off.

6. Measurement Overload (OVLD)

If the input voltage exceeds the maximum measurement capability of a module, an overload (OVLD) condition will be indicated in the return values that resulted from a MEAS:VOLT? or MEAS:POW? query sent to the associated channel. The MEAS:POW? query will return an overload indication if either voltage or current has exceeded the module's maximum measurement capability since power is calculated from voltage and current. Overload is indicated by the value 9.9E + 37 instead of the normal voltage or power readings. This is the IEEE 488.2 value for positive infinity.

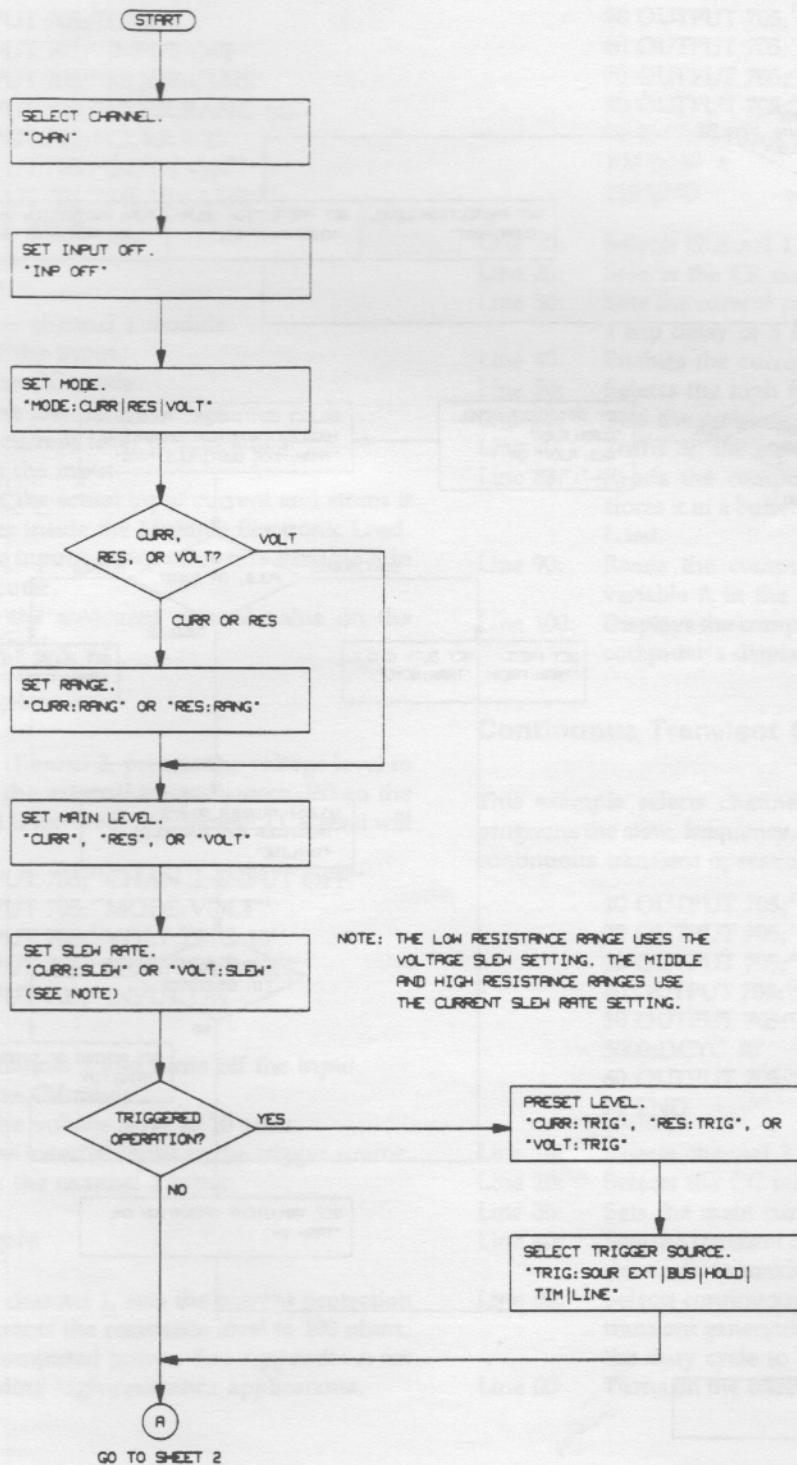


Figure 5-1. Remote Programming Flowchart (Sheet 1)

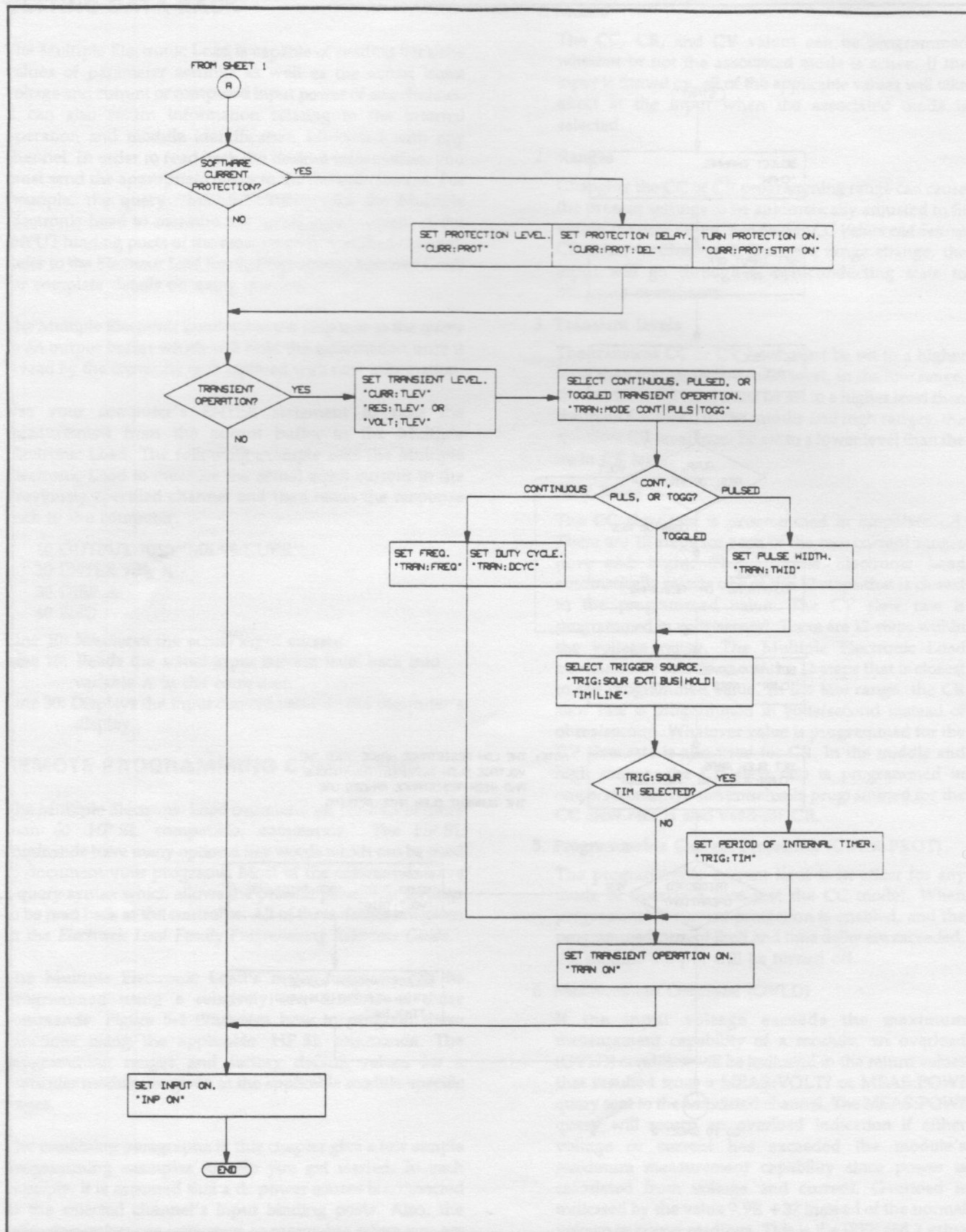


Figure 5-1. Remote Programming Flowchart (Sheet 2)

CC Mode Example

This example selects channel 1, sets the current level to 1.25 amps and then reads back the actual current value.

```
10 OUTPUT 705;"CHAN 1"  
20 OUTPUT 705;"INPUT OFF"  
30 OUTPUT 705;"MODE:CURR"  
40 OUTPUT 705;"CURR:RANG MIN"  
50 OUTPUT 705;"CURR 1.25"  
60 OUTPUT 705;"INPUT ON"  
70 OUTPUT 705;"MEAS:CURR?"  
80 ENTER 705;A  
90 DISP A  
100 END
```

- Line 10: Selects the channel 1 module.
- Line 20: Turns off the input.
- Line 30: Selects the CC mode.
- Line 40: Selects the low current range.
- Line 50: Sets the current level to 1.25 amps.
- Line 60: Turns on the input.
- Line 70: Measures the actual input current and stores it in a buffer inside the Multiple Electronic Load.
- Line 80: Reads the input current value into variable A in the computer.
- Line 90: Displays the measured current value on the computer's display.

CV Mode Example

This example selects channel 2, presets the voltage level to 10 volts, and selects the external trigger source. When the external trigger signal is received, the channel 2 CV level will be set to 10 volts.

```
10 OUTPUT 705;"CHAN 2::INPUT OFF"  
20 OUTPUT 705;"MODE:VOLT"  
30 OUTPUT 705;"VOLT:TRIG 10"  
40 OUTPUT 705;"TRIG:SOUR EXT"  
50 OUTPUT 705;"INPUT ON"  
60 END
```

- Line 10: Selects channel 2 and turns off the input.
- Line 20: Selects the CV mode.
- Line 30: Presets the voltage level to 10 volts.
- Line 40: Selects the external input as the trigger source.
- Line 50: Turns on the channel 2 input.

CR Mode Example

This example selects channel 1, sets the current protection limit to 2 amps, programs the resistance level to 100 ohms, and reads back the computed power. See Appendix A for considerations regarding high-resistance applications.

```
10 OUTPUT 705;"CHAN 1::INPUT OFF"  
20 OUTPUT 705;"MODE:RES"  
30 OUTPUT 705;"CURR:PROT:LEV 2;DEL 5"  
40 OUTPUT 705;"CURR:PROT:STAT ON"  
50 OUTPUT 705;"RES:RANG MAX"  
60 OUTPUT 705;"RES 100"  
70 OUTPUT 705;"INPUT ON"  
80 OUTPUT 705;"MEAS:POW?"  
90 ENTER 705;A  
100 DISP A  
110 END
```

- Line 10: Selects channel 1 and turns off the input.
- Line 20: Selects the CR mode.
- Line 30: Sets the current protection limit to 2 amps with a trip delay of 5 seconds.
- Line 40: Enables the current protection feature.
- Line 50: Selects the high resistance range.
- Line 60: Sets the resistance level to 100 ohms.
- Line 70: Turns on the input.
- Line 80: Reads the computed input power value and stores it in a buffer inside the Multiple Electronic Load.
- Line 90: Reads the computed input power level into variable A in the computer.
- Line 100: Displays the computed input power level on the computer's display.

Continuous Transient Operation Example

This example selects channel 2, sets the CC levels and programs the slew, frequency, and duty cycle parameters for continuous transient operation.

```
10 OUTPUT 705;"CHAN 2::INPUT OFF"  
20 OUTPUT 705;"MODE:CURR"  
30 OUTPUT 705;"CURR 1"  
40 OUTPUT 705;"CURR:TLEV 2;SLEW MAX"  
50 OUTPUT 705;"TRAN:MODE CONT;FREQ 5000;DCYC 40"  
60 OUTPUT 705;"TRAN ON::INPUT ON"  
70 END
```

- Line 10: Selects channel 2 and turns the input off.
- Line 20: Selects the CC mode.
- Line 30: Sets the main current level to 1 ampere.
- Line 40: Sets the transient current level to 2 amps and the slew rate to maximum.
- Line 50: Selects continuous transient operation, sets the transient generator frequency to 5 kHz, and sets the duty cycle to 40%.
- Line 60: Turns on the transient generator and the input.

Pulsed Transient Operation Example

This example selects channel 1, sets the CR levels, selects the bus as the trigger source, sets the fastest slew rate, programs a pulse width of 1 millisecond, and turns on transient operation. When the *TRG command is received, a 1 millisecond pulse is generated at the channel 1 input.

```
10 OUTPUT 705;"CHAN 1::INPUT OFF"
20 OUTPUT 705;"MODE:RES"
30 OUTPUT 705;"RES:RANG MAX; LEV 100"
40 OUTPUT 705;"RES:TLEV 50"
50 OUTPUT 705;"TRIG:SOUR BUS"
60 OUTPUT 705;"CURR:SLEW MAX"
70 OUTPUT 705;"TRAN:MODE PULS;TWID
.001"
80 OUTPUT 705;"TRAN ON::INPUT ON"

200 OUTPUT 705;"*TRG"
210 END
```

- Line 10: Selects channel 1 and turns the input off.
- Line 20: Selects the CR mode.
- Line 30: Selects the high resistance range and sets the main resistance level to 100 ohms.
- Line 40: Sets the transient resistance level to 50 ohms. Remember in the high resistance range, the transient resistance level must be set to a lower level than the main resistance level.
- Line 50: Selects the HP-IB as the trigger source.
- Line 60: Sets the CC slew rate to the maximum value. Remember that in the high resistance range, the CC slew rate is used.
- Line 70: Selects pulsed transient operation and sets the pulse width to 1 millisecond.
- Line 80: Turns on the transient generator and the input.

Other commands are executed

- Line 200: The *TRG command generates a 1 millisecond pulse at the channel 1 input.

Synchronous Toggled Transient Operation Example

This example programs channels 1 and 2 to generate synchronous transient waveforms. Each channel is set up to operate in the CV mode with toggled transient operation turned on. The Multiple Electronic Load's internal trigger oscillator is set up to produce trigger pulses at a frequency of 2 kHz in order to generate synchronous waveforms at the channel 1 and channel 2 inputs.

```
10 OUTPUT 705;"CHAN 1::INPUT OFF"
20 OUTPUT 705;"MODE:VOLT"
30 OUTPUT 705;"VOLT 5"
40 OUTPUT 705;"VOLT:TLEV 10; SLEW MAX"
50 OUTPUT 705;"TRAN:MODE TOGG"
60 OUTPUT 705;"TRAN ON::INPUT ON"
70 OUTPUT 705;"CHAN 2::INPUT OFF"
80 OUTPUT 705;"MODE VOLT"
90 OUTPUT 705;"VOLT 10"
100 OUTPUT 705;"VOLT:TLEV 20; SLEW MAX"
110 OUTPUT 705;"TRAN:MODE TOGG"
120 OUTPUT 705;"TRAN ON::INPUT ON"
130 OUTPUT 705;"TRIG:TIM .0005"
140 OUTPUT 705;"TRIG:SOUR TIM"
150 END
```

- Line 10: Selects channel 1 and turns the input off.
- Line 20: Selects the CV mode.
- Line 30: Sets the main voltage level to 5 volts.
- Line 40: Sets the transient voltage level to 10 volts and the voltage slew rate to maximum.
- Line 50: Selects toggled transient operation.
- Line 60: Enables transient operation and turns on the channel 1 input.
- Line 70: Selects channel 2 and turns the input off.
- Line 80: Selects the CV mode.
- Line 90: Sets the main voltage level to 10 volts.
- Line 100: Sets the transient voltage level to 20 volts and the slew to maximum.
- Line 110: Selects toggled transient operation.
- Line 120: Enables transient operation and turns on the channel 2 input.
- Line 130: Sets the internal trigger oscillator frequency to 2 kHz (period of pulses = 0.0005).
- Line 140: Selects the Multiple Electronic Load's internal oscillator as the trigger source. The oscillator begins running as soon as this line is executed.

Chapter 6 CALIBRATION

INTRODUCTION

This chapter describes the calibration procedures for the HP 6050A and 6051A Electronic Load mainframe and its associated modules. Both "A" modules (HP Models 60501A-60504A) and "B" modules (HP Models 60501B-60507B) are covered in separate procedures. The Electronic Load should be calibrated annually, or whenever certain repairs are made (refer to the Service Manual). Calibration is accomplished entirely in software by sending calibration constants to the Electronic Load via the HP-IB. This means that the Electronic Load can be calibrated without removing its cover, or removing it from its cabinet if rack mounted.

Each module has three DACs that must be calibrated — a main DAC, a readback DAC, and a transient level DAC. Six ranges must be calibrated for both the main DAC and the transient DAC — a voltage range, a low resistance range, a middle resistance range, a high resistance range, a low current range, and a high current range. The main DAC requires two operating points to be calibrated for each range — a high point and a low point. The transient DAC requires only the high operating point to be calibrated for each range; it uses the same low operating point as the main DAC. Note that the transient level for the middle and high resistance ranges is *lower* than the high level of the main DAC.

The readback DAC is only calibrated for the high current range and the voltage range. It also requires two operating points to be calibrated for each range — a high point and a low point. For the sake of convenience you can use the

same values to calibrate the main and the readback DAC, but you could also use different values to optimize accuracy.

NOTE

All calibration must be done when the Electronic Load is at room temperature.

EQUIPMENT REQUIRED

Table 6-1 lists the equipment required for calibration. Note that less accurate and less expensive current shunts may be used than those listed, but the accuracy to which current and resistance programming, as well as readback, can be checked must be reduced accordingly. Figure 6-1 illustrates how the calibration equipment should be connected.

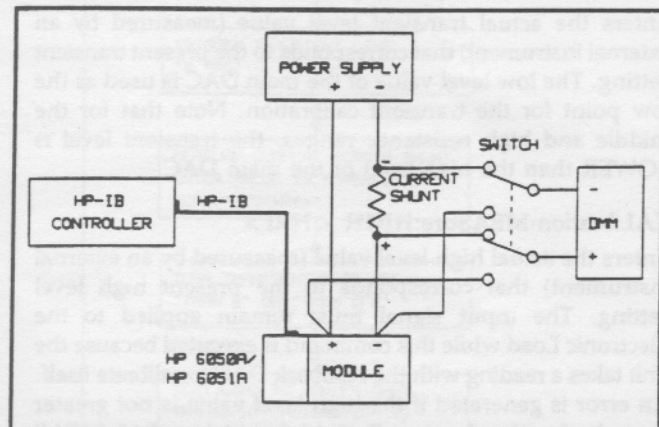


Figure 6-1. Calibration Equipment Setup

Table 6-1. Equipment Required for Calibration

Equipment	Characteristics	Recommended Model
Shunts	0.1 Ω @ 15 A, 0.04% @ 25 W 0.01 Ω @ 100 A, 0.04% @ 100 W 0.001 Ω @ 300 A, 0.04% @ 100 W	Guildline 9230/15 Guildline 9230/100 Guildline 9230/300
Voltmeter	dc accuracy of 0.01%, 6 digit readout	HP 3456A or equivalent
Power Supply	60 Vdc/120 Adc minimum PARD < 3 mV rms/30 mv pp	HP 6032A or HP 6035A and HP 6031A, or equivalent
Controller	HP-IB (IEEE-488)	HP BASIC (2.1 or higher)

CALIBRATION COMMANDS

The following calibration commands are required to calibrate the Electronic Load. They are used in the example program included in this section. Refer to the *HP Electronic Loads Programming Reference Guide* for syntax requirements for HP SL commands.

CALibration:[MODE] ON|OFF|1|0

Turns the calibration mode on or off.

CALibration:LEVel:HIGH <NRf>

Enters the actual high level value (measured by an external instrument) that corresponds to the present high level setting. An error is generated if the high level value is not greater than the low level value. Both high and low **CAL:LEV** commands must be sent before the constants are recalculated and stored in RAM.

CALibration:LEVel:LOW <NRf>

Enters the actual low level value (measured by an external instrument) that corresponds to the present low level setting. An error is generated if the low level value is not less than the high level value. Both high and low **CAL:LEV** commands must be sent before the constants are recalculated and stored in RAM.

CALibration:TLEVel[:HIGH] <NRf>

Enters the actual transient level value (measured by an external instrument) that corresponds to the present transient setting. The low level value of the main DAC is used as the low point for the transient calibration. Note that for the middle and high resistance ranges, the transient level is LOWER than the high level of the main DAC.

CALibration:MEASure:HIGH <NRf>

Enters the actual high level value (measured by an external instrument) that corresponds to the present high level setting. The input signal must remain applied to the Electronic Load while this command is executed because the unit takes a reading with the readback DAC to calibrate itself. An error is generated if the high level value is not greater than the low level value. Both high and low **CAL:MEAS** commands must be sent before the constants are recalculated and stored in RAM.

CALibration:MEASure:LOW <NRf>

Enters the actual low level value (measured by an external instrument) that corresponds to the present low level setting. The input signal must remain applied to the Electronic Load while this command is executed because the unit takes a reading with the readback DAC to calibrate itself. An error is generated if the low level value is not less than the high level value. Both high and low **CAL:MEAS** commands must be sent before the constants are recalculated and stored in RAM.

CALibration:SAVE

Writes the present calibration constants into the EEPROM. This command does not have to be sent until all ranges and

modes have been calibrated. If the unit is turned off before **CAL:SAVE** is sent, the new calibration constants are lost.

CALIBRATION FLOWCHARTS

The flowcharts in Figures 6-2 and 6-3 describe the calibration procedures for "A" and "B" modules, respectively. They correspond to the example calibration programs. The flowcharts indicate the appropriate statement that is used in the program example to accomplish each step. They also indicate when to set the power supply to the appropriate voltage and current output. Refer to the Calibration Information (Table 4) in your module manual for the variable values, power supply settings, and current shunts.

Calibration mode is turned on at the beginning of the calibration procedure. Remember to save the calibration constants after you have verified that they are within specifications. Do not turn calibration mode off until after you have saved the new calibration constants — otherwise the new calibration constants will be lost.

NOTE

*When calibrating the high calibration point of the high current range and high current transient level, you must wait about 30 seconds for the internal current shunt of the module to stabilize with the full current applied before you execute the **CAL:MEAS:HIGH** command. Because the high current range calibration cause the module to heat up, you should also allow about 30 seconds time for the module to cool down to room temperature before continuing to calibrate any other modes or ranges.*

One shortcut that is used in this calibration procedure is that the readback DAC is calibrated for current readback after the high current range calibration, and calibrated for voltage readback after the voltage range calibration. This is because the readback setups are the same as the setups for the high current and voltage ranges. Another shortcut is that the same values are used to calibrate the main DAC as well as the readback DAC. You may wish to use different values to calibrate the readback DAC to optimize accuracy.

It is not necessary to calibrate the current readback for the low current range or for reading back resistance values. This is because the high current readback calibration takes care of the low current range. The resistance values that are read back are calculated based on the voltage at the input terminals and the current through the internal current shunt resistor. If the readback DAC has been calibrated for voltage and current readback, resistance readback will be accurate.

NOTE

Remember to turn the unit off after you have saved the new calibration constants. When the unit is turned on again, the new calibration constants are used to recalculate the software OP and OC limits.

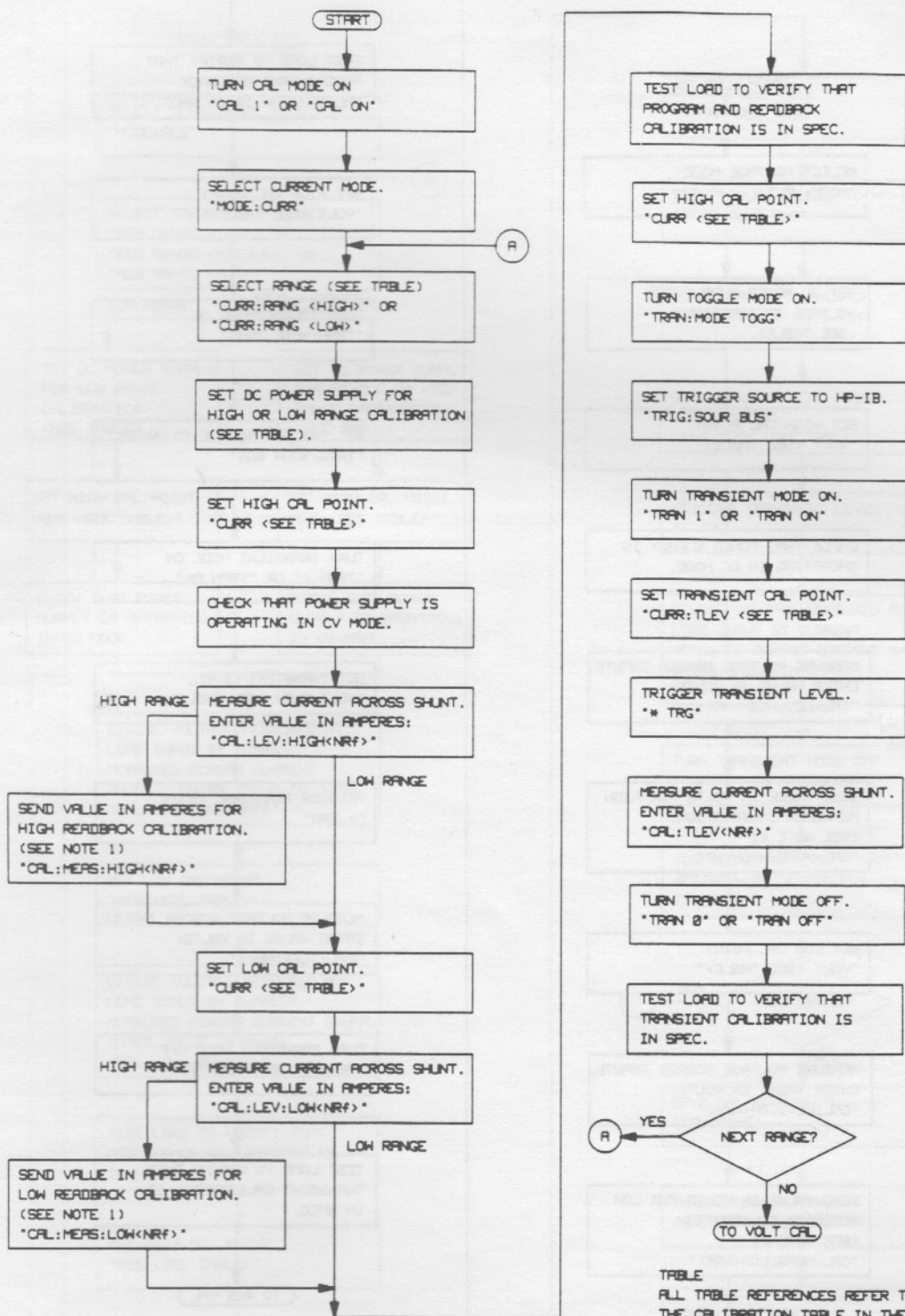


Figure 6-2. Calibration Flowchart for "A" Modules

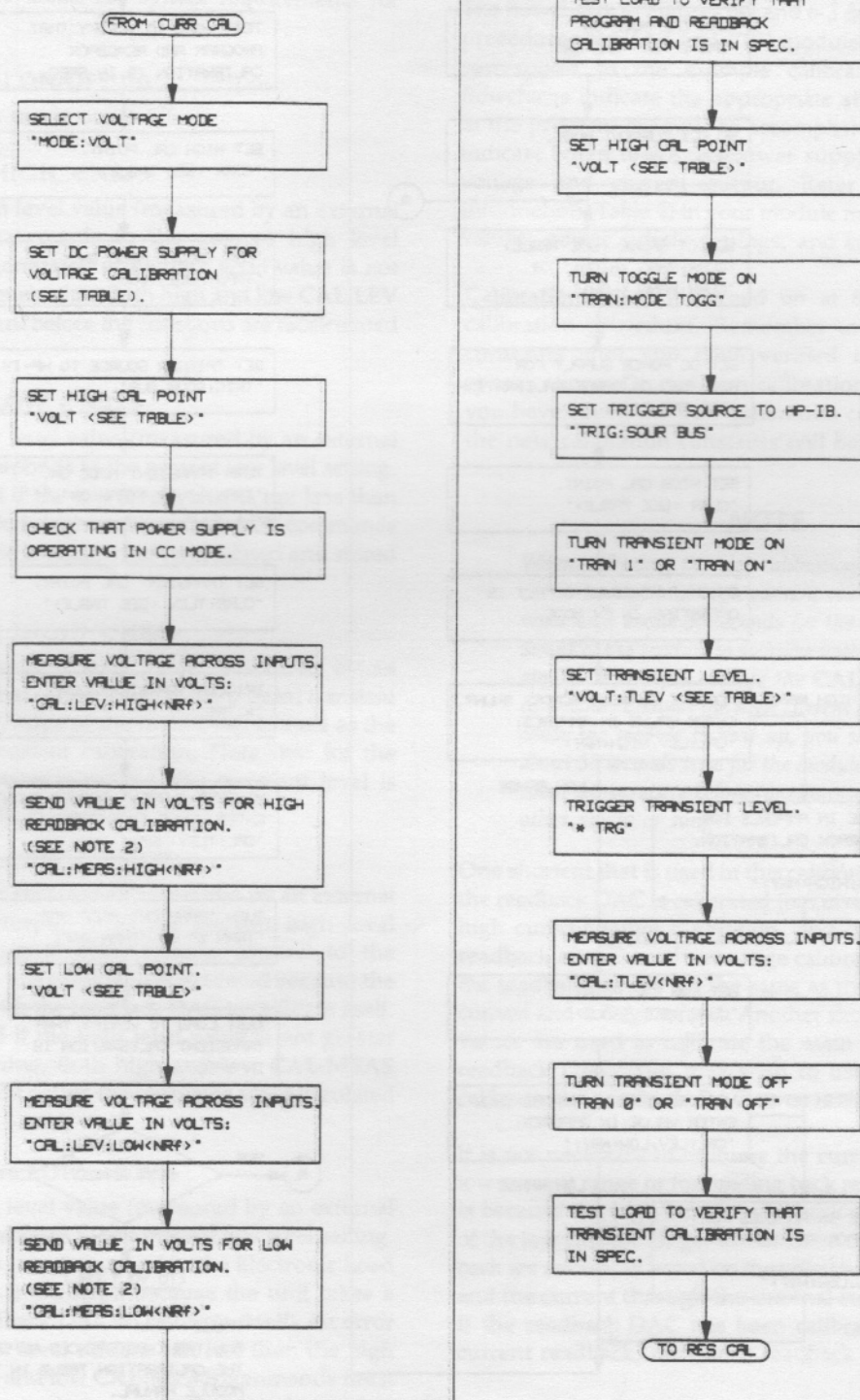


TABLE
ALL TABLE REFERENCES REFER TO
THE CALIBRATION TABLE IN THE
MODULE MANUAL.

NOTE 2
READBACK DAC DOES NOT NECESSARILY
HAVE TO BE CALIBRATED TO THE
SAME ACCURACY AS THE PROGRAM DAC.

Figure 6-2. Calibration Flowchart for "A" Modules (continued)

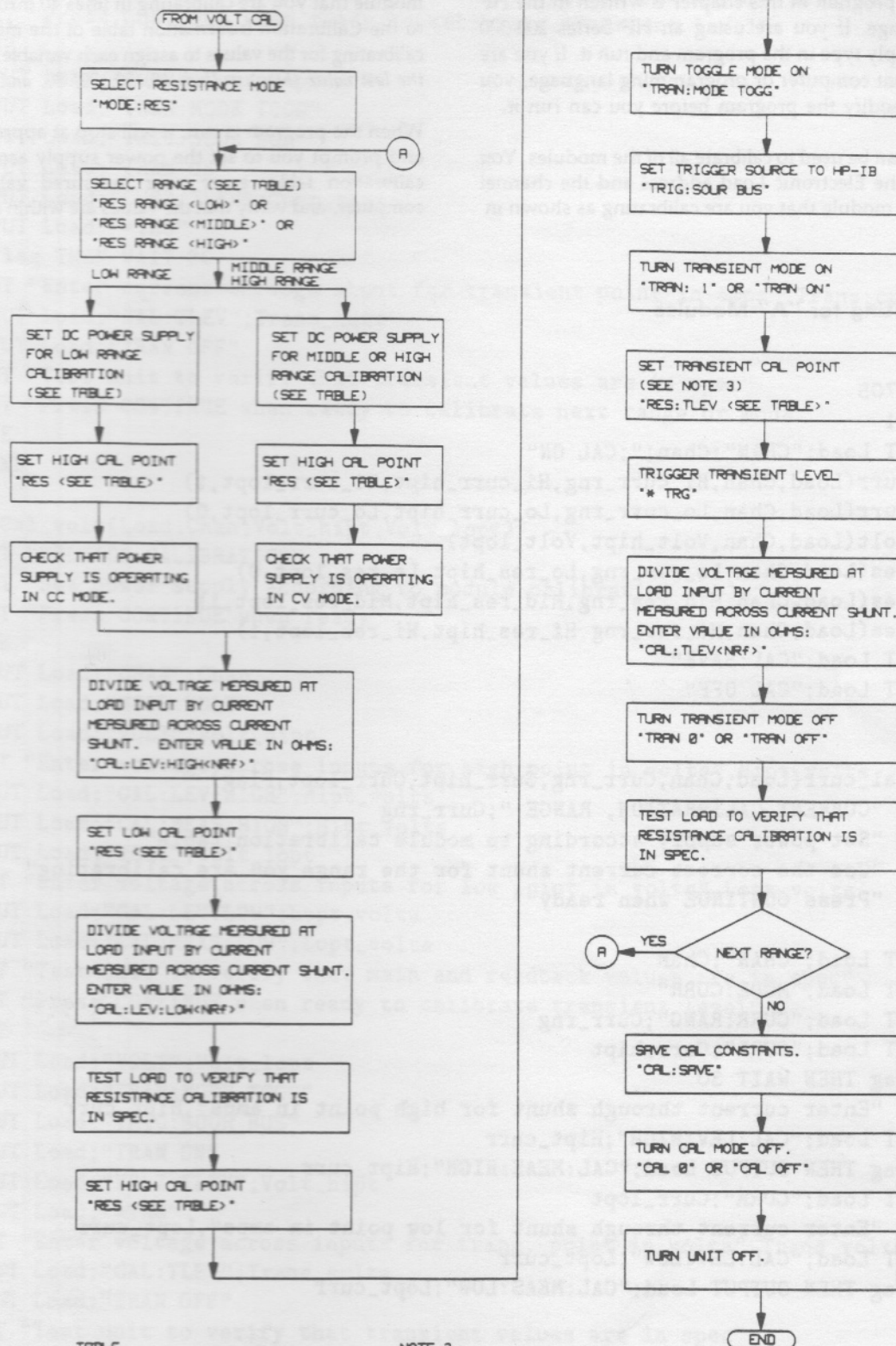


Figure 6-2. Calibration Flowchart for "A" Modules (continued)

EXAMPLE PROGRAMS

Each example program in this chapter is written in the HP BASIC Language. If you are using an HP Series 200/300 computer, simply type in the program and run it. If you are using a different computer or programming language, you will have to modify the program before you can run it.

The program can be used to calibrate all of the modules. You must specify the Electronic Load address and the channel number of the module that you are calibrating as shown in

lines 10 and 20. (The program assumes address 705, channel 1.) Then you must make the variable assignments for the module that you are calibrating in lines 40 through 90. Refer to the Calibration Information table of the module you are calibrating for the values to assign each variable. *Do not change the last value (Flag) in lines 40, 50, 70, 80, and 90.*

When the program is run, it will stop at appropriate places and prompt you to set the power supply according to the calibration table, enter your measured values into the computer, and verify that the values are within specifications.

Program Listing for "A" Modules

```
10 Load=705
20 Chan=1
30 OUTPUT Load;"CHAN";Chan;"CAL ON"
40 Cal_curr(Load,Chan,Hi_curr_rng,Hi_curr_hipt,Hi_curr_lopt,1)
50 Cal_curr(Load,Chan,Lo_curr_rng,Lo_curr_hipt,Lo_curr_lopt,0)
60 Cal_volt(Load,Chan,Volt_hipt,Volt_lopt)
70 Cal_res(Load,Chan,Lo_res_rng,Lo_res_hipt,Lo_res_lopt,0)
80 Cal_res(Load,Chan,Mid_res_rng,Mid_res_hipt,Mid_res_lopt,1)
90 Cal_res(Load,Chan,Hi_res_rng,Hi_res_hipt,Hi_res_lopt,1)
100 OUTPUT Load;"CAL:SAVE"
110 OUTPUT Load;"CAL OFF"
120 END
130 !
140 SUB Cal_curr(Load,Chan,Curr_rng,Curr_hipt,Curr_lopt,Flag)
150 PRINT "CURRENT CALIBRATION, RANGE ";Curr_rng
160 PRINT "Set power supply according to module calibration table"
170 PRINT "Use the correct current shunt for the range you are calibrating"
180 PRINT "Press CONTINUE when ready"
190 PAUSE
200 OUTPUT Load;"CHAN";Chan
210 OUTPUT Load;"MODE:CURR"
220 OUTPUT Load;"CURR:RANG";Curr_rng
230 OUTPUT Load;"CURR";Curr_hipt
240 IF Flag THEN WAIT 30
250 INPUT "Enter current through shunt for high point in amps",Hipt_curr
260 OUTPUT Load;"CAL:LEV:HIGH";Hipt_curr
270 IF Flag THEN OUTPUT Load;"CAL:MEAS:HIGH";Hipt_curr
280 OUTPUT Load;"CURR";Curr_lopt
290 INPUT "Enter current through shunt for low point in amps",Lopt_curr
300 OUTPUT Load;"CAL:LEV:LOW";Lopt_curr
310 IF Flag THEN OUTPUT Load;"CAL:MEAS:LOW";Lopt_curr
```

Program Listing for "A" Modules (continued)

```

320 PRINT "Test unit to verify that main (and readback) values are in spec"
330 PRINT "Press CONTINUE when ready to calibrate transient level"
340 PAUSE
350 OUTPUT Load;"CURR";Curr_lopt
360 OUTPUT Load;"TRAN:MODE TOGG"
370 OUTPUT Load;"TRIG:SOUR BUS"
380 OUTPUT Load;"TRAN ON"
390 OUTPUT Load;"CURR:TLEV";Curr_hipt
400 OUTPUT Load;"*TRG"
410 IF Flag THEN WAIT 30
420 INPUT "Enter current through shunt for transient point in amps",Trans_curr
430 OUTPUT Load;"CAL:TLEV";Trans_curr
440 OUTPUT Load;"TRAN OFF"
450 PRINT "Test unit to verify that transient values are in spec"
460 PRINT "Press CONTINUE when ready to calibrate next range or mode"
470 PAUSE
480 SUBEND
490 !
500 SUB Cal_volt(Load,Chan,Volt_hipt,Volt_lopt)
510 PRINT "VOLTAGE CALIBRATION"
520 PRINT "Set power supply according to module calibration table"
530 PRINT "Press CONTINUE when ready"
540 PAUSE
550 OUTPUT Load;"CHAN";Chan
560 OUTPUT Load;"MODE:VOLT"
570 OUTPUT Load;"VOLT";Volt_hipt
580 INPUT "Enter voltage across inputs for high point in volts",Hipt_volts
590 OUTPUT Load;"CAL:LEV:HIGH";Hipt_volts
600 OUTPUT Load;"CAL:MEAS:HIGH";Hipt_volts
610 OUTPUT Load;"VOLT";Volt_lopt
620 INPUT "Enter voltage across inputs for low point in volts",Lopt_volts
630 OUTPUT Load;"CAL:LEV:LOW";Lopt_volts
640 OUTPUT Load;"CAL:MEAS:LOW";Lopt_volts
650 PRINT "Test unit to verify that main and readback values are in spec"
660 PRINT "Press CONTINUE when ready to calibrate transient level"
670 PAUSE
680 OUTPUT Load;"VOLT";Volt_lopt
690 OUTPUT Load;"TRAN:MODE TOGG"
700 OUTPUT Load;"TRIG:SOUR BUS"
710 OUTPUT Load;"TRAN ON"
720 OUTPUT Load;"VOLT:TLEV";Volt_hipt
730 OUTPUT Load;"*TRG"
740 INPUT "Enter voltage across inputs for trans. point in volts",Trans_volts
750 OUTPUT Load;"CAL:TLEV";Trans_volts
760 OUTPUT Load;"TRAN OFF"
770 PRINT "Test unit to verify that transient values are in spec"
780 PRINT "Press CONTINUE when ready to calibrate next mode"
790 PAUSE
800 SUBEND

```


Program Listing for "A" Modules (continued)

```

810 !
820 SUB Cal_res(Load,Chan,Res_rng,Res_hipt,Res_lopt,Flag)
830 PRINT "RESISTANCE CALIBRATION, RANGE ";Res_rng
840 PRINT "Set power supply according to module calibration table"
850 PRINT "Press CONTINUE when ready"
860 PAUSE
870 OUTPUT Load;"CHAN";Chan
880 OUTPUT Load;"MODE:RES"
890 OUTPUT Load;"RES:RANG";Res_rng
900 OUTPUT Load;"RES";Res_hipt
910 INPUT "Enter voltage across inputs for high point in volts",Hipt_volt
920 INPUT "Enter current through shunt for high point in amps",Hipt_curr
930 Hipt_res=Hipt_volt/Hipt_curr
940 OUTPUT Load;"CAL:LEV:HIGH";Hipt_res
950 OUTPUT Load;"RES";Res_lopt
960 INPUT "Enter voltage across inputs for low point in volts",Lopt_volt
970 INPUT "Enter current through shunt for low point in amps",Lopt_curr
980 Lopt_res=Lopt_volt/Lopt_curr
990 OUTPUT Load;"CAL:LEV:LOW";Lopt_res
1000 PRINT "Test unit to verify that main values are in spec"
1010 PRINT "Press CONTINUE when ready to calibrate transient level"
1020 PAUSE
1030 IF Flag THEN
1040 OUTPUT Load;"RES";Res_hipt
1050 ELSE
1060 OUTPUT Load;"RES";Res_lopt
1070 END IF
1080 OUTPUT Load;"TRAN:MODE TOGG"
1090 OUTPUT Load;"TRIG:SOUR BUS"
1100 OUTPUT Load;"TRAN ON"
1110 IF Flag THEN
1120 OUTPUT Load;"RES:TLEV";Res_lopt
1130 ELSE
1140 OUTPUT Load;"RES:TLEV";Res_hipt
1150 END IF
1160 OUTPUT Load;"*TRG"
1170 INPUT "Enter voltage across inputs for trans. point in volts",Trans_volt
1180 INPUT "Enter current through shunt for trans. point in amps",Trans_curr
1190 Trans_res=Trans_volt/Trans_curr
1200 OUTPUT Load;"CAL:TLEV";Trans_res
1210 OUTPUT Load;"TRAN OFF"
1220 PRINT "Test unit to verify that transient values are in spec"
1230 PRINT "Press CONTINUE when ready to calibrate next range or end program"
1240 PAUSE
1250 SUBEND

```

Explanation

LINE 10-20	Specify select code, address, and channel (default = 705, 1)
LINE 30	Turn calibration mode on
LINE 40-90	Assign variables for subprograms (see module calibration tables)
LINE 100	Store new constants in EEROM when calibration complete
LINE 110	Turn calibration mode off
LINE 140	Current calibration subroutine
LINE 200-220	Select channel, current mode, and range
LINE 230	Set high calibration point
LINE 240	If high current range, wait for internal current shunt to stabilize
LINE 260	Send measurement in amperes for high main calibration point
LINE 270	If high current range, send measurement in amperes for high readback cal point
LINE 280	Set low calibration point
LINE 300	Send measurement in amperes for low main calibration point
LINE 310	If high current range, send measurement in amperes for low readback cal point
LINE 350	Set low calibration point
LINE 360-370	Select transient toggle mode and HP-IB trigger source
LINE 380-390	Turn transient mode on and set transient calibration point
LINE 400	Trigger transient level
LINE 410	If high current range, wait for internal current shunt to stabilize
LINE 430	Send measurement in amperes for high transient calibration point
LINE 440	Turn transient mode off
LINE 500	Voltage calibration subroutine
LINE 550-560	Select channel and voltage mode
LINE 570	Set high calibration point
LINE 590	Send measurement in volts for high main calibration point
LINE 600	Send measurement in volts for high readback calibration point
LINE 610	Set low calibration point
LINE 630	Send measurement in volts for low main calibration point
LINE 640	Send measurement in volts for low readback calibration point
LINE 680	Set low calibration point
LINE 690-700	Select transient toggle mode and HP-IB trigger source
LINE 710-720	Turn transient mode on and set transient calibration point
LINE 730	Trigger transient level
LINE 750	Send measurement in volts for transient calibration point
LINE 760	Turn transient mode off
LINE 820	Resistance calibration subroutine
LINE 870-890	Select channel, resistance mode, and range
LINE 900	Set high calibration point
LINE 930-940	Calculate and send measurement in ohms for high main calibration point
LINE 950	Set low calibration point
LINE 980-990	Calculate and send measurement in ohms for low main calibration point
LINE 1030-1070	If middle and high range, set high calibration point; otherwise set low point
LINE 1080-1090	Select transient toggle mode and HP-IB trigger source
LINE 1100	Turn transient mode on
LINE 1110-1150	If middle and high range, set lower transient point; otherwise set higher point
LINE 1160	Trigger transient level
LINE 1190-1200	Calculate and send measurement in ohms for transient calibration point
LINE 1210	Turn transient mode off

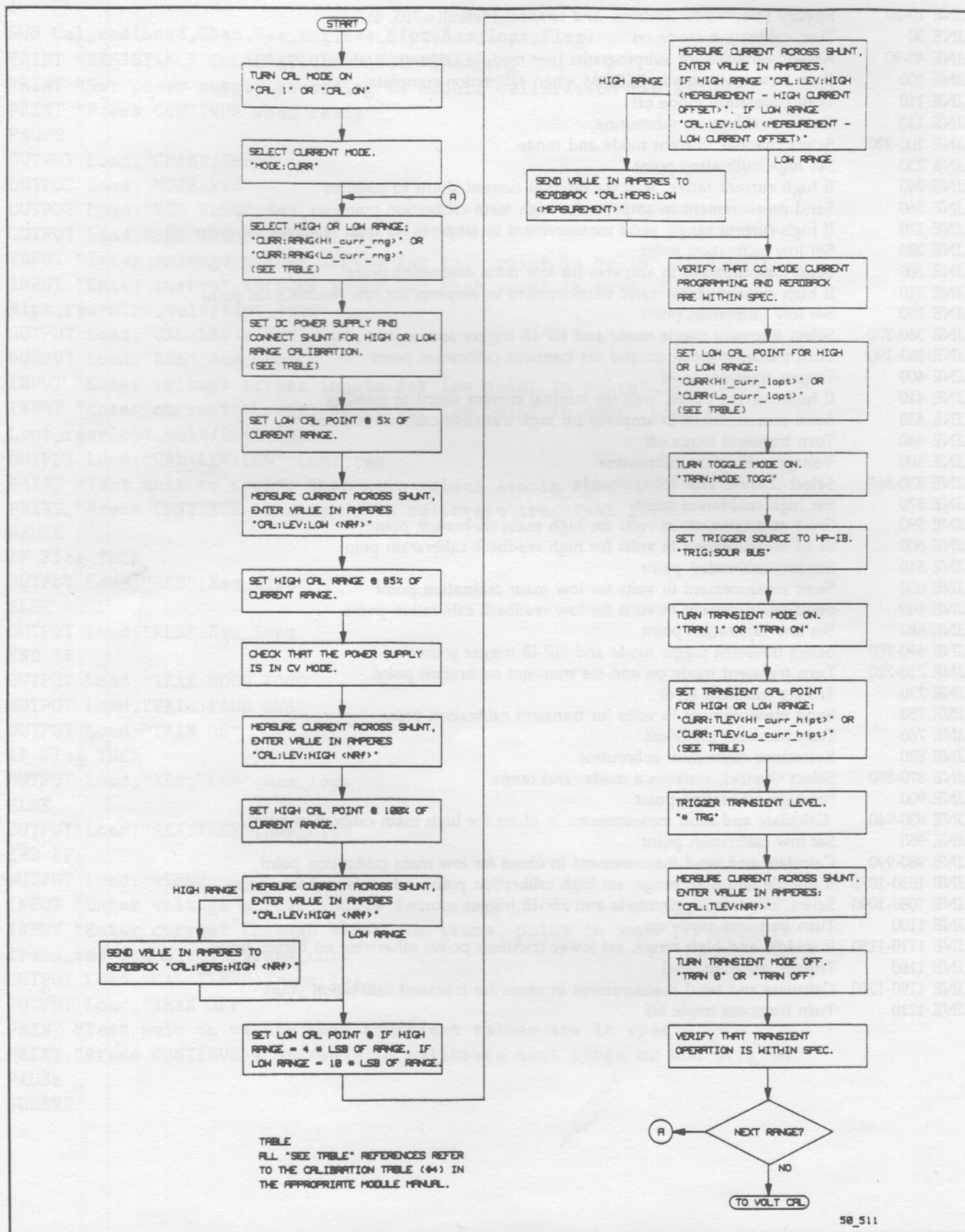


Figure 6-3. Calibration Flowchart for "B" Modules

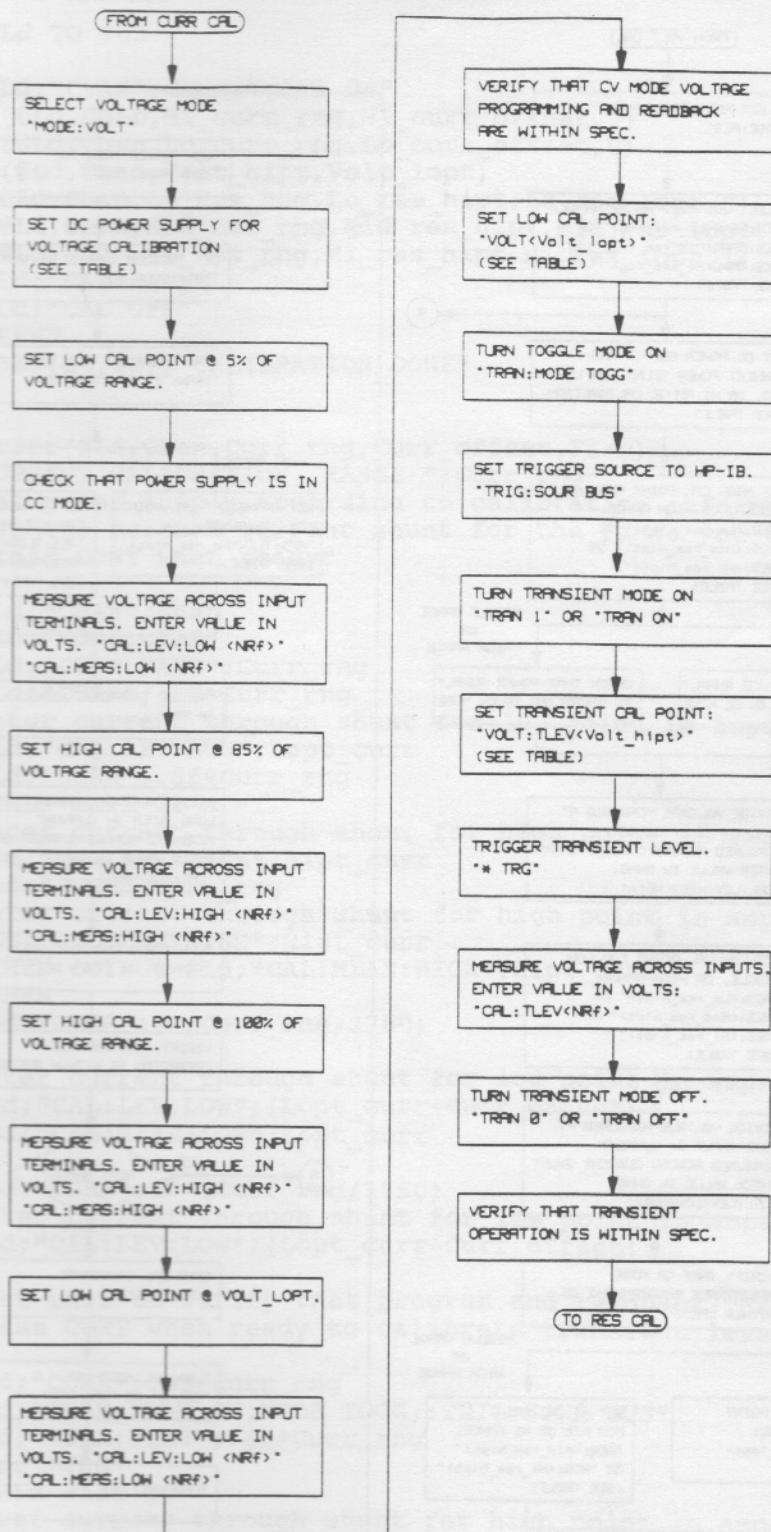


TABLE
ALL "SEE TABLE" REFERENCES REFER
TO THE CALIBRATION TABLE (#4) IN
THE APPROPRIATE MODULE MANUAL.

Figure 6-3. Calibration Flowchart for "B" Modules (continued)

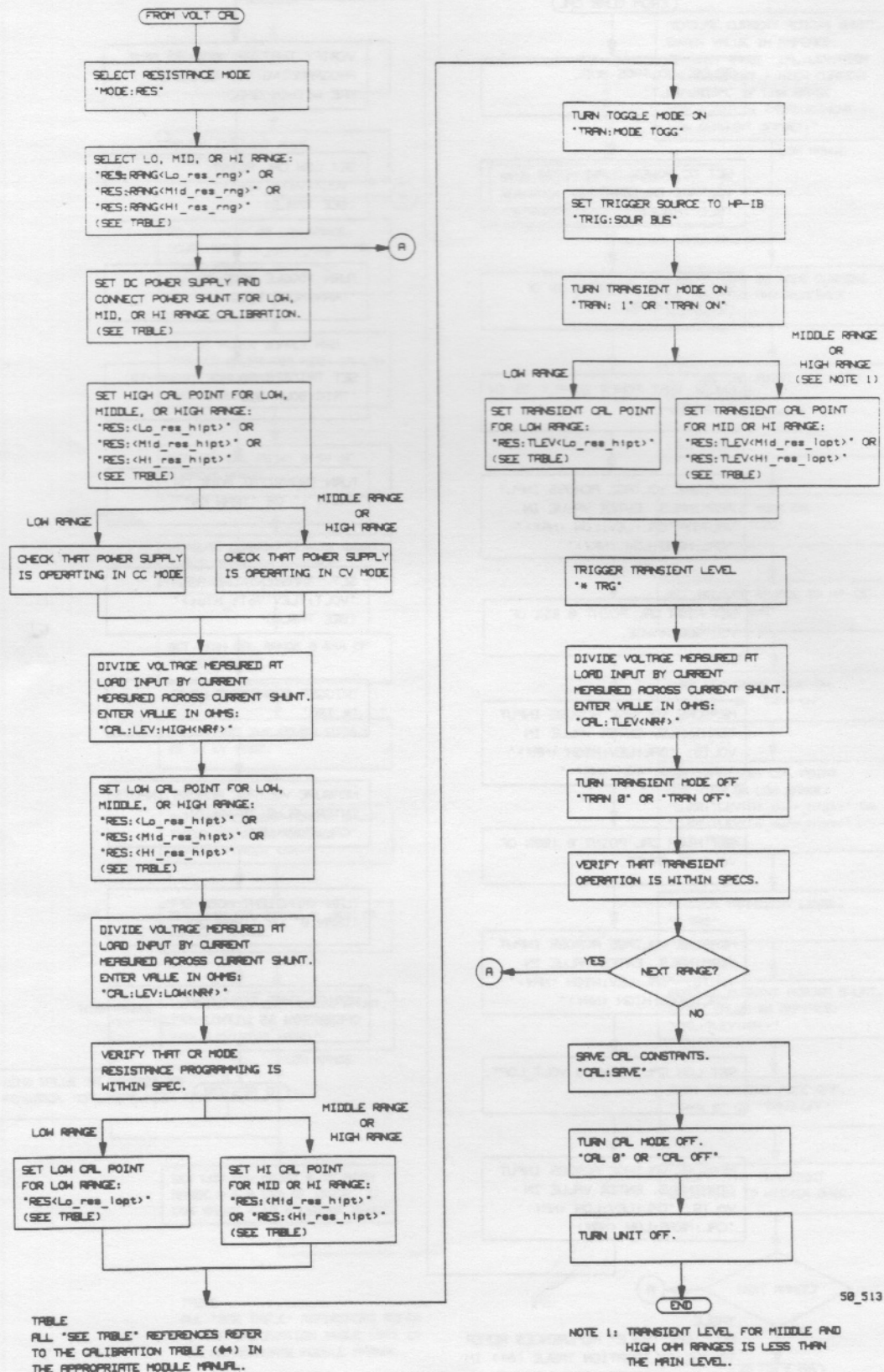


Figure 6-3. Calibration Flowchart for "B" Modules (continued)

Program Listing for "B" Modules

```

10  ASSIGN @Ld TO 705
20  Chan=1
30  OUTPUT @Ld;"CHAN";Chan;"CAL ON"
40  Cal_curr(@Ld,Chan,Hi_curr_rng,Hi_curr_offset,1)
50  Cal_curr(@Ld,Chan,Lo_curr_rng,Lo_curr_offset,0)
60  Cal_volt(@Ld,Chan,Volt_hipt,Volt_lopt)
70  Cal_res(@Ld,Chan,Lo_res_rng,Lo_res_hipt,Lo_res_lopt,0)
80  Cal_res(@Ld,Chan,Mid_res_rng,Mid_res_hipt,Mid_res_lopt,1)
90  Cal_res(@Ld,Chan,Hi_res_rng,Hi_res_hipt,Hi_res_lopt,1)
100 OUTPUT @Ld;"CAL:SAVE"
110 OUTPUT @Ld;"CAL OFF"
120 CLEAR SCREEN
130 PRINT TABXY(10,10);"CALIBRATION DONE"
140 END
150 !
160 SUB Cal_curr(@Ld,Chan,Curr_rng,Curr_offset,Flag)
170 PRINT "CURRENT CALIBRATION, RANGE ";Curr_rng
180 PRINT "Set power supply according to calibration information table"
190 PRINT "Use the correct current shunt for the range you are calibrating"
200 PRINT "Press CONT when ready"
210 PAUSE
220 OUTPUT @Ld;"CHAN";Chan
230 OUTPUT @Ld;"MODE:CURR"
240 OUTPUT @Ld;"CURR:RANG";Curr_rng
250 OUTPUT @Ld;"CURR";.05*Curr_rng
260 INPUT "Enter current through shunt for low point in amps",Lopt_curr
270 OUTPUT @Ld;"CAL:LEV:LOW";Lopt_curr
280 OUTPUT @Ld;"CURR";.85*Curr_rng
290 IF Flag THEN WAIT 25
300 INPUT "Enter current through shunt for high point in amps",Hipt_curr
310 OUTPUT @Ld;"CAL:LEV:HIGH";Hipt_curr
320 OUTPUT @Ld;"CURR";Curr_rng
330 INPUT "Enter current through shunt for high point in amps",Hipt_curr
340 OUTPUT @Ld;"CAL:LEV:HIGH";Hipt_curr
350 IF Flag THEN OUTPUT @Ld;"CAL:MEAS:HIGH";Hipt_curr
360 IF Flag THEN
370 OUTPUT @Ld;"CURR";4*(Curr_rng/3750)
380 WAIT 25
390 INPUT "Enter current through shunt for low point in amps",Lopt_curr
400 OUTPUT @Ld;"CAL:LEV:LOW";(Lopt_curr-Curr_offset)
410 OUTPUT @Ld;"CAL:MEAS:LOW";Lopt_curr
420 ELSE
430 OUTPUT @Ld;"CURR";10*(Curr_rng/3750)
440 INPUT "Enter current through shunt for low point in amps",Lopt_curr
450 OUTPUT @Ld;"CAL:LEV:LOW";(Lopt_curr-Curr_offset)
460 END IF
470 PRINT "Test unit to verify that program and readback values are in spec"
480 PRINT "Press CONT when ready to calibrate transient levels "
490 PAUSE
500 OUTPUT @Ld;"CURR";.05*Curr_rng
510 OUTPUT @Ld;"TRAN:STAT ON;MODE TOGG;:TRIG:SOUR BUS"
520 OUTPUT @Ld;"CURR:TLEV";.85*Curr_rng
530 OUTPUT @Ld;"*TRG"
540 IF Flag THEN WAIT 30
550 INPUT "Enter current through shunt for high point in amps",Trpt_curr
560 OUTPUT @Ld;"CAL:TLEV";Trpt_curr
570 OUTPUT @Ld;"TRAN OFF"
580 PRINT "Test unit to verify that transient values are in spec"
590 PRINT "Press CONT when ready to calibrate next range or mode"
600 PAUSE

```


Program Listing for "B" Modules (continued)

```

610 SUBEND
620 !
630 SUB Cal_volt(@Ld,Chan,Volt_hipt,Volt_lopt)
640 PRINT "VOLTAGE CALIBRATION"
650 PRINT "Set power supply according to calibration information table"
660 PRINT "Press CONT when ready"
670 PAUSE
680 OUTPUT @Ld;"CHAN";Chan
690 OUTPUT @Ld;"MODE:VOLT"
700 OUTPUT @Ld;"VOLT";.05*Volt_hipt
710 WAIT 3
720 INPUT "Enter voltage across input terminals for low point in volts",
    Lopt_volts
730 OUTPUT @Ld;"CAL:LEV:LOW";Lopt_volts
740 OUTPUT @Ld;"CAL:MEAS:LOW";Lopt_volts
750 OUTPUT @Ld;"VOLT";.85*Volt_hipt
760 WAIT 3
770 INPUT "Enter voltage across input terminals for high point in volts",
    Hipt_volts
780 OUTPUT @Ld;"CAL:LEV:HIG";Hipt_volts
790 OUTPUT @Ld;"CAL:MEAS:HIG";Hipt_volts
800 OUTPUT @Ld;"VOLT";Volt_lopt
810 WAIT 3
820 INPUT "Enter voltage across input terminals for low point in volts",
    Lopt_volts
830 OUTPUT @Ld;"CAL:LEV:LOW";Lopt_volts
840 OUTPUT @Ld;"CAL:MEAS:LOW";Lopt_volts
850 OUTPUT @Ld;"VOLT";Volt_hipt
860 WAIT 3
870 INPUT "Enter voltage across input terminals for high point in volts",
    Hipt_volts
880 OUTPUT @Ld;"CAL:LEV:HIG";Hipt_volts
890 OUTPUT @Ld;"CAL:MEAS:HIG";Hipt_volts
900 PRINT "Test unit to verify that program and readback values are in spec"
910 PRINT "Press CONT when redy to calibrate transient level"
920 PAUSE
930 OUTPUT @Ld;"VOLT";Volt_lopt
940 OUTPUT @Ld;"TRAN:STAT ON;MODE TOGG;:TRIG:SOUR BUS"
950 OUTPUT @Ld;"VOLT:TLEV";Volt_hipt
960 OUTPUT @Ld;"*TRG"
970 INPUT "Enter voltage across input terminals for transient point in volts",
    Trpt_volts
980 OUTPUT @Ld;"CAL:TLEV";Trpt_volts
990 OUTPUT @Ld;"TRAN OFF"
1000 PRINT "test unit to verify that transient values are in spec"
1010 PRINT "Press CONT when ready to calibrate next mode"
1020 PAUSE
1030 SUBEND
1040 !
1050 SUB Cal_res(@Ld,Chan,Res_rng,Res_hipt,Res_lopt,Flag)
1060 PRINT "RESISTANCE CALIBRATION, RANGE";Res_rng
1070 PRINT "Set power supply to calibration information table"
1080 PRINT "Press CONT when ready to continue"
1090 PAUSE
1100 OUTPUT @Ld;"CHAN";Chan
1110 OUTPUT @Ld;"MODE:RES"
1120 OUTPUT @Ld;"RES:RANG";Res_rng
1130 OUTPUT @Ld;"RES";Res_hipt
1140 INPUT "Enter voltage across input terminals in volts",Hipt_volt
1150 INPUT "Enter current through current shunt in amps",Hipt_curr

```

Program Listing for "B" Modules (continued)

```

1160 Hipt_res=Hipt_volt/Hipt_curr
1170 OUTPUT @Ld;"CAL:LEV:HIGH";Hipt_res
1180 OUTPUT @Ld;"RES";Res_lopt
1190 INPUT "Enter voltage across input terminals in volts",Lopt_volt
1200 INPUT "Enter current through current shunt in amps",Lopt_curr
1210 Lopt_res=Lopt_volt/Lopt_curr
1220 OUTPUT @Ld;"CAL:LEV:LOW";Lopt_res
1230 PRINT "Test unit to verify resistance values"
1240 PRINT "Press CONT when ready to calibrate transient level"
1250 PAUSE
1260 IF Flag THEN
1270 OUTPUT @Ld;"RES";Res_hipt
1280 ELSE
1290 OUTPUT @Ld;"RES";Res_lopt
1300 END IF
1310 OUTPUT @Ld;"TRAN:STAT ON;MODE TOGG;;TRIG:SOUR BUS"
1320 IF Flag THEN
1330 OUTPUT @Ld;"RES:TLEV";Res_lopt
1340 ELSE
1350 OUTPUT @Ld;"RES:TLEV";Res_hipt
1360 END IF
1370 OUTPUT @Ld;"*TRG"
1380 INPUT "Enter voltage across input terminals in volts",Tran_volt
1390 INPUT "Enter current through current shunt in amps",Tran_curr
1400 Tran_res=Tran_volt/Tran_curr
1410 OUTPUT @Ld;"CAL:TLEV";Tran_res
1420 OUTPUT @Ld;"TRAN OFF"
1430 PRINT "Test unit to verify transient values are in spec"
1440 PRINT "Press CONT when ready to end program or calibrate next range"
1450 PAUSE
1460 SUBEND

```


Appendix A

CONSIDERATIONS FOR OPERATING IN CONSTANT RESISTANCE MODE

The HP Electronic Loads implement Constant Resistance (CR) mode by using either the CV circuits or CC circuits to regulate the input. The low range is regulated with the CV circuits, using the input current monitor as the reference. Therefore, resistance is described by the formula

$$\frac{V}{I} = R$$

in which input current I is the reference, and voltage at the input terminals, V , is the parameter controlled to determine the resistance of the load.

The middle and high ranges are regulated with the CC circuits, using the input voltage monitor as the reference. Resistance is described by the formula

$$\frac{I}{V} = \frac{1}{R}$$

in which input voltage V is the reference, and current through the input terminals, I , is the parameter controlled to determine the resistance of the load. The reciprocal of resistance, $1/R$, is conductance, G . Therefore, the two highest ranges are best thought of as constant conductance ranges, with the CC circuit used to control conductance. This affects how the specified accuracy offset errors (in siemens or 1/ohms, formerly mhos) relate to programmed values (in ohms).

Any offset voltages in the op amps that comprise the load's regulator circuits become errors at the input terminals of the load. In both CV and CC modes the offset is constant across the specified operating range, and can be accounted for during calibration.

The effects of offsets on CR mode accuracy are specified as plus-or-minus constant values in milliohms (low range) or millisiemens (middle or high ranges), and are less than 1% of full scale. In the two higher ranges of CR mode (the constant conductance ranges), the effect on the programmed resistance value is not linear over the resistance range, because resistance is the reciprocal of conductance. Also, because

$$G = \frac{1}{R}$$

the effect of an offset in current (I) on conductance (G) is greater at low input voltages and less for large input voltages.

The electronic load designs are optimized for high-current applications. Therefore, the effects of offsets are more pronounced at high resistance (very low current) values. This may not represent a problem in typical applications, such

as those in which the load is used to test a power supply. For example, a 5-volt power supply being tested at 1 amp will require a load resistance of 5 ohms, which is equivalent to 0.2 siemens. The worst-case offset of + 0.008 siemens produces a resistance of between 4.8 ohms and 5.2 ohms, which represents a 4% error.

By contrast, a 10,000-ohm load connected to a 60-volt power supply will draw only 6 milliamps. Electronic loads are not designed to regulate such small currents.

If large resistances are required, the accuracy can be improved by reading the voltage and current directly from the load, calculating the actual resistance, and then adjusting the programmed value accordingly. This technique is most practical in applications requiring a fixed resistive load.

The following examples illustrate the worst-case error possibilities resulting from op amp offsets. The examples are based on a 300-watt unit having 1 ohm, 1 kilohm, and 10 kilohm ranges. These examples do not include the effects of gain errors on accuracy (specified in percent).

NOTE

Note that typical performance is far better than the worst-case possibilities shown here.

Example 1: 1 Ω range (0.033 Ω to 1 Ω)

The offset error for this range is specified as + 8 milliohms. Therefore, if 1 ohm is programmed, the actual resistance will be

$$1 \Omega + 0.008 \Omega = 0.992 \text{ to } 1.008 \Omega$$

Similarly, if 0.033 ohms is programmed, the actual resistance will be

$$0.033 \Omega \pm 0.008 \Omega = 0.032 \text{ to } 0.048 \Omega$$

Example 2: 1 k Ω range: (1 Ω to 1 k Ω , or 1 S to 0.001 S)

Because this range is, in effect, a constant conductance range, offset is specified in siemens (1/ohms). Resistance, however, is programmed in ohms. Therefore, to compute the contribution of offset error to programmed value error, the programmed value must be reciprocated first. The offset is then applied to the programmed value (in siemens) and the result is once again reciprocated.

Note that 1 ohm equals 1 siemen, and 1 kilohm equals 0.001 siemens. Therefore, the conductance (0.001 siemens) at full scale resistance (1 kilohm) is a very small percentage of full scale conductance.

If 1 ohm is programmed, the corresponding conductance value is 1 siemen. The actual resistance will be

$$1 \text{ S} \pm 0.008 \text{ S} = 1.008 \text{ S to } 0.992 \text{ S} \\ = 0.992 \Omega \text{ to } 1.008 \Omega$$

If 1 kilohm is programmed, the corresponding conductance value is 0.001 siemens. The actual resistance will be

$$0.001 \text{ S} \pm 0.008 \text{ S} = 0.009 \text{ S to } -0.007 \text{ S} \\ = 111 \Omega \text{ to infinite } \Omega \\ \text{(typically } 900 \text{ to } 1100 \Omega)$$

The load cannot provide negative current corresponding to negative siemens. Therefore, zero current translates to zero siemens, which corresponds to infinite ohms. Note also that the resistance can be as low as 111 ohms, which is much lower than 1 kilohm. This is because the current offset is large compared to the small current corresponding to 1 kilohm (0.001 siemens). For instance, 0.001 siemens corresponds to 6 milliamps at 6 volts input, and the offset specification of 0.008 siemens corresponds to 48 milliamps at 6 volts input.

Calculations for the 10 kilohm range are similar.

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